TPS389006/08-Q1,TPS389R0-Q1 マルチチャネル過電圧および低電圧 I²C プログラマブル電圧スーパーバイザおよびモニタ

1 特長

- ASIL-D 機能安全準拠
  - 機能安全アプリケーション用の開発向け
  - ISO 26262 システムの設計に役立つ資料
  - ASIL D までの決定論的対応能力
  - ASIL D までのハードウェア機能
- 以下の結果で AEC-Q100 認定済み:
  - デバイス温度グレード 1:-40℃～+125℃
- 最新の SoC を監視
  - ±6mV のスレッショルド精度 (-40℃～+125℃)
  - 入力電圧範囲:2.5V～5.5V
  - 低電圧誤動作防止 (UVLO):2.48 V
  - "Low" スタンバイ静止電流:200µA
  - 6 チャネル、2 個のリモート センス付き (TPS389006-Q1)
  - 6 チャネル、2 個のリモート センスおよびリセット出力付き (TPS389R06-Q1)
  - 8 チャネル (TPS389008-Q1)
  - 固定ウィンドウのスレッショルド レベル
    - 0.2V～1.475V、5mV ステップ
    - 0.8V～5.5V、20mV ステップ
- 小さなソリューション サイズとわずかな部品コスト
  - 3mm × 3mm の QFN パッケージ
  - 可変グリッチ耐性 (I²C 利用)
  - 調整可能な電圧スレッショルド レベル (I²C 利用)
- 安全アプリケーション向けに設計
  - アクティブ Low、オープン ドレイン NIRQ 出力
  - アクティブ Low、オープン ドレイン NRST 出力 (TPS389R0-Q1)
  - リアルタイム電圧読み出し用の 8 ビット ADC を内蔵
  - 巡回冗長性検査 (CRC)
  - パケット エラー チェック(PEC)
  - シーケンス ロギングとフォルト ロギング機能
- レールのタグ付けの同期機能
  - シーケンシング機能を実現するために、マルチチャネル シーケンサと接続

2 アプリケーション

- 先進運転支援システム (ADAS)
- センサ フュージョン

3 概要

TPS389006/08-Q1 デバイスは、ASIL-D 準拠の 6/8 チャネルのウィンドウ スーパーバイザ IC で、2 つのリモート センス ピン (6 チャネル バージョン) を搭載し、16 ピンの 3mm × 3mm QFN パッケージで供給されます。TPS389R06-Q1 デバイスは、2 つのリモート センス ピンとリセット出力を備えた 6 チャネルのウィンドウ スーパーバイザ IC です。この高精度のマルチチャネル電圧スーパーバイザは、低電圧電源レールで動作する、電源誤差の余地が小さいシステム向けに設計されています。

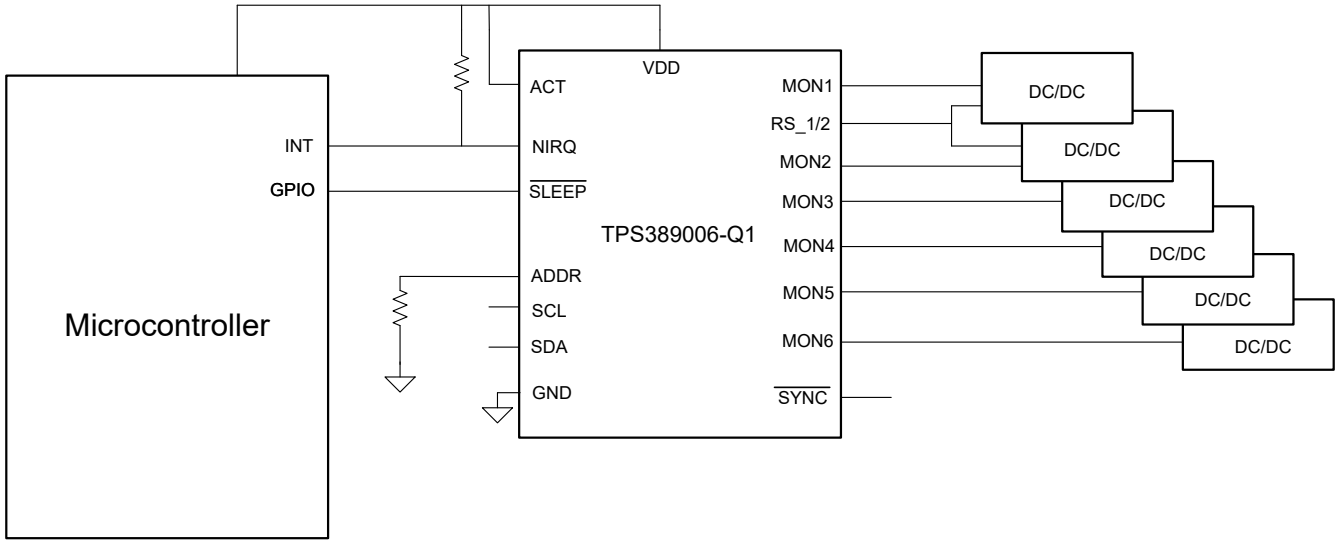
リモート センス ピンを使用すると、PCB トレース全体での電圧降下を考慮して、大電流コア レールで高精度の電圧測定を実現できます。I²C 機能により、スレッショルド、リセット遅延、グリッチ フィルタ、ピン機能を柔軟に選択できます。内部グリッチ耐性およびノイズ フィルタにより、外部 RC 部品が不要になり、電源過渡による誤リセットを低減できます。また、このデバイスは、外付け抵抗なしで過電圧および低電圧リセットのスレッショルドを設定できるため、総合的な精度、コスト、サイズをさらに最適化でき、安全性システムの信頼性も向上します。

このデバイスには CRC エラー チェック、電源オン / オフ時のシーケンス ロギング、電圧読み出しを行うための内蔵 ADC が搭載されており、冗長なエラー チェックが可能です。また、TPS389006 は、デバイス電源投入時にレールにタグを付ける SYNC 機能を提供します。さらに、TPS389006 デバイスをテキサス・インスツルメンツの電源シーケンサ TPS38700 と組み合わせることで、SIL-3 レベル準拠のための電圧監視に加えて、適切なパワーオン シーケンスを確保できします。

製品情報

部品番号	パッケージ (1)	本体サイズ (公称)(2)
TPS389006-Q1	WQFN (16)	3 mm × 3mm
TPS389008-Q1 のプレビュー		
TPS389R0-Q1 のプレビュー		

(1) 利用可能なすべてのパッケージについては、データシートの末尾にある注文情報を参照してください。
(2) パッケージ サイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。



TPS389006-Q1 の回路例

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4 Device Comparison

図 4-1 shows the device nomenclature of the TPS389006/08-Q1,TPS389R0-Q1. 表 4-1provides a summary of available device functions and corresponding part number. Contact TI sales representatives or go online to TI's E2E forum for details and availability of other options; minimum order quantities apply.

See セクション 9.1 for more information regarding the device ordering codes. 表 9-1 and 表 9-3 show how to decode the function of the device based on the part number.

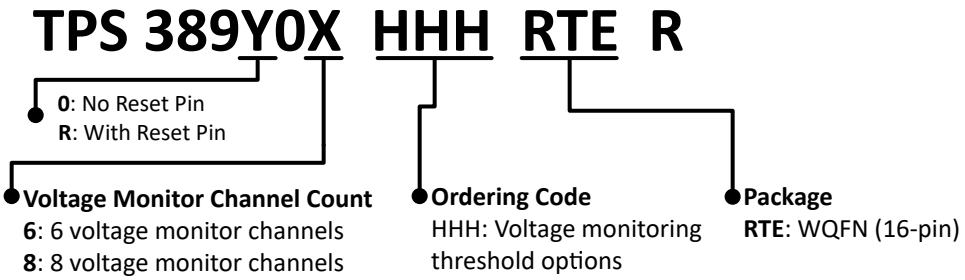

図 4-1. TPS389006/08-Q1,TPS389R0-Q1 Device Nomenclature

表 4-1. Multichannel Supervisor Summary Table

Specification	TPS38900x-Q1	TPS389R0x-Q11	TPS38800x-Q11	TPS388R0x-Q11	TPS389C0x-Q1	TPS388C0x-Q11
Hardware ASIL Rating	D	D	B	B	D	B
Monitoring Channel Count	4 to 8	4 to 7	4 to 8	4 to 7	3 to 6	3 to 6
Monitoring Range	0.2 to 5.5V	0.2 to 5.5V	0.2 to 5.5V	0.2 to 5.5V	0.2 to 5.5V	0.2 to 5.5V
Comparator Monitoring (HF Faults)	✓	✓	✓	✓	✓	✓
ADC Monitoring (LF Faults)	✓	✓	x	x	✓	x
Watchdog	x	x	x	x	Q&A	Window
Voltage Telemetry	✓	✓	x	x	✓	x
Monitor Glitch Filtering	✓	✓	✓	✓	✓	✓
Sequence Logging	✓	x	✓	x	✓	✓
NIRQ PIN	✓	✓	✓	✓	✓	✓
NRST PIN	x	✓	x	✓	✓	✓
SYNC PIN	✓	x	x	x	x	x
WDO PIN	x	x	x	x	✓	✓
WDI PIN	x	x	x	x	x	✓
ESM PIN	x	x	x	x	✓	x

1. Preview, contact TI sales representatives or on TI's E2E forum for details and availability of other options

5 Pin Configuration and Functions

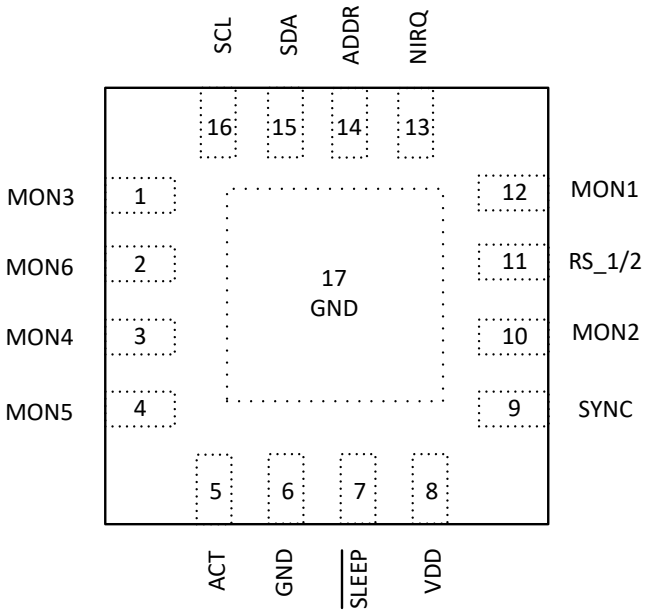

図 5-1. RTE Package
16-Pin WQFN
TPS389006-Q1 Top View

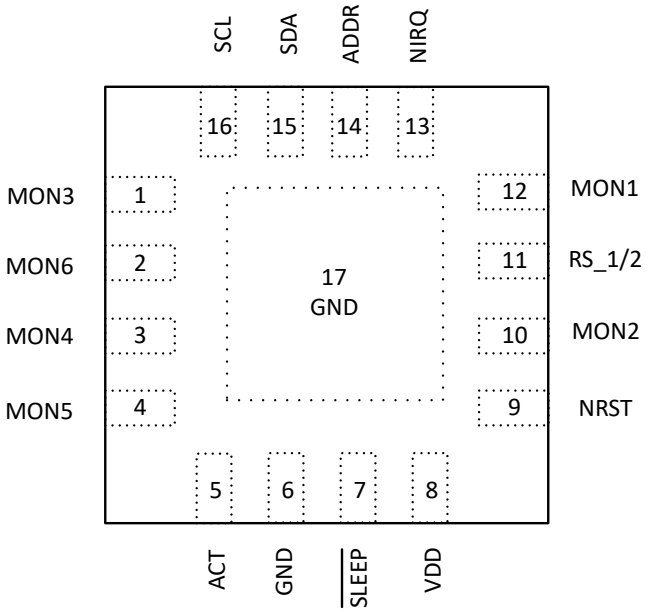

図 5-2. RTE Package
16-Pin WQFN
TPS389R0-Q1 Top View

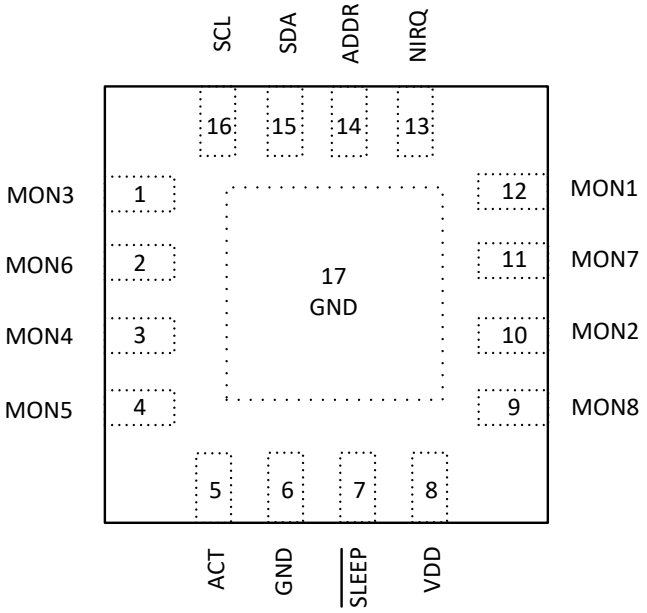

図 5-3. RTE Package
16-Pin WQFN
TPS389008-Q1 Top View

表 5-1. Pin Functions

PIN			I/O	DESCRIPTION
NO.	TPS389006/08-Q1	TPS389R0-Q1		
	NAME	NAME		
1	MON3	MON3	I	Voltage monitor channel 3
2	MON6	MON6	I	Voltage monitor channel 6
3	MON4	MON4	I	Voltage monitor channel 4
4	MON5	MON5	I	Voltage monitor channel 5
5	ACT	ACT	I	Active high device enable
6	GND	GND	-	Power ground
7	$\overline{\text{SLEEP}}$	$\overline{\text{SLEEP}}$	I	Active low sleep enable
8	VDD	VDD	-	Power supply rail
9	$\overline{\text{SYNC}}$/MON8	-	I/O	Sequence logging synchronization across multiple devices/Voltage monitor channel 8
9	-	NRST	O	Open Drain Reset Output
10	MON2	MON2	I	Voltage monitor channel 2
11	RS_1/2/MON7	RS_1/2	I	Voltage monitor channel 1/2 remote sense/ Voltage monitor channel 7
12	MON1	MON1	I	Voltage monitor channel 1
13	NIRQ	NIRQ	O	Active-low open-drain interrupt output
14	ADDR	ADDR	I	I^2C address select pin
15	SDA	SDA	I/O	I^2C data pin
16	SCL	SCL	I	I^2C clock pin
17	GND	GND	-	Exposed power ground pad

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
Voltage	VDD	–0.3	6	V
Voltage	NIRQ, NRST	–0.3	6	V
Voltage	ACT, $\overline{\text{SLEEP}}$, SCL, SDA	–0.3	6	V
Voltage	$\overline{\text{SYNC}}$	–0.3	VDD+0.3	V
Voltage	ADDR	–0.3	2	V
Voltage	MONx	–0.3	6	V
Current	NIRQ, NRST		±10	mA
Temperature (2)	Continuous total power dissipation	See the Thermal Information		
	Operating junction temperature, T_J	-40	150	°C
	Operating free-air temperature, T_A	-40	125	°C
	Storage temperature, T_{stg}	-65	150	°C

(1) Stresses beyond values listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) As a result of the low dissipated power in this device, it is assumed that $T_J = T_A$.

6.2 ESD Ratings

				VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)		±2000	V
		Charged-device model (CDM), per AEC Q100-011	All pins	±500	
			Corner pins	±750	

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification

6.3 Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
VDD	Supply pin voltage	2.5		5.5	V
NIRQ,NRST	Pin voltage	0		5.5	V
I_{NIRQ},I_{NRST}	Pin Currents	0		±5	mA
ADDR	Address pin voltage	0		1.8	V
MONx	Monitor Pins	0		5.5	V
ACT, $\overline{\text{SLEEP}}$, SCL, SDA	Pin Voltage	0		5.5	V
SYNC	Pin Voltage	0		VDD	V
R_{UP} (1)	Pull-up resistor (Open Drain config)	10		100	kΩ

6.4 Thermal Information

THERMAL METRIC(1)		TPS389006 RTE (WQFN) PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	53.4	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	51.4	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	17.2	°C/W
Ψ_{JT}	Junction-to-top characterization parameter	0.3	°C/W
Ψ_{JB}	Junction-to-board characterization parameter	20.7	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	3.9	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.5 Electrical Characteristics

At 2.6V <= VDD <= 5.5V , NIRQ,NRST Voltage = 10kΩ to V_{DD}, NIRQ,NRST load = 10pF, and over the operating free-air temperature range of – 40°C to 125°C, unless otherwise noted. Typical values are at T_J = 25°C, typical conditions at VDD= 3.3V .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
COMMON PARAMETERS						
VDD	Input supply voltage		2.6		5.5	V
VDD_{UVLO}	Rising Threshold		2.67		2.81	V
	Falling Threshold		2.48		2.60	V
V_{POR}	Power on Reset Voltage (2)				1.65	V
I_{DD_Active}	Supply current into VDD pin (MON = LF/HF active) ACT = High, $\overline{Sleep}$ = High	VDD <= 5.5V		1.55	2	mA
I_{DD_Sleep}	Supply current into VDD pin (MON = LF/HF active) ACT = High ,$\overline{Sleep}$ = Low,I2C = Sleep power bit set to 1	VDD <= 5.5V		1.55	2	mA
I_{DD_Idle}	Supply current into VDD pin (MON = OVLF active) ACT = Low, Idle state-I2C active and OVLF mon	VDD <= 5.5V >10ms BIST		200	280	µA
$I_{DD\_Deep\ Sleep}$	Supply current into VDD pin (MON = HF active), ACT = High,$\overline{Sleep}$ = Low,I2C = Sleep power bit set to 0	VDD <= 5.5V		275	380	µA
V_{MONX}	MON voltage range		0.2		5.5	V
I_{MONX}	Input current MONx pins	V_{MON} = 5V			20	µA
I_{MONX_ADJ}	Input current for ADJ version (1x)	V_{MON} = 5V			0.1	µA
VMON_LF	1x mode (No scaling)		0.2		1.475	V
	with 4x scaling		0.8		5.5	V
VMON_HF	1x mode (No scaling)		0.2		1.475	V
	with 4x scaling		0.8		5.5	V
Threshold granularity_HF	1x mode (No scaling) LSB			5		mV
	4x mode (With scaling) LSB			20		mV
LPF cutoff LF	Range of Programmable values (I^2C selectable)	Low Freq channel	250		4000	Hz
LPF cutoff HF		High Freq channel		4		Mhz

6.5 Electrical Characteristics (続き)

At 2.6V <= VDD <= 5.5V , NIRQ,NRST Voltage = 10kΩ to V_{DD}, NIRQ,NRST load = 10pF, and over the operating free-air temperature range of – 40°C to 125°C, unless otherwise noted. Typical values are at T_J = 25°C, typical conditions at VDD= 3.3V .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Accuracy_HF	VMON	0.2V≤V_{MONX}≤1.0V	–6		6	mV
		1.0V<V_{MONX}≤1.475V	-7.5		7.5	mV
		1.475V<V_{MONX}≤2.95V	-0.6		0.6	%
		VMONX>2.95V	-0.7		0.7	%
V_{HYS_HF}	Hysteresis on UV,OV pin(Hysteresis is with respect of the tripoint ((UV),(OV)) (1)	0.2V≤V_{MONX}≤1.475V		5	11	mV
		1.475V<V_{MONX}≤2.95V		9	16	
		VMONX>2.95V		17	28	mV
MON_OFF	OFF Voltage threshold	Monitored falling edge of V_{MON}	140		215	mV
I_{LKG}	Output leakage current -NIRQ	VDD=V_{NIRQ}=5.5V			300	nA
ACT_L	Logic Low input	DEV_CONFIG.SOC_IF1=1			0.36	V
ACT_H	Logic high input	DEV_CONFIG.SOC_IF1=1	0.84			V
$\overline{\text{SLEEP}}$_L	Logic Low input	DEV_CONFIG.SOC_IF1=1			0.36	V
$\overline{\text{SLEEP}}$_H	Logic high input	DEV_CONFIG.SOC_IF1=1	0.84			V
$\overline{\text{SYNC}}$_L	Input High	DEV_CONFIG.SOC_IF1=1			0.36	V
$\overline{\text{SYNC}}$_H	Input Low	DEV_CONFIG.SOC_IF1=1	0.84			V
$\overline{\text{SYNC}}$_PU	Internal Pull-up		25		100	kΩ
$\overline{\text{SYNC}}$_OL	with 10kΩ external pull up				0.1	V
ACT	Internal Pull down			100		kΩ
$\overline{\text{SLEEP}}$	Internal Pull down			100		kΩ
UV,OV	Steps/Resolution	0.2V<V_{MONX}≤1.475V		5		mV
		0.8V<V_{MONX}<5.5V		20		
V_{OL}	Low level output voltage-NIRQ	NIRQ ,5.5V/5mA			100	mV
$I_{lkg(OD)}$	Open-Drain output leakage current-NIRQ	NIRQ pin in High Impedance,V_{NIRQ} = 5.5, Not asserted state			90	nA
V_{OL}	Low level output voltage-NRST	NRST ,5.5V/5mA			100	mV
$I_{lkg(OD)}$	Open-Drain output leakage current-NRST	NRST pin in High Impedance,V_{NRST} = 5.5, Not asserted state			600	nA
I_{ADDR}	ADDR pin current			20		µA
I^2C ADDR	(Hex format)	R=5.36k		0x30		
		R=16.2k		0x31		
		R=26.7k		0x32		
		R=37.4k		0x33		
		R=47.5k		0x34		
		R=59.0k		0x35		
		R=69.8k		0x36		
		R=80.6k		0x37		
TSD	Thermal Shutdown			155		℃
TSD Hys	Thernal Shutdown Hysterisis			20		℃
RS	Remote sense range		-100		100	mV
ADC SPECIFICATION						
Vin	Input Range		0.2		5.5	V
Res_LF	Resolution	1x mode (No scaling)		5		mV
		4x mode		20		mV

6.5 Electrical Characteristics (続き)

At 2.6V <= VDD <= 5.5V , NIRQ,NRST Voltage = 10kΩ to V_{DD}, NIRQ,NRST load = 10pF, and over the operating free-air temperature range of – 40°C to 125°C, unless otherwise noted. Typical values are at T_J = 25°C, typical conditions at VDD= 3.3V .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_S	Sample Rate			125		ksps
V_{HYS_LF}	Hysteresis LF faults	1x mode (No scaling)		10	15	mV
V_{HYS_LF}	Hysteresis LF faults	4x mode		40	55	mV
Accuracy_LF	VMON	1x mode (No scaling)	-12		+12	mV
		4x mode	-40		+40	mV
I2C ELECTRICAL SPECIFICATIONS						
C_B	Capacitive load for SDA and SCL				400	pF
SDA,SCL	Low Threshold	DEV_CONFIG.SOC_IF1=0			0.8	V
SDA,SCL	High Threshold	DEV_CONFIG.SOC_IF1=0	2.0			V

(1) Hysteresis is with respect of the tripoint ($V_{IT-(UV)}$, $V_{IT+(OV)}$).
(2) V_{POR} is the minimum V_{DDX} voltage level for a controlled output state.

6.6 Timing Requirements

At 2.6V ≤ VDD ≤ 5.5V , NIRQ,NRST Voltage = 10kΩ to VDD, NIRQ,NRST load = 10pF, and over the operating free-air temperature range of – 40°C to 125°C, unless otherwise noted. Typical values are at T_J = 25°C, typical conditions at VDD = 3.3V .

			MIN	NOM	MAX	UNIT
COMMON PARAMETERS						
t_{BIST}	POR to ready with BIST, TEST_CFG.AT_POR=1	includes OTP load			12	ms
t_{NBIST}	POR to ready without BIST, TEST_CFG.AT_POR=0	includes OTP load			2	ms
BIST	BIST time,TEST_CFG.AT_POR=1 or TEST_CFG.AT_SHDN=1				10	ms
t_{I2C_ACT}	I^2C active from BIST complete				0	µs
t_{SEQ_Range}	Sequence timestamp range, ACT or $\overline{SLEEP}$ edge to max counter				4	s
t_{SEQ_LSB}	Sequence timestamp resolution			50		µs
t_{MON_ACT}	Monitoring active from ACT rising edge				10	µs
t_{SEQ_ACT}	Sequence tagging active from ACT or $\overline{SLEEP}$ edge				12	µs
t_{NIRQ}	Fault detection to NIRQ assertion latency (except OV/UV faults)				25	µs
t_{NRST}	Fault detection to NRST assertion latency (except OV/UV faults)				25	µs
$t_{PD\_NIRQ\_1X}$	HF fault Propagation detect delay (default deglitch filter) includes digitial delay	VIT_OV/UV +/- 100mV			650	ns
$t_{PD\_NIRQ\_4X}$	HF fault Propagation detect delay (default deglitch filter) includes digitial delay	VIT_OV/UV +/- 400mV			750	ns
$t_{PD\_NRST\_1X}$	HF fault Propagation detect delay (default deglitch filter) includes digitial delay	VIT_OV/UV +/- 100mV			650	ns
$t_{PD\_NRST\_4X}$	HF fault Propagation detect delay (default deglitch filter) includes digitial delay	VIT_OV/UV +/- 400mV			750	ns
t_{SEQ_ACC}	Accuracy of sequence timestamp		-5		5	%

6.6 Timing Requirements (続き)

At 2.6V ≤ VDD ≤ 5.5V , NIRQ,NRST Voltage = 10kΩ to VDD, NIRQ,NRST load = 10pF, and over the operating free-air temperature range of – 40°C to 125°C, unless otherwise noted. Typical values are at T_J = 25°C, typical conditions at VDD = 3.3V .

			MIN	NOM	MAX	UNIT
t_D	RESET time delay	I2C Register time delay =000		200		µs
		I2C Register time delay =001		1		ms
		I2C Register time delay =010		10		ms
		I2C Register time delay =011		16		ms
		I2C Register time delay =100		20		ms
		I2C Register time delay =101		70		ms
		I2C Register time delay =110		100		ms
		I2C Register time delay =111		200		ms
t_{GI_R}	UV & OV debounce range via I2C	FLT_HF(N)	0.1		102.4	µs

6.6 Timing Requirements (続き)

At 2.6V ≤ VDD ≤ 5.5V , NIRQ,NRST Voltage = 10kΩ to VDD, NIRQ,NRST load = 10pF, and over the operating free-air temperature range of – 40°C to 125°C, unless otherwise noted. Typical values are at T_J = 25°C, typical conditions at VDD = 3.3V .

			MIN	NOM	MAX	UNIT
I2C TIMING CHARACTERISTICS						
f_{SCL}	Serial clock frequency	Standard mode			100	kHz
f_{SCL}	Serial clock frequency	Fast mode			400	kHz
f_{SCL}	Serial clock frequency	Fast mode +			1	MHz
t_{LOW}	SCL low time	Standard mode	4.7			µs
t_{LOW}	SCL low time	Fast mode	1.3			µs
t_{LOW}	SCL low time	Fast mode +	0.5			µs
t_{HIGH}	SCL high time	Standard mode	4			µs
t_{HIGH}	SCL high time	Fast mode +	0.26			µs
$t_{SU;DAT}$	Data setup time	Standard mode	250			ns
$t_{SU;DAT}$	Data setup time	Fast mode	100			ns
$t_{SU;DAT}$	Data setup time	Fast mode +	50			ns
$t_{HD;DAT}$	Data hold time	Standard mode	10			ns
$t_{HD;DAT}$	Data hold time	Fast mode	10			ns
$t_{HD;DAT}$	Data hold time	Fast mode +	10			ns
$t_{SU;STA}$	Setup time for a Start or Repeated Start condition	Standard mode	4.7			µs
$t_{SU;STA}$	Setup time for a Start or Repeated Start condition	Fast mode	0.6			µs
$t_{SU;STA}$	Setup time for a Start or Repeated Start condition	Fast mode +	0.26			µs
$t_{HD:STA}$	Hold time for a Start or Repeated Start condition	Standard mode	4			µs
$t_{HD:STA}$	Hold time for a Start or Repeated Start condition	Fast mode	0.6			µs
$t_{HD:STA}$	Hold time for a Start or Repeated Start condition	Fast mode +	0.26			µs
t_{BUF}	Bus free time between a STOP and START condition	Standard mode	4.7			µs
t_{BUF}	Bus free time between a STOP and START condition	Fast mode	1.3			µs
t_{BUF}	Bus free time between a STOP and START condition	Fast mode +	0.5			µs
$t_{SU;STO}$	Setup time for a Stop condition	Standard mode	4			µs
$t_{SU;STO}$	Setup time for a Stop condition	Fast mode	0.6			µs
$t_{SU;STO}$	Setup time for a Stop condition	Fast mode +	0.26			µs
trDA	Rise time of SDA signal	Standard mode			1000	
trDA	Rise time of SDA signal	Fast mode	20		300	ns
trDA	Rise time of SDA signal	Fast mode +			120	ns
tfDA	Fall time of SDA signal	Standard mode			300	ns
tfDA	Fall time of SDA signal	Fast mode	1.4		300	ns
tfDA	Fall time of SDA signal	Fast mode +	6.5		120	ns
trCL	Rise time of SCL signal	Standard mode			1000	ns
trCL	Rise time of SCL signal	Fast mode	20		300	ns
trCL	Rise time of SCL signal	Fast mode +			120	ns
tfCL	Fall time of SCL signal	Standard mode			300	ns
tfCL	Fall time of SCL signal	Fast mode	6.5		300	ns
tfCL	Fall time of SCL signal	Fast mode +	6.5		120	ns
tSP	Pulse width of SCL and SDA spikes that are suppressed	Standard mode, Fast mode and Fast mode +			50	ns

6.7 Typical Characteristics

At T_J = 25°C, V_{DD} = 3.3V , and R_{PU} = 10kΩ, unless otherwise noted.

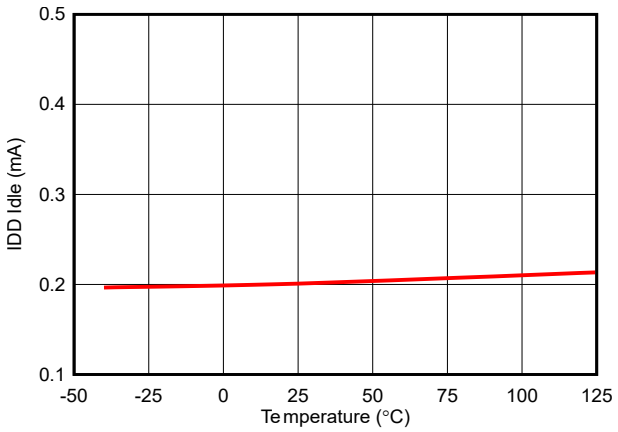

図 6-1. Idle Input Current Vs Temperature

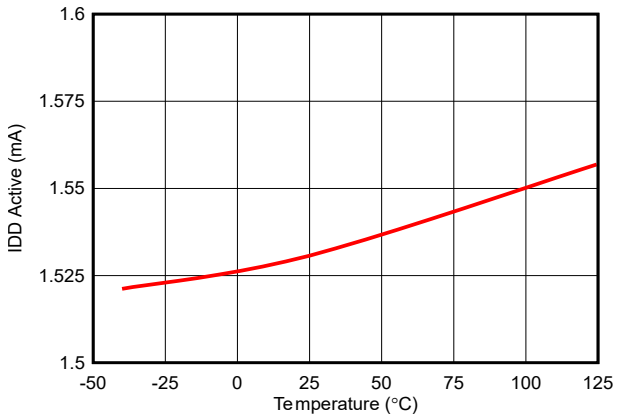

図 6-2. Active Input Current Vs Temperature

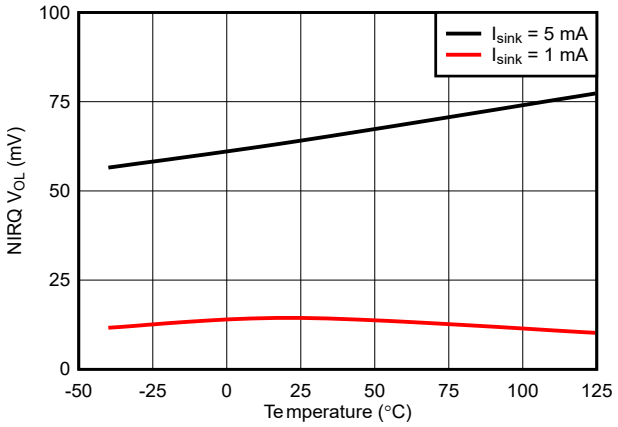

図 6-3. NIRQ Low Level Output Voltage Vs Temperature

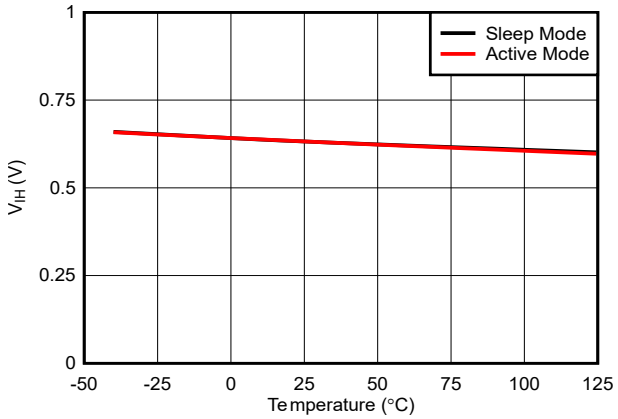

図 6-4. High Level Input Voltage Vs Temperature

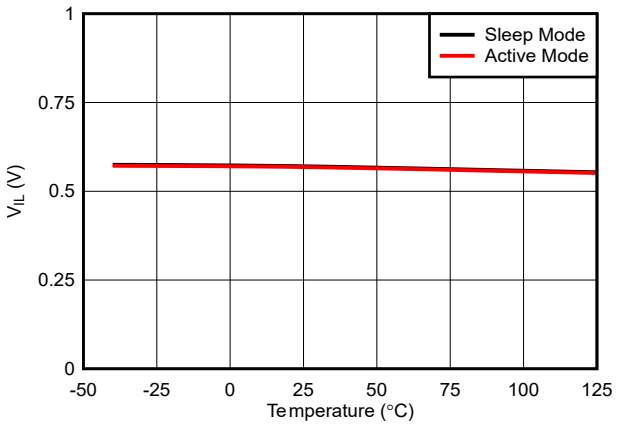

図 6-5. Low Level Input Voltage Vs Temperature

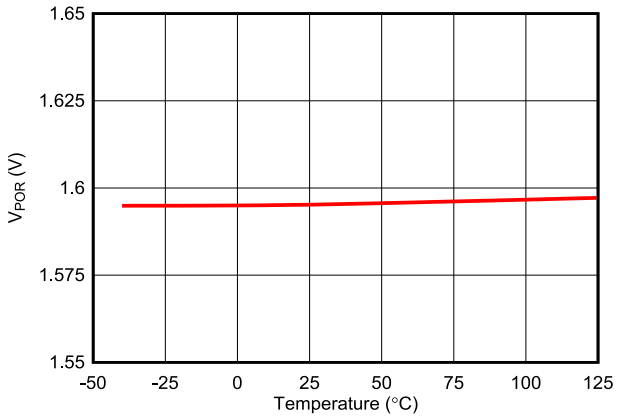

図 6-6. Power-on-Reset Voltage Vs Temperature

7 Detailed Description

7.1 Overview

The TPS389006/08 family of devices has six/eight channels that can be configured for over voltage, under voltage or both in a window configuration. The TPS389006/08 features highly accurate window threshold voltages (up to ±6mV) and a variety of voltage thresholds which can be factory configured or set on boot up by I^2C commands.

The TPS389006/08 includes the resistors used to set the overvoltage and undervoltage thresholds internal to the device. These internal resistors allow for lower component counts and greatly simplifies the design because no additional margins are needed to account for the accuracy of external resistors.

The TPS389006 has a sequence logging feature to monitor and assign timestamps/log for the power rails turning on and off. It can perform sequence logging on a single device or across multiple devices on a board. It uses the $\overline{\text{SYNC}}$ pin to communicate across multiple devices. When either the ACT or $\overline{\text{SLEEP}}$ pin transitions from low to high or high to low, the sequence logging function becomes active until the expiry of the sequence timeout (SEQ_TOUT). During the sequence timeout, the UV faults can be masked (Automask - AMSK).

The TPS389006/08 is designed to assert active low output signals (NIRQ) when the monitored voltage is outside the safe window. The factory configuration can have the interrupts disabled for over voltage and under voltage faults, sequence timeout, BIST enabled at POR, sequence fault interrupts disabled, and over voltage and under voltage deglitch settings depending on the OTP. The TPS389R0 also has an open drain NRST output that can be selectively mapped to UV/OV or any UV faults for either all the monitored voltages or a single monitored voltage.

7.2 Functional Block Diagram

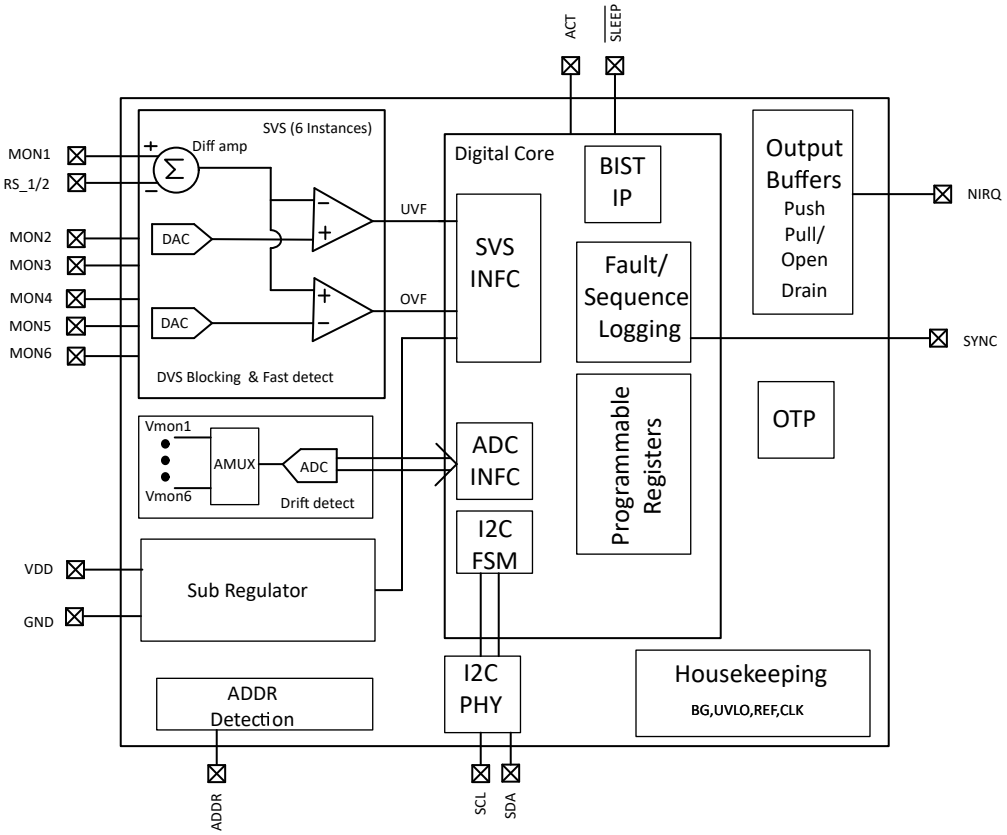

図 7-1. TPS389006-Q1 Block Diagram

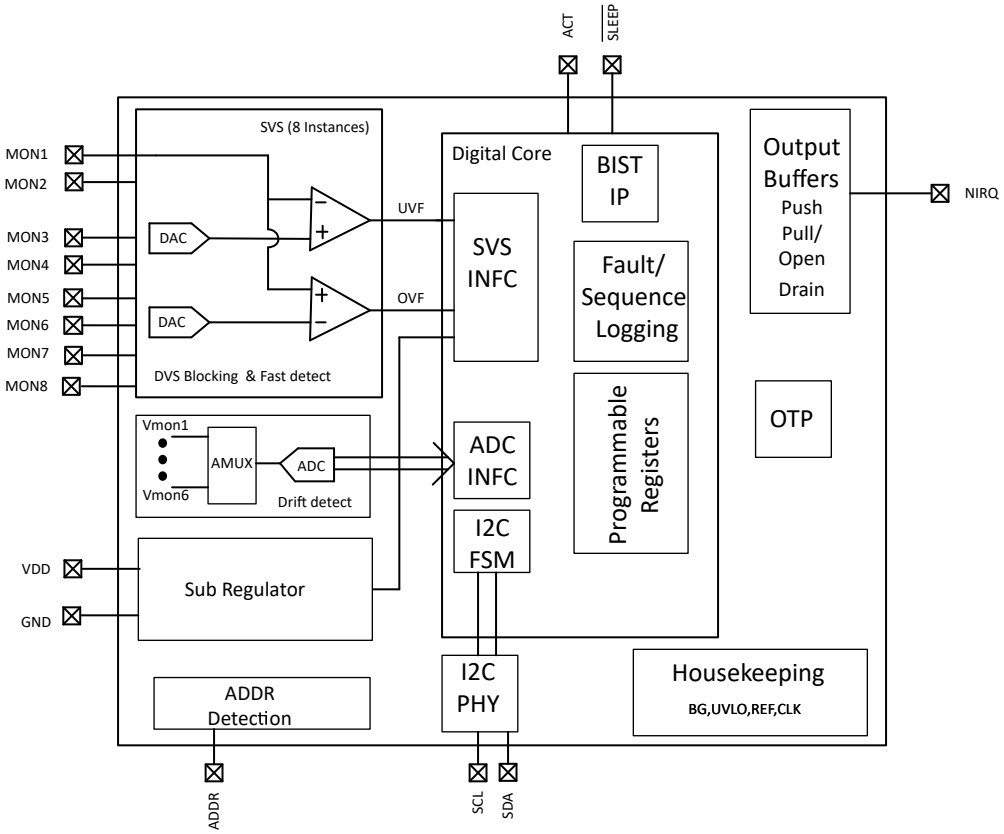

図 7-2. TPS389008-Q1 Block Diagram

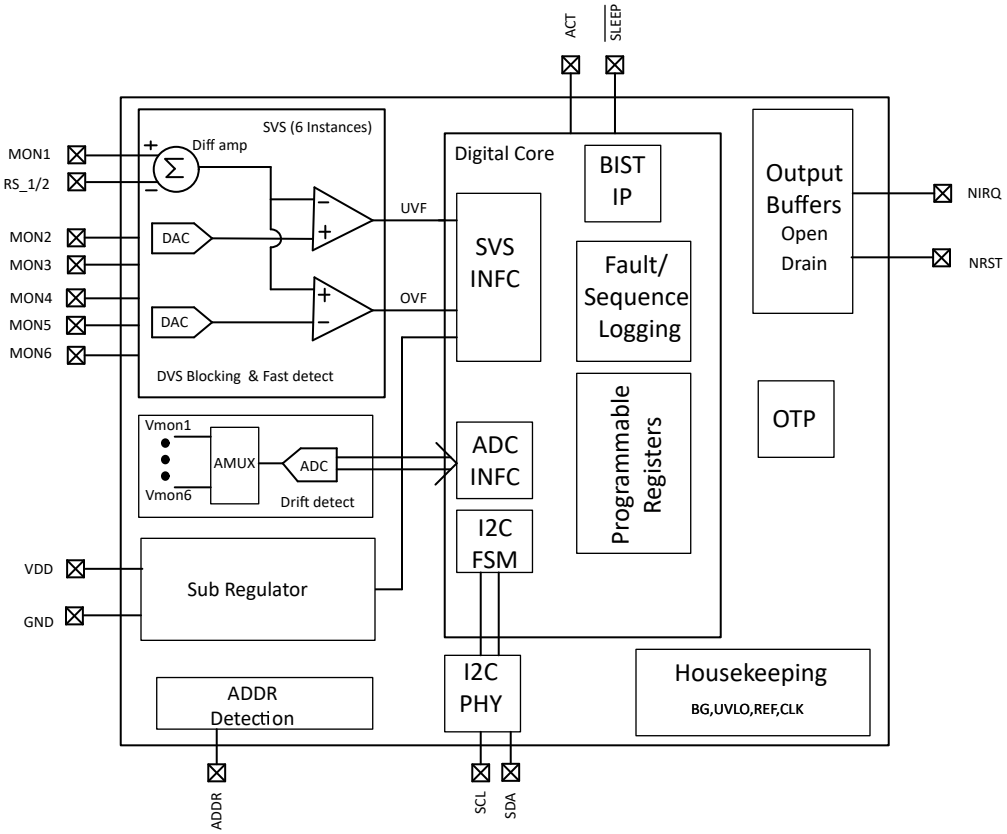

図 7-3. TPS389R0-Q1 Block Diagram

7.3 Feature Description

7.3.1 I²C

The TPS389006 device follows the I²C protocol (up to 1MHz) to manage communication with host devices such as a MCU or System on Chip (SoC). I²C is a two wire communication protocol implemented using two signals, clock (SCL) and data (SDA). The host device is the primary controller of communication. TPS389006 device responds over the data line during read or write operations as defined by I²C protocol. Both SCL and SDA signals are open drain topology and can be used in a wired-OR configuration with other devices to share the communication bus. Both SCL and SDA pins need an external pull up resistor to supply voltage (10kΩ recommended).

図 7-4 shows the timing relationship between SCL and SDA lines to transfer 1 byte of data. SCL line is always controlled by host. To transfer 1 byte data, host needs to send 9 clocks on SCL. 8 clocks for data and 1 clock for ACK or NACK. SDA line is controlled by either the host or TPS389006 device based on the read or write operation. 図 7-4 and 図 7-5 highlight the communication protocol flow and which device controls SDA line at various instances during active communication.

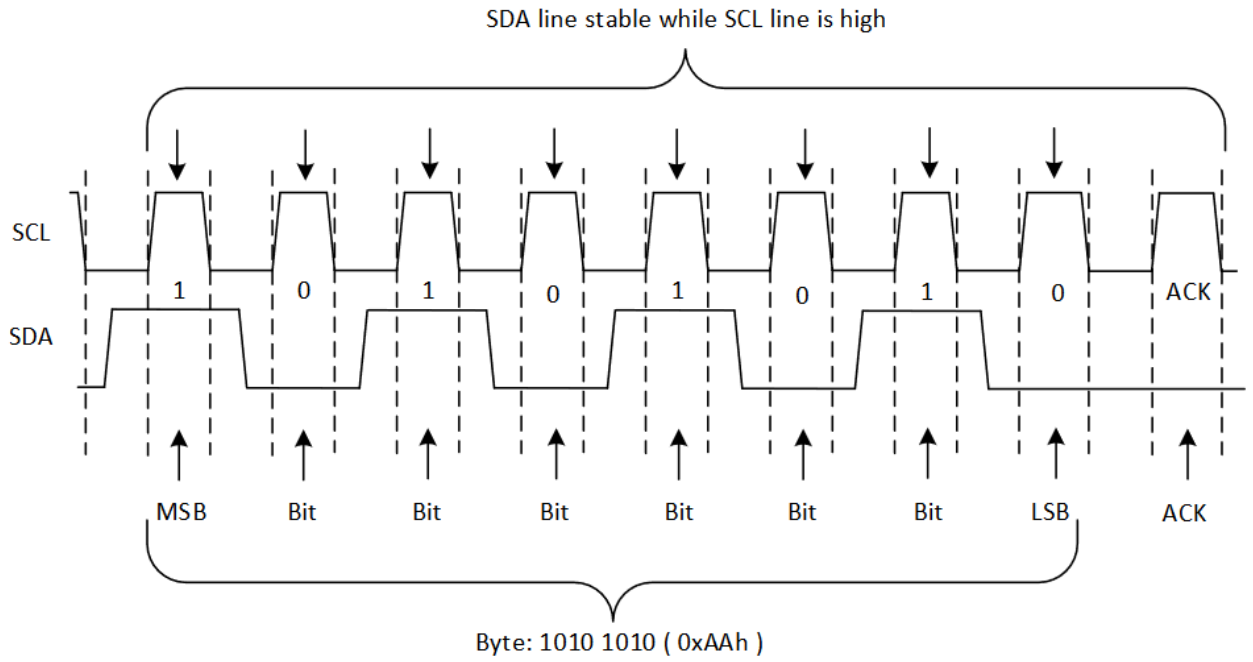

図 7-4. SCL to SDA Timing for 1 Byte Data Transfer

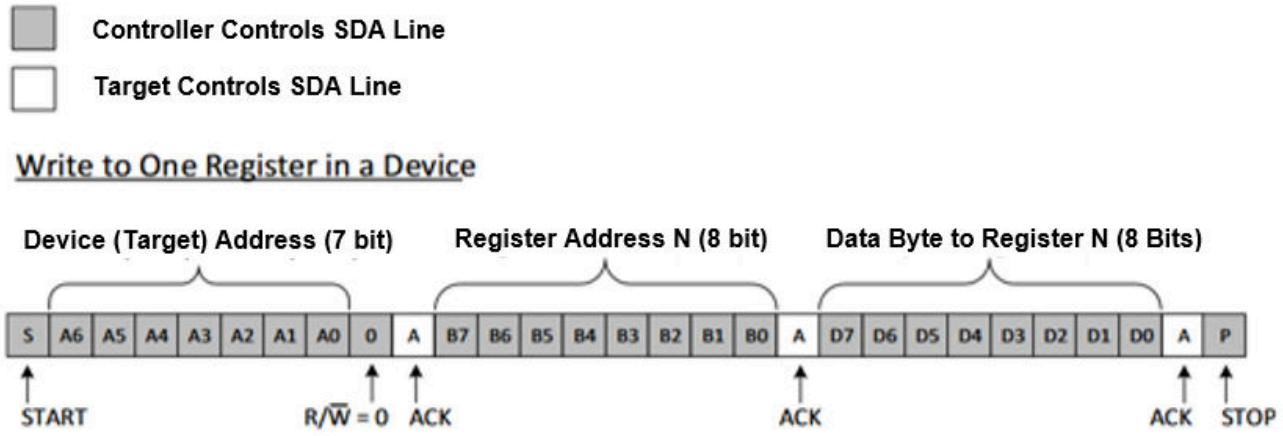

図 7-5. I²C Write Protocol

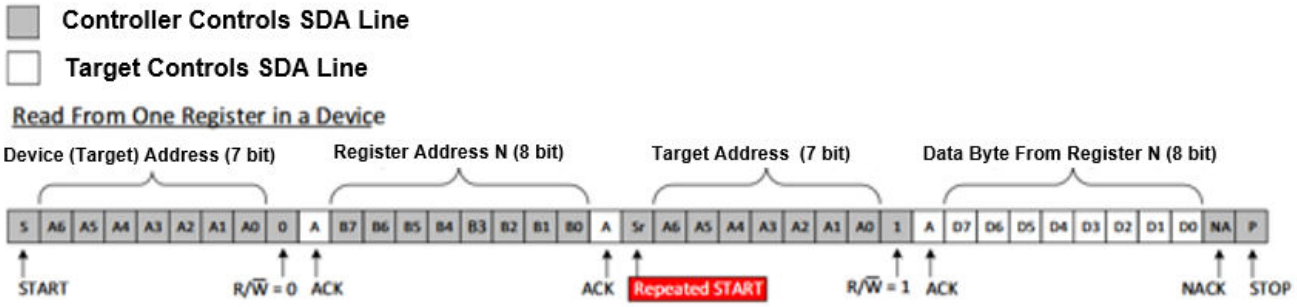

図 7-6. I²C Read Protocol

Before initiating communication over I²C protocol, host needs to confirm the I²C bus is available for communication. Monitor the SCL and SDA lines, if any line is pulled low, the I²C bus is occupied. Host needs to wait until the bus is available for communication. Once the bus is available for communication, the host can initiate read or write operation by issuing a START condition. Once the I²C communication is complete, release the bus by issuing STOP command. 図 7-7 shows how to implement START and STOP condition.

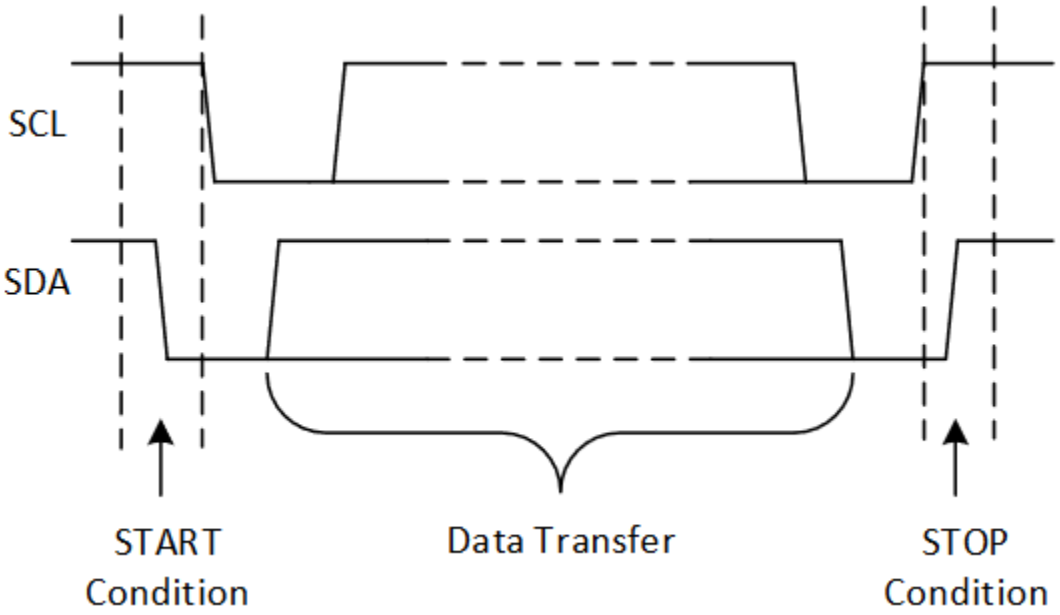

図 7-7. I²C START and STOP Condition

表 7-1 shows the different functionality available when programming with I²C.

表 7-1. User Programmable I²C Functions

FUNCTIONS	DESCRIPTION
Thresholds for OV/UV- fast loop	Adjustable in 5mV steps from 0.2V to 1.475V and 20mV steps from 0.8V to 5.5V
Thresholds for drift -positive and negative	Adjustable in 5mV steps from 0.2V to 1.475V and 20mV steps from 0.8V to 5.5V
Voltage Monitoring scaling	1 or 4
Glitch (debounce) immunity for OV/UV-fast loop	0.1 us to 102.4 us
Low pass filter cut off Frequency	250Hz to 4kHz
Enable sequence timeout	1ms to 4s
Sleep sequence timeout	1ms to 4s
SYNC pulse width	50us to 2600us
Expected ON/OFF Sequence on ACT	Used for sequence logging
Expected ON/OFF Sequence on Sleep	Used for sequence logging
Auto Mask OFF-ON-OFF via ACT	Selectable for each MON channel
Auto Mask OFF-ON-OFF via $\overline{\text{SLEEP}}$	Selectable for each MON channel
Packet error checking for I²C	Enabling or Disabling
Force NIRQ assertion	Controlled by I²C register
Individual channel MON	Enable or Disable
Interrupt disable functions	BIST, PEC, TSD, CRC

7.3.2 Auto Mask (AMSK)

In the case of power up AMSK_ON and AMSK_EXS registers apply. It masks interrupts till the MON voltage crosses the UVLF threshold or sequence timeout expires whichever is sooner. In the case of power down AMSK_OFF and AMSK_ENS registers apply. It masks interrupts till the MON voltage is below the OFF threshold and then the OVLF interrupts are active.

表 7-2 summarizes the auto-mask operation for the ACT and SLEEP transitions.

表 7-2. Transition Table

TRANSITION	AUTO-MASK APPLIED	AUTO-MASK APPLIES TO	AUTO-MASK INACTIVE	INTERRUPTS ACTIVE FOR MON CHANNELS NOT IN AUTO-MASK
ACT (Low -> High)	AMSK_ON	IEN_UVLF, IEN_UVHF, IEN_OVHF	SEQ_TOUT expires or rail crosses UVLF	At ACT=High
ACT (High -> Low)	AMSK_OFF	IEN_UVLF, IEN_UVHF, IEN_OVHF	Auto-mask active in transition till SEQ_TOUT expires	Until SEQ_TOUT expires
$\overline{\text{SLEEP}}$ (Low -> High) ACT = High	AMSK_EXS	IEN_UVLF, IEN_UVHF, IEN_OVHF	SEQ_TOUT expires or rail crosses UVLF	Always active
$\overline{\text{SLEEP}}$ (High -> Low) ACT = High	AMSK_ENS	IEN_UVLF, IEN_UVHF, IEN_OVHF	Auto-mask active	Always active

7.3.3 Packet Error Checking (PEC)

TPS389C03-Q1 supports Packet Error Checking (PEC) as a way to implement Cyclic Redundancy Checking (CRC). PEC is a dynamic CRC that happens only during read or write transactions if enabled. With the initial value of CRC set to 0x00, the PEC uses a CRC-8 represented by the polynomial:

$$C(x) = x^8 + x^2 + x + 1 \quad (1)$$

The polynomial is meant to catch any bit flips or noise in I2C communication which cause data and PEC byte to have a mismatch. The PEC calculation includes all bytes in the transmission, including address, command and data. The PEC calculation does not include ACK or NACK bits or START, STOP or REPEATED START conditions. If PEC is enabled, and the TPS389C03-Q1 is transmitting data, then the TPS389C03-Q1 is responsible for sending the PEC byte. If PEC is enabled, and the TPS389C03-Q1 is reveiving data from the MCU, then the MCU is responsible for sending the PEC byte. In case of faster communications needs like servicing the watchdog the required PEC feature can be effectively used to handle missing PEC information and to avoid triggering faults. 図 7-8 and 図 7-9 highlight the communication protocol flow when PEC is required and which device controls SDA line at various instances during active communication.

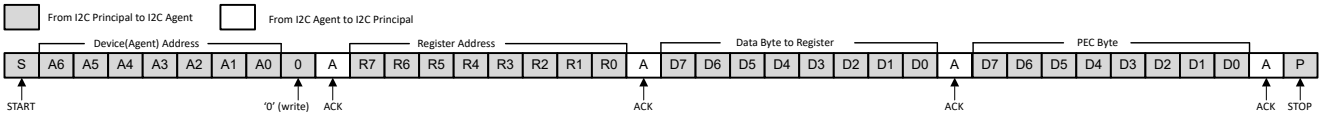

図 7-8. Single Byte Write with PEC

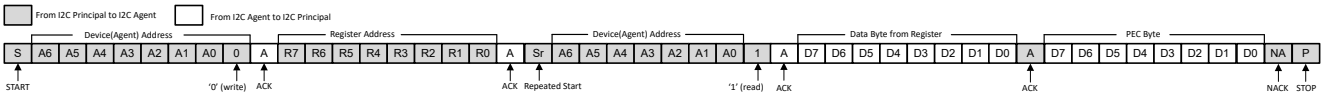

図 7-9. Single Byte Read with PEC

表 7-3 summarises the registers associated with a PEC Write command and resulting device behavior. 表 7-4 summarises the registers associated with a PEC Read command and resulting device behavior.

表 7-3. PEC Write Summary

EN_PEC	REQ_PEC	PEC_INT	Interrupt Status
0	x	x	PEC byte is not required in write operation, NO NIRQ assertion.
1	0	x	A write command missing a PEC byte is treated as OK, the write command executes and result in a I2C ACK. A write command with an incorrect PEC is treated as an error, the write command does not execute and result in a I2C NACK. NO NIRQ assertion.
1	1	0	A missing PEC is treated as an error, a write command only executes if the correct PEC byte is provided. I2C communication still responds with an ACK although write command did not execute. A write command with an incorrect PEC is treated as an error, the write command does not execute and result in a I2C NACK. NO NIRQ assertion.
1	1	1	A missing PEC is treated as an error, a write command only executes if the correct PEC byte is provided. I2C communication still responds with an ACK although write command did not execute. A write command with an incorrect PEC is treated as an error, the write command does not execute and results in a I2C NACK. NIRQ is asserted when a write command with a incorrect or missing PEC byte is attempted.

表 7-4. PEC Read Summary

EN_PEC	REQ_PEC	PEC_INT	Interrupt Status
0	x	x	I2C read operation reponds with data stored in register, I2C read command does not respond with registers corresponding PEC byte.
1	x	x	I2C read operation reponds with data stored in register and corresponding PEC byte.

7.3.4 VDD

The TPS389006 is designed to operate from an input voltage supply range between 2.5V to 5.5V. An input supply capacitor is not required for this device; however, if the input supply is noisy good analog practice is to place a 1µF capacitor between the VDD pin and the GND pin.

V_{DD} needs to be at or above $V_{DD(MIN)}$ for at least the start-up delay (t_{SD}+ t_D) for the device to be fully functional.

7.3.5 MON

The TPS389006/08 and TPS389R0 combines two comparators with a precision reference voltage and a trimmed resistor divider per monitor (MON) channel. This configuration optimizes device accuracy because all resistor tolerances are accounted for in the accuracy and performance specifications. Both comparators also include built-in hysteresis that provides noise immunity and makes sure stable operation.

Although not required in most cases, for noisy applications good analog design practice is to place a 1nF to 10nF bypass capacitor at the MON input to reduce sensitivity to transient voltages on the monitored signal. Specific deglitch times can also be set independently for each MON via I^2C registers

When monitoring VDD supply voltage, the MON pin can be connected directly to VDD. The output (NIRQ) and (NRST) is high impedance when voltage at the MON pin is between upper and lower boundary of threshold.

7.3.6 NIRQ

NIRQ is a interrupt error ouput with latched behavior, if a monitored voltage falls or rises outside of the programmed OVHF and UVHF thresholds NIRQ is asserted. NIRQ remains in its low state until the action causing the fault is no longer present and a 1-to-clear is written to the bit signaling the fault. Un-mapping NIRQ from a fault reporting register does not de-assert the NIRQ signal. NIRQ is In a typical TPS389006/08-Q1,TPS389R0-Q1 application, the NIRQ output is connected to a reset or enable input of a processor [such as a digital signal processor (DSP) or application-specific integrated circuit (ASIC), or other processor type].

The TPS389006/08-Q1,TPS389R0-Q1 has an open drain active low output that requires a pull-up resistor to hold these lines high to the required voltage logic. Connect the pull-up resistor to the proper voltage rail to

enable the output to be connected to other devices at the correct interface voltage levels. The pull-up resistor value is determined by V_{OL}, output capacitive loading, and output leakage current. These values are specified in *セクション 6*. The open drain output can be connected as a wired-OR logic with other open drain signals such as another TPS389006/08-Q1,TPS389R0-Q1 NIRQ pin.

7.3.7 ADC

The ADC used in the TPS389006 runs on a 1Mhz clock with an effective sampling rate of 1/8MHz (= 125kHz). Initially, the ADC records with a resolution of 12 bits (1LSB = 0.41667mV) which is later round off to 8-bit data for I^2C transaction. (1LSB = 5mV) The ADC uses ping-pong architecture in which it requires 2us for both sampling and conversion per channel with a total of 2 sampling channels. While CH0 performs coarse conversion, CH1 does fine conversion and vice verse.

Digitized 8-bit data is updated once the fine conversion is completed, which occurs once every 8µs. Each I^2C transaction initiated for reading 8-bit MON_LVL data (the ADC data of a particular channel), 8-bit data is paused from updating until the I^2C transaction completes.

Voltage scaling is done using a resistor ladder, but for differential mode channels, a chopping circuit is used to get the average of both of the voltages (VMON + VMON_RS)/2 since VMON_RS can be negative and can't be converted into an ADC code. VMON – VMON_RS is calculated digitally by subtracting ((VMON + VMON_RS) /2) from VMON and then multiplying by 2.

The MONX channels can be configured in 1x (0.2V to 1.475V) or 4x mode (0.8V to 5.5V). For differential mode channels configured in 1x mode, (MON1 and MON2) the ADC range is limited up to 1.7V. To configure an ADC channel above 1.7V, please use 4x mode.

Real time voltage measurements use 式 2.

$$V_{lvl} = ((ADC[7:0] * 5mV) + 0.2) * (VRANGE\_MULT) \quad (2)$$

1. ADC[7:0] is translated to a corresponding decimal value. The value of ADC[7:0] corresponding to MON1-MON6 can be read from registers 0x40-0x45 of セクション 7.5.1.
2. VRANGE_MULT corresponds to the selected monitor voltage multiplier set in register 0x1F of セクション 7.5.2.
3. VRANGE_MULT is set to a decimal 1 or 4 value depending on monitored value.

7.3.8 Time Stamp

Time stamp measurement use 式 3. The time stamps are used for sequence logging purposes to determine the order in which the rails are turned on or off.

$$t_{stamp} = 50\mu s * CLOCK[15:0] \quad (3)$$

1. CLOCK[15:0] translated to corresponding decimal value. The value of CLOCK[15:0] corresponding to MON1-MON6 can be read from registers 0x90-0x9B of BANK0.

7.3.9 NRST

The NRST pin in the TPS389R0-Q1 features a programmable reset delay time that can be adjusted from 0.2ms to 200ms when using TI_CONTROL register. NRST is an open-drain output that must be pulled up through a 1kΩ to 100kΩ pullup resistor. When the device is powered up and POR is complete, NRST is asserted low until the BIST is complete. After the BIST, NRST remains high (not asserted) until it is triggered by a mappable fault condition. An NRST_MISMATCH fault will be asserted if the NRST pin is pulled to an unexpected state. For example, if the NRST pin is in a high-impedance state (logic high) and is externally pulled low, then an NRST_MISMATCH fault will assert. During an NRST toggle NRST mismatch will be active after 2µs, NRST must exceed 0.6*VDD to be considered in a logic high state. For conditions resulting in a Failsafe mode NRST pin will assert low and stay asserted until a power cycle.

NRST is also mappable to the OVHF and UVHF faults using the FC_LF[n] registers. If a monitored voltage falls or rises outside of the programmed OVHF and UVHF thresholds, then NRST is asserted, driving the NRST pin low. When the monitored voltage comes back into the valid window, a reset delay circuit is enabled that holds NRST low for a specified reset delay period (t_D). Note if NRST is un-mapped from OVHF and UVHF faults while NRST is asserted then NRST deasserts, NRST reasserts when re-mapped assuming the voltage is still outside the valid window

The t_D period is determined by the RST_DLY[2:0] value found in the TI_CONTROL register. When the reset delay has elapsed, the NRST pin goes to a high-impedance state and uses a pullup resistor to hold NRST high. The pullup resistor must be connected to the proper voltage rail to allow other devices to be connected at the correct interface voltage. To ensure proper voltage levels, give some consideration when choosing the pullup resistor values. The pullup resistor value is determined by output logic low voltage (VOL), capacitive loading, and leakage current.

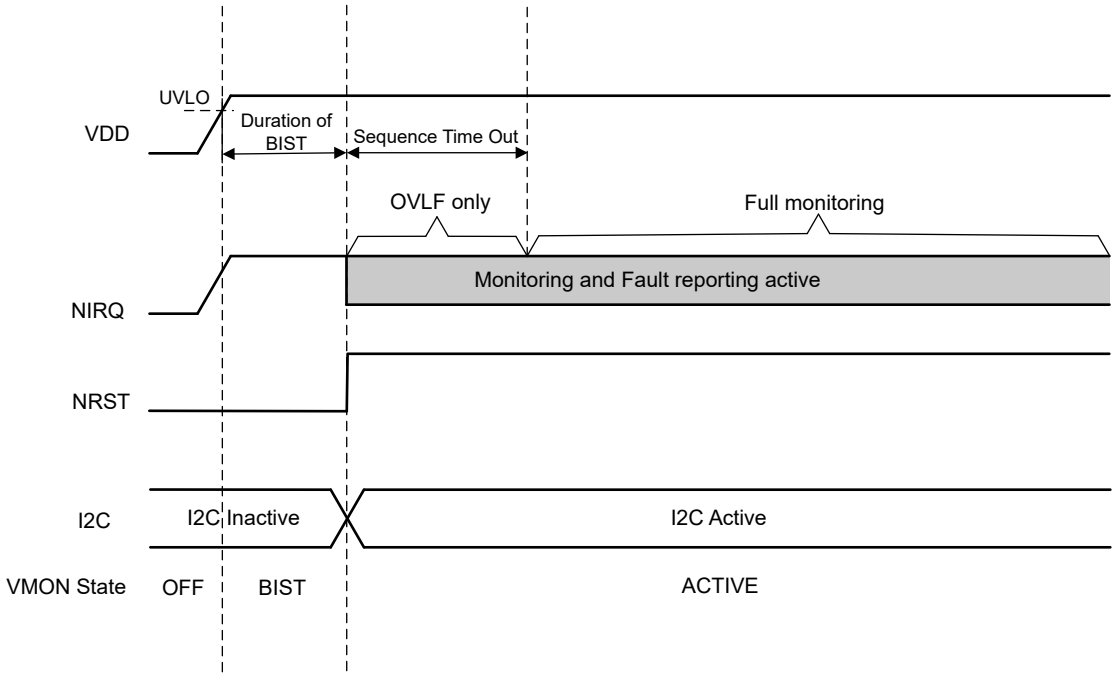

図 7-10. TPS389R0-Q1Start up Behavior Reset Pin

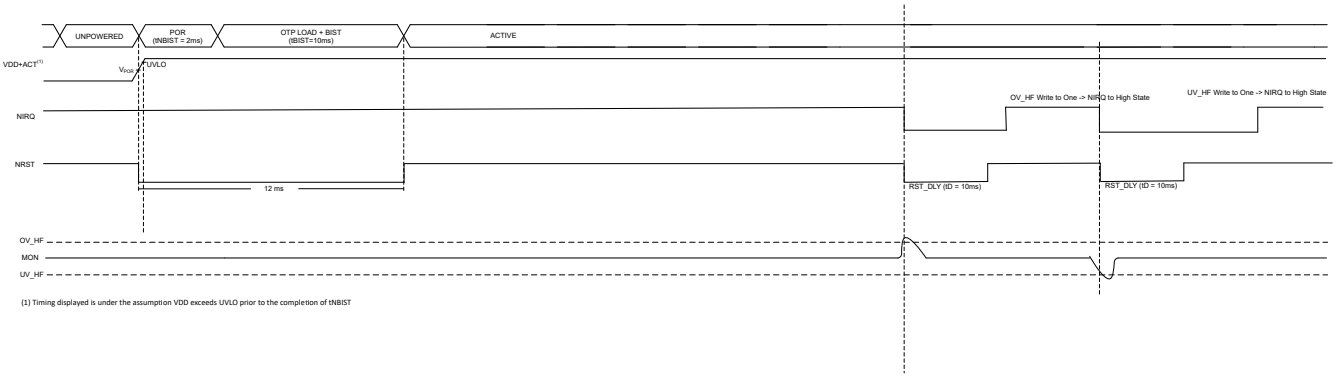

図 7-11. TPS389R0-Q1Reset Timing diagram for voltage faults

7.3.10 Register Protection

TPS389006/08-Q1 and TPS389R0-Q1 features register protection enabled through registers PROT1 0xF1h and PROT2 0xF2h. Registers PROT1 and PROT2 composition is shown in table 表 7-5.

表 7-5. PROT1 Register Description

Register	Bit	7	6	5	4	3	2	1	0
PROT1 (0xF1)	R/W	RSVD	RSVD	WRKC	WRKS	CFG	IEN	MON	SEQ
PROT2 (0xF2)	R/W	RSVD	RSVD	WRKC	WRKS	CFG	IEN	MON	SEQ

To write-protect a register group, the host must set the relevant bit in both registers PROT1 and PROT2. Register groups are split up into categories as shown in 表 7-6. Register groups are only applicable to registers in Bank One.

表 7-6. Write-Protect Register Group Summary

Register name	PROT group	Register name	PROT group
VMON_CTL	WRKC	TI_CONTROL	N/A
VMON_MISC	CFG	AMSK_ON	IEN
TEST_CFG	CFG	AMSK_OFF	IEN
IEN_UVHP	IEN	SEQ_TOUT_MSB	SEQ
IEN_UVLP	IEN	SEQ_TOUT_LSB	SEQ
IEN_OVHP	IEN	SEQ_UP_THLD	SEQ
IEN_OVLP	IEN	SEQ_DN_THLD	SEQ
IEN_CONTROL	IEN	BANK_SEL	N/A
IEN_TEST	IEN	MON4 settings	MON[4]
IEN_VENDOR	IEN	MON5 settings	MON[5]
VIN_CH_EN	CFG	MON6 settings	MON[6]
VRANGE_MULT	CFG	MON7 settings	MON[7]
MON1 settings	MON[1]	MON8 settings	MON[8]
MON2 settings	MON[2]	-	-
MON3 settings	MON[3]	-	-

If individual monitor protection is desired this can be achieved through the use of register PROT_MON (0xF3) as seen in figure 表 7-7.

表 7-7. PROT_MON Register Description

Register	Bit	7	6	5	4	3	2	1	0
PROT_MON (0xF3)	R/W	MON[8]	MON[7]	MON[6]	MON[5]	MON[4]	MON[3]	MON[2]	MON[1]

Register PROT_MON selects the monitor channel which is protected once PROT1 AND PROT2 registers are written to protect the MON group. Register PROT_MON is set to a value of 0xFF by default, this makes it such that when MON protection is applied through registers PROT1 and PROT2 the protection is applied to all monitors. If a user wishes to not apply protection to a specific monitor channel then the user must set the bit corresponding to the monitor channel in question to a value of 0 prior to PROT1 and PROT2 being set.

At start up registers PROT1 and PROT2 are set to a default value of 0x00. Once a bit is set to 1 in PROT1 or PROT2 the bit will become read-only and cannot be cleared by a write command. To reset PROT1 and PROT2 the user can utilize RESET_PROT, bit 3 of the VMON_CTL register. RESET_PROT is part of the WRKC register set therefore if the user desires to use RESET_PROT's functionality WRKC protection should be included when

configuring PROT1 and PROT2 protection registers. If WRKC protection is enabled when configuring PROT1 and PROT2 then protection registers can only be reset through a device power cycle.

7.4 Device Functional Modes

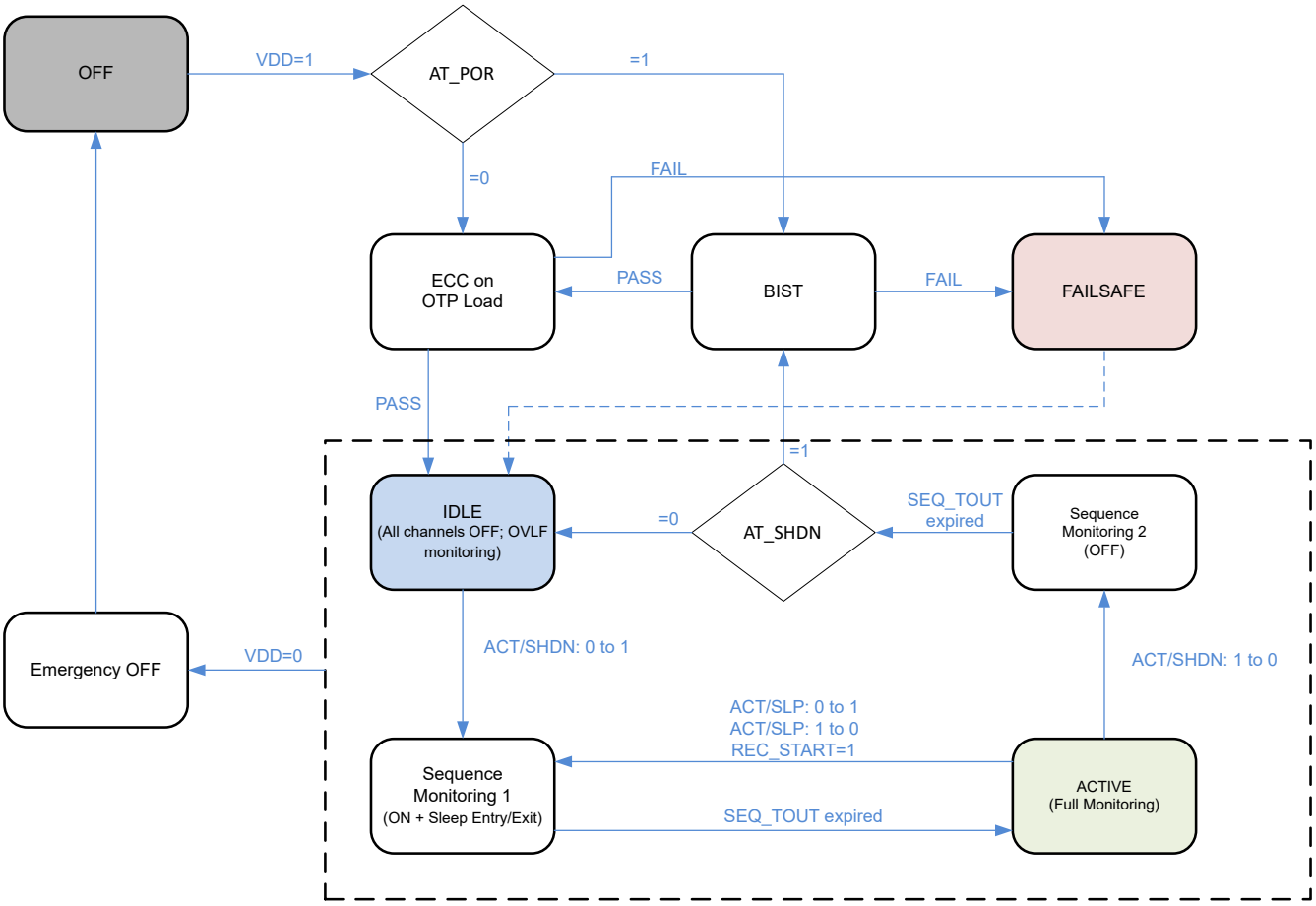

図 7-12. TPS389006/08-Q1,TPS389R0-Q1 State Diagram

7.4.1 Built-In Self Test and Configuration Load

Built-In Self Test (BIST) is performed:

1. At Power On Reset (POR), if TEST_CFG.AT_POR=1
2. When exiting ACTIVE state due to ACT transitioning from 1→0, if TEST_CFG.AT_SHDN=1

Configuration load from OTP is assisted by ECC (supporting SEC-DED). This is to protect against data integrity issues and to maximize system availability.

During BIST, NIRQ is de-asserted (asserted in case of failure),NRST is asserted (for devices with NRST pin), input pins are ignored, $\overline{\text{SYNC}}$ is tri-stated, and the I^2C block is inactive with SDA and SCL de-asserted. The BIST includes device testing to meet the Functional Safety goals outlined in functional safety documentation. Once BIST is completed without failure, I^2C is immediately active and the device enters the IDLE sate after loading the configuration data from OTP. If BIST fails and/or ECC reports Double-Error Detection (DED; meant for detecting multiple bit flips when loading data from memory), NIRQ and NRST (for devices with NRST pin) is asserted, the device enters FAILSAFE state, and a best effort attempt is made to keep the I^2C function active. TEST_INFO register can provide additional information on the test results.

The detailed behavior upon success/failure of the BIST is controlled by INT_TEST and IEN_TEST registers. Reporting of the BIST results is carried out through:

- NIRQ pin: pulled low depending on the test result and BIST_C and BIST bits in IEN_TEST
- NRST pin (if applicable): pulled low depending on the test result and BIST_C and BIST bits in IEN_TEST
- I_BIST_C and BIST bits in INT_TEST register depending on IEN_TEST settings
- VMON_STAT.ST_BIST_C register bit
- TEST_INFO[3:0] register bits

7.4.1.1 Notes on BIST Execution

Upon Power-On-Reset, the TPS389006/08-Q1,TPS389R0-Q1 needs to make a decision whether to run BIST or not, based on the value of the TEST_CFG.AT_POR register bit. Assuming that ECC on this register is performed after BIST has checked the ECC logic itself, verification of the data integrity before running BIST is not possible.

7.4.2 TPS389006/08-Q1,TPS389R0-Q1 Power ON

When the TPS389006/08-Q1,TPS389R0-Q1 is powered ON, BIST is optionally executed (depending on TEST_CFG.AT_POR register bit); I^2C and fault reporting (through NIRQ) become active as soon as BIST is completed and configuration is loaded from OTP (assisted by ECC, supporting SEC-DED).

The details of the configuration load ECC and BIST results are reported in TEST_INFO register.

Upon detection of the ACT rising edge, the TPS389006/08-Q1,TPS389R0-Q1 starts the sequence timeout timer and the monitoring of the power ON sequence. $\overline{\text{SLEEP}}$ is ignored until ACT is High and the sequence timeout has expired. The TPS389006/08-Q1,TPS389R0-Q1 will then act on $\overline{\text{SLEEP}}$ transitions to monitor/record Sleep Entry/Exit sequences.

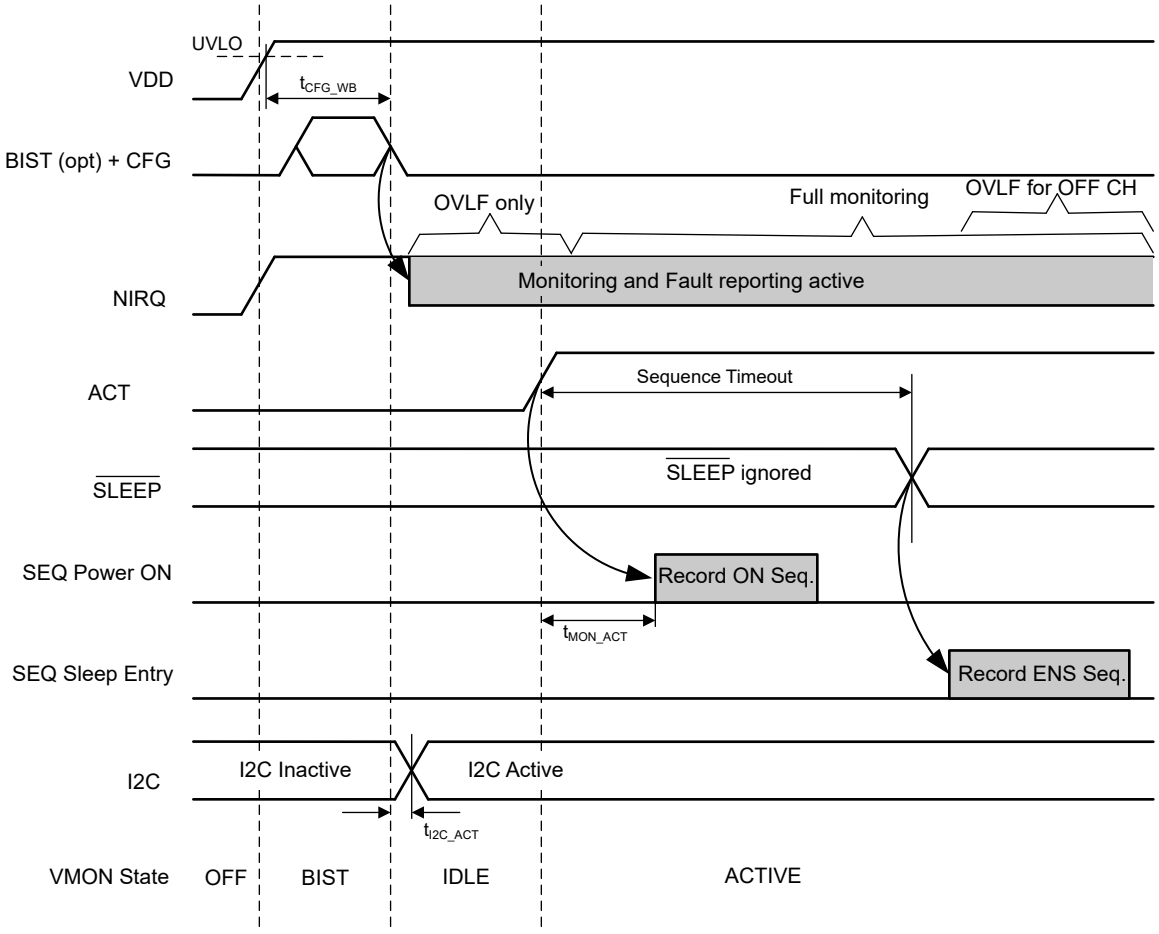

図 7-13. TPS389006/08-Q1 Power ON Signaling and Internal States

BIST completion can be detected through interrupt or register polling:

- Interrupt: INT_TEST.I_BIST_C flag is set and NIRQ is asserted if IEN_TEST.BIST_C=1
- Polling: VMON_STAT register can be polled to read the ST_BIST_C bit

7.4.3 General Monitoring

TPS389006/08 and TPS389R0 has multiple monitoring modes including IDLE, ACTIVE, SLEEP, and DEEP SLEEP. These modes refer to the monitoring states of the device shown in 表 7-8.

7.4.3.1 IDLE Monitoring

The TPS389006/08-Q1,TPS389R0-Q1 is in IDLE state when ACT is Low and BIST is completed.

In this state, all monitored channels are expected to be in the OFF state (below the OFF threshold).

For the enabled channels in OFF state, only the Overvoltage Low Frequency (OVLF) thresholds are monitored to make sure the reliability limits are not violated.

7.4.3.2 ACTIVE Monitoring

The TPS389006/08-Q1,TPS389R0-Q1 is in ACTIVE state when ACT is High.

VMON monitors high frequency channel levels (comparator sense path) and low frequency channel levels (ADC sense path) against Undervoltage High Frequency (UVHF), Overvoltage High Frequency (OVHF), Undervoltage Low Frequency (UVLF), and Overvoltage Low Frequency (OVLF) thresholds.

Some channels can be connected to rails which are controlled by user software. Such channels can be in the OFF state (below the OFF threshold) when the TPS389006/08-Q1,TPS389R0-Q1 is in an ACTIVE state, and have the UVLF/UVHF interrupts normally disabled. Once these rails are turned ON, the TPS389006/08-Q1,TPS389R0-Q1 host enables the channels UVLF/UVHF interrupts to allow full monitoring. Similarly, before these rails are turned OFF, the TPS389006/08-Q1,TPS389R0-Q1 host disables the channels UVLF/UVHF interrupts to avoid false UV violations during the ramp down. As these channels are not part of the sequencing initiated by ACT or $\overline{\text{SLEEP}}$, the UVLF/UVHF/OVHF interrupts cannot be automatically enabled/disabled using the auto-mask registers. While in the OFF state, only the OVLF thresholds are monitored to make sure the reliability limits are not violated.

Other enabled channels can be in OFF state as a result of the $\overline{\text{SLEEP}}$ 1→0 transition sequence. Those channels are identified by the AMSK_ENS auto-mask register, used to avoid UVLF interrupts (as well as UVHF and OVHF interrupts) during the transition. For those channels in the OFF state and identified by the AMSK_ENS register, only the OVLF thresholds are monitored to make sure the reliability limits are not violated.

表 7-8. Modes of Operation Summary

Mode	Pin/Bit Condition	Iq	Monitored- Triggers NIRQ if CHx enabled	Status only	ADC/Telemetry
ACTIVE	ACT=High, Sleep=High	1.5mA	OVLF, UVLF, OVHF, UVHF	OFF	Enabled
IDLE	ACT=Low, Sleep=X	230uA	OVLF	OFF	Disabled
SLEEP ACT=High, SLEEP=Low Sleep Power bit=1	CHx not assigned to Sleep	1.5mA	OVLF, UVLF, OVHF, UVHF	OFF	Enabled
	CHx assigned to Sleep (AMSK=1)		OVLF	OFF	
	CHx assigned to Sleep (AMSK=0)		OVLF, UVLF, OVHF, UVHF	OFF	
DEEP SLEEP ACT=High, SLEEP=Low Sleep Power bit=0	CHx not assigned to Sleep	330uA	OVHF, UVHF	-	Disabled
	CHx assigned to Sleep (AMSK=1)		No monitoring	-	
	CHx assigned to Sleep (AMSK=0)		OVHF, UVHF	-	

7.4.3.3 Sequence Monitoring 1

In addition to voltage monitoring, voltage rails sequences are also monitored on ACT and $\overline{\text{SLEEP}}$ changes, or on setting SEQ_REC_CTL.REC_START=1.

Sequence Monitoring 1 is a transitional state entered when:

1. ACT transitions 0→1
2. $\overline{\text{SLEEP}}$ transitions 0→1, if ACT=1
3. $\overline{\text{SLEEP}}$ transitions 1→0, if ACT=1
4. Host sets SEQ_REC_CTL.REC_START=1

The first three transitions trigger the same set of actions, with the TPS389006/08-Q1,TPS389R0-Q1 always ending in the ACTIVE state. However, the registers used to log and check the sequencing information are different.

The fourth method to start sequence monitoring (register bit set by the host) gives the flexibility to the host to decide when and where to track a sequence while the external signals are static. This is useful, for example, when software shutdown is initiated using FORCE_SHUTDOWN[1:0].

The following sections describe the actions for the first three cases explicitly for clarity.

7.4.3.3.1 ACT Transitions 0→1

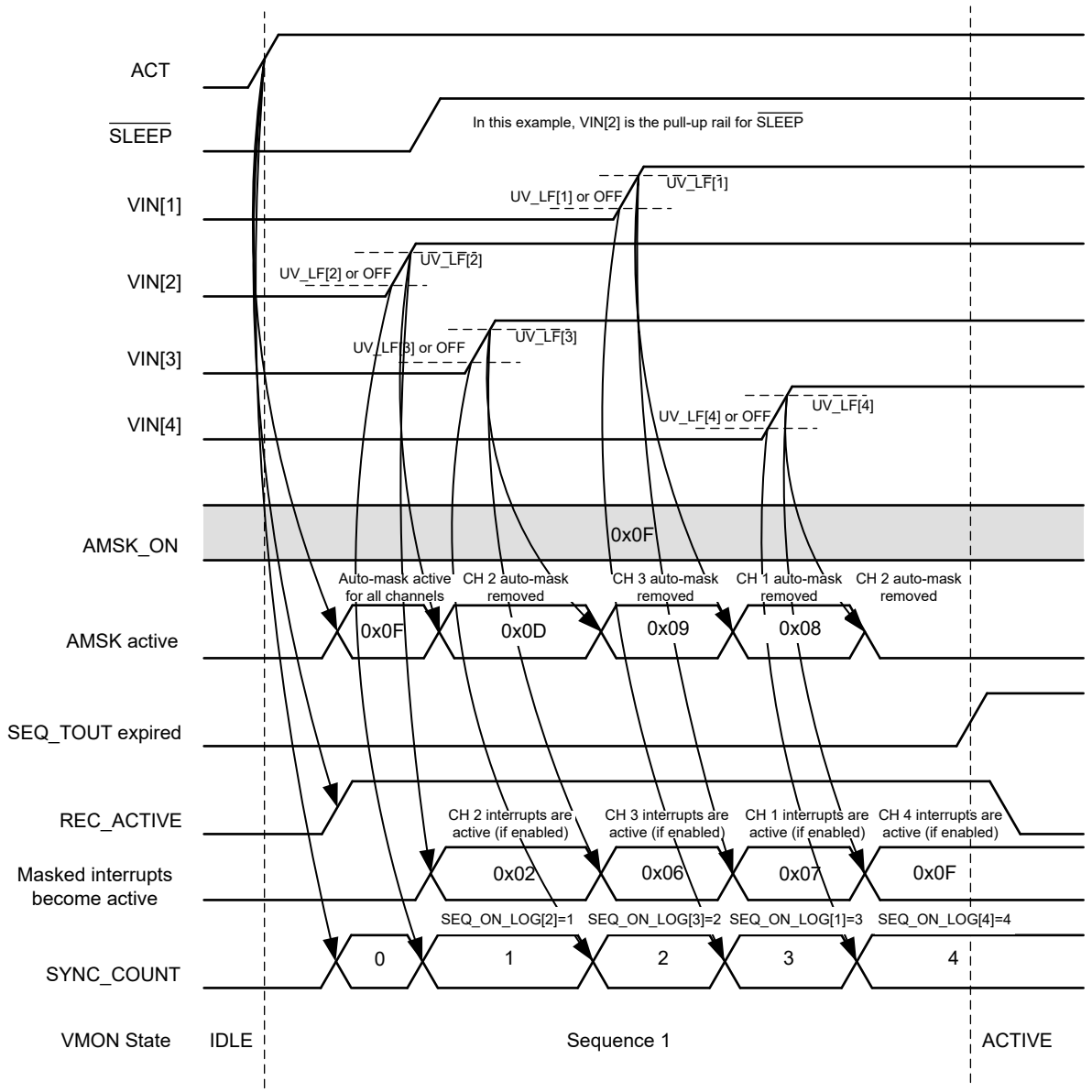

図 7-14. ACT 0→1 Transition

1. The TPS389006/08-Q1,TPS389R0-Q1 takes several actions on the ACT 0→1 transition:
   a. The synchronization counter is reset to 0.
   b. The REC_ACTIVE bit is set, and SEQ[1:0] bits are updated to 00b.
   c. If the sequence overwrite bit is enabled (EN_SEQ_OW=1), the sequence logging registers (SEQ_ON_LOG[N]) are overwritten with new data. If there was data in the registers that was not read by the host (SEQ_ON_RDY still set), the sequence overwrite flag (SEQ_ON_OW) gets set.
   d. If the timestamps overwrite bit is enabled (EN_TS_OW=1), the timestamp logging registers (SEQ_TIME_xSB[N]) are overwritten with new data. If there was data in the registers that was not read by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set.

e. If the sequence overwrite bit is disabled (EN_SEQ_OW=0) and there was data in the registers SEQ_ON_LOG[N] that was not read and acknowledged by the host (SEQ_ON_RDY still set), the sequence overwrite flag (SEQ_ON_OW) is set and does not overwrite the registers with new data.
f. If the timestamp overwrite bit is disabled (EN_TS_OW=0) and there was data in the registers SEQ_TIME_xSB[N] that was not read and acknowledged by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set and does not overwrite the registers with new data.
g. The internal sequence timer is (re)started.

2. All TPS389006/08-Q1,TPS389R0-Q1 inputs selected with auto-mask register AMSK_ON start with masked (disabled) interrupts for Undervoltage Low Frequency (UVLF), Undervoltage High Frequency (UVHF), and Overvoltage High Frequency (OVHF) conditions.
3. As each rail passes the UVLF threshold (UV_LF[N]), automatically (and expected to happen within about 5-10µs) the relevant UV and OV interrupts are unmasked and enabled/disabled according to the IEN_UVLF, IEN_UVHF, and IEN_OVHF registers.
4. As each rail passes the UVLF or OFF threshold (depending on SEQ_UP_THLD.OFF_UV[N] register setting), the rail is tagged with a counter corresponding to the order of rising edge transition. A timestamp is also logged.
   a. the tag value stored in the relevant status register SEQ_ON_LOG[N] if allowed as per overwrite settings and status. also, the timestamp of the event is stored in registers SEQ_TIME_MSB[N] and SEQ_TIME_LSB[N] as allowed by the overwrite settings and status.
   b. the SEQ_ON_LOG[N] register is compared to the expected sequence order value defined in register SEQ_EXP[N], and an interrupt is generated if different and if the relevant interrupt enable bit is set (IEN_SEQ_ON). Note that if overwrite settings and recording status do not allow writing new data to the logging registers, then the comparison cannot be performed and no interrupt will be generated.
5. After a timeout, tagging stops.
   a. Clear the REC_ACTIVE bit.
   b. If rails are up with the correct sequence, TPS389006/08-Q1,TPS389R0-Q1 is in ACTIVE state and starts normal monitoring.
   c. If any rail has a tag not matching the configured value in SEQ_ON_EXP[N] register, NIRQ is asserted. The TPS389006/08-Q1,TPS389R0-Q1 continues normal monitoring.
   d. If $\overline{\text{SLEEP}}$ is low, the TPS389006/08-Q1,TPS389R0-Q1 will not start recording the Sleep Entry sequence, as sequence recording is started on ACT and $\overline{\text{SLEEP}}$ transitions, or when initiated through I^2C command.

7.4.3.3.2 $\overline{SLEEP}$ Transition 1→0

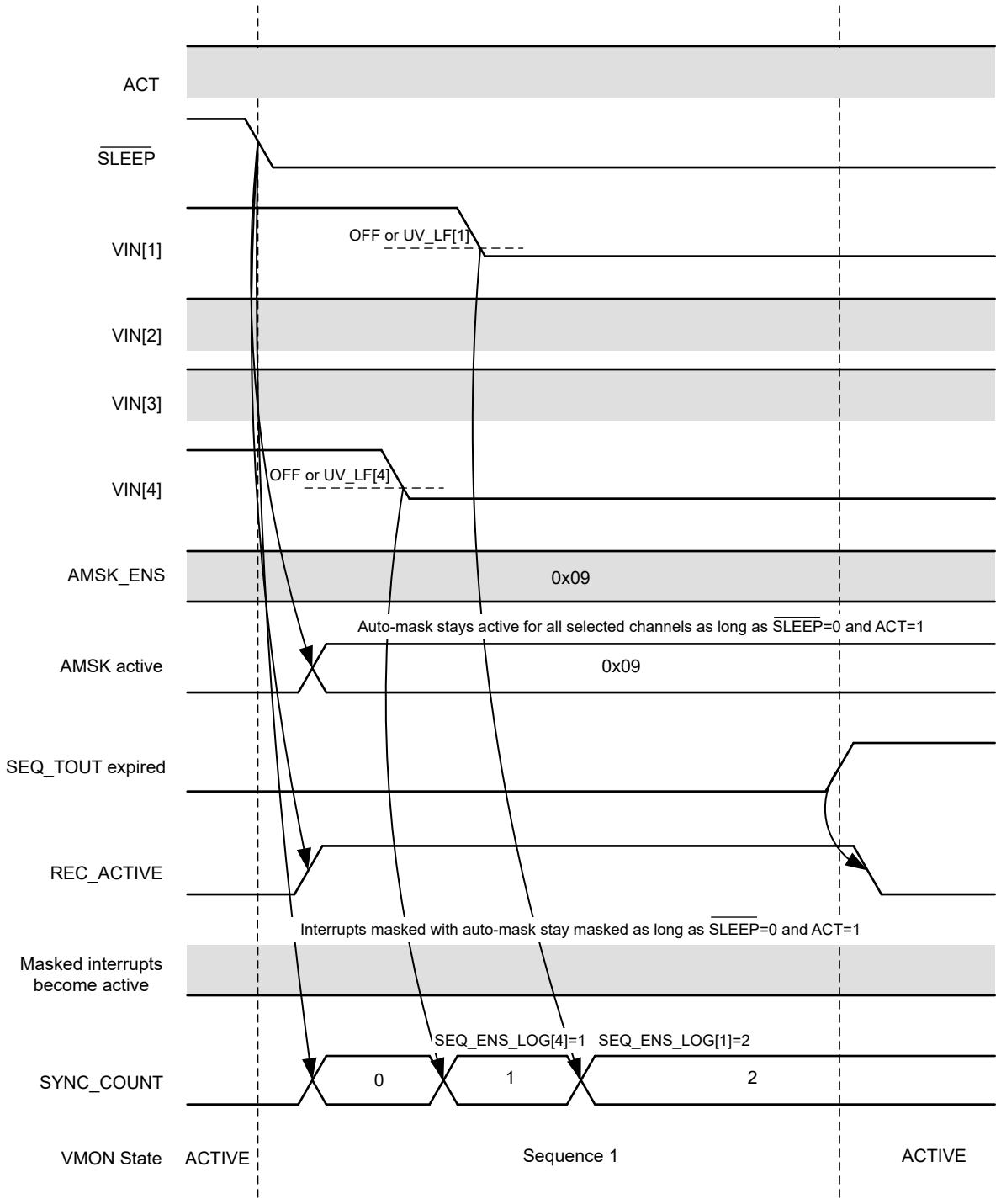

図 7-15. $\overline{SLEEP}$ 1→0 Transition

1. The TPS389006/08-Q1,TPS389R0-Q1 takes several actions on the $\overline{SLEEP}$ 1→0 transition:
   a. The synchronization counter is reset to 0.
   b. The REC_ACTIVE bit is set, and SEQ[1:0] bits are updated to 11b.

c. If the sequence overwrite bit is enabled (EN_SEQ_OW=1), the sequence logging registers (SEQ_ENS_LOG[N]) are overwritten with new data. If there was data in the registers that was not read by the host (SEQ_ENS_RDY still set), the timestamp overwrite flag (TS_OW) is set.
d. If the timestamp overwrite bit is enabled (EN_TS_OW=1), the timestamp logging registers (SEQ_TIME_xSB[N]) are overwritten with new data. If there was data in the registers that was not read by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set.
e. If the sequence overwrite bit is disabled (EN_SEQ_OW=0) and there was data in the registers SEQ_ENS_LOG[N] that was not read and acknowledged by the host (SEQ_ENS_RDY still set), the sequence overwrite flag (SEQ_ENS_OW) is set, and the registers are not overwritten with new data.
f. If the timestamp overwrite bit is disabled (EN_TS_OW=0) and there was data in the registers SEQ_TIME_xSB[N] that was not read and acknowledged by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set, and the registers are not overwritten with new data.
g. The internal sequence timer is (re)started.

2. Relevant TPS389006/08-Q1,TPS389R0-Q1 inputs selected with auto-mask register AMSK_ENS are set with masked interrupts for UVLF, UVHF and OVHF conditions.
3. As each rail passes the OFF or UVLF threshold (depending on SEQ_DN_THLD.OFF_UV[N] register setting), the rail is tagged with a counter corresponding to the order of falling edge transition. A timestamp is also logged.
   a. The tag value is stored in the relevant status register SEQ_ENS_LOG[N] if allowed as per overwrite settings and status. Also, the timestamp of the event is stored in registers SEQ_TIME_MSB[N] and SEQ_TIME_LSB[N] as allowed by the overwrite settings and status.
   b. The SEQ_ENS_LOG[N] register is compared to the expected sequence order value defined in register SEQ_ENS_EXP[N], and an interrupt is generated if different and if the relevant interrupt enable bit is set (IEN_SEQ_ENS). Note that if overwrite settings and recording status do not allow writing new data to the logging registers, then the comparison cannot be performed and no interrupt is generated.
4. After timeout, tagging stops.
   a. The REC_ACTIVE bit is cleared.
   b. If rails are down with the correct sequence, TPS389006/08-Q1,TPS389R0-Q1 is in ACTIVE state and continues normal monitoring (only OVLF thresholds are monitored for enabled channels in OFF state).

7.4.3.3.3 $\overline{SLEEP}$ Transition 0→1

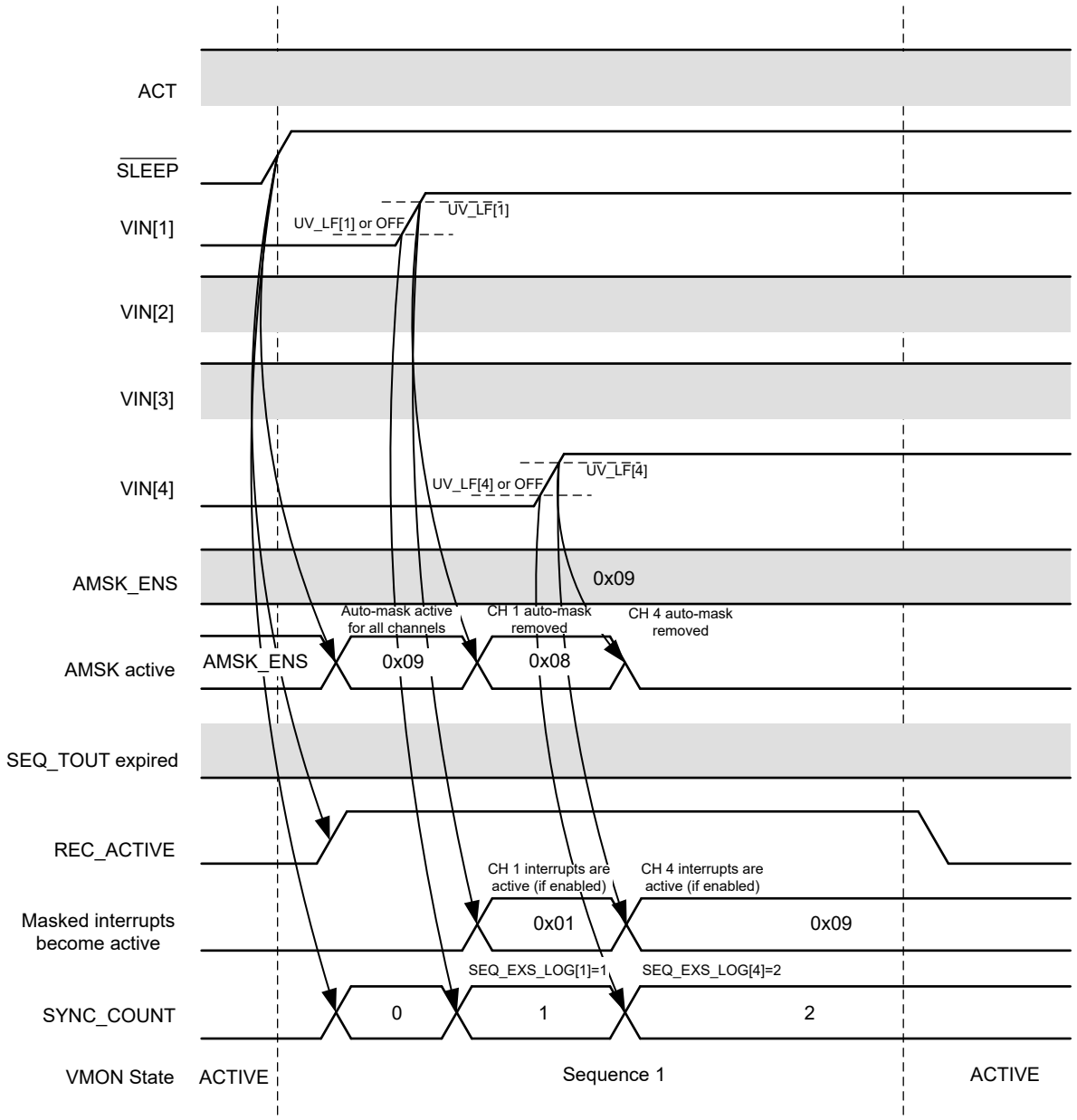

図 7-16. $\overline{SLEEP}$ 0→1 Transition

1. The TPS389006/08-Q1,TPS389R0-Q1 takes several actions on the $\overline{SLEEP}$ 0→1 transition:
   a. The synchronization counter is reset to 0.
   b. The REC_ACTIVE bit is set, and SEQ[1:0] bits are updated to 10b.
   c. If the sequence overwrite bit is enabled (EN_SEQ_OW=1), the sequence logging registers (SEQ_EXS_LOG[N]) are overwritten with new data. If there was data in the registers that was not read by the host (SEQ_EXS_RDY still set), the sequence overwrite flag (SEQ_EXS_OW) is set.
   d. If the timestamp overwrite bit is enabled (EN_TS_OW=1), the timestamp logging registers (SEQ_TIME_xSB[N]) are overwritten with new data. If there was data in the registers that was not read by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set.

e. If the sequence overwrite bit is disabled (EN_SEQ_OW=0) and there was data in the registers SEQ_EXS_LOG[N] that was not read and acknowledged by the host (SEQ_EXS_RDY still set), the sequence overwrite flag (SEQ_EXS_OW) is set, and the registers are not overwritten with new data.
f. If the timestamp overwrite bit is disabled (EN_TS_OW=0) and there was data in the registers SEQ_TIME_xSB[N] that was not read and acknowledged by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set, and the registers are not overwritten with new data.
g. The internal sequence timer is (re)started.

2. Relevant TPS389006/08-Q1,TPS389R0-Q1 inputs selected with auto-mask register AMSK_EXS are set with masked (disabled) interrupts for UVLF, UVHF, and OVHF conditions.
3. As each rail passes the UVLF threshold (UV_LF[N]), automatically (and expected to happen within about 5-10 µs) the relevant UV and OV interrupts are unmasked and enabled/disabled according to the IEN_UVLF, IEN_UVHF, and IEN_OVHF registers.
4. As each rail passes the UVLF or OFF threshold (depending on SEQ_UP_THLD.OFF_UV[N] register setting), the rail is tagged with a counter corresponding to the order of rising edge transition. A timestamp is also logged.
   a. The tag value is stored in the relevant status register SEQ_EXS_LOG[N] if allowed as per overwrite settings and status. Also, the timestamp of the event is stored in registers SEQ_TIME_MSB[N] and SEQ_TIME_LSB[N] as allowed by the overwrite settings and status.
   b. The SEQ_EXS_LOG[N] register is compared to the expected sequence order value defined in register SEQ_EXS_EXP[N], and an interrupt is generated if different and if relevant interrupt enable bit is set (IEN_SEQ_EXS). Note that if overwrite settings and recording status do not allow writing new data to the logging registers, then the comparison cannot be performed and no interrupt is generated.
5. After a timeout, tagging stops.
   a. The REC_ACTIVE bit is cleared.
   b. If rails are up with the correct sequence, TPS389006/08-Q1,TPS389R0-Q1 is in ACTIVE state and starts normal monitoring.
   c. If any rail has a tag not matching the configured value in SEQ_EXS_EXP[N] register, NIRQ is asserted. TPS389006/08-Q1,TPS389R0-Q1 continues normal monitoring.

7.4.3.4 Sequence Monitoring 2

Sequence Monitoring 2 is very similar to Sequence Monitoring 1, however, an extra step is taken when exiting this transitioning state depending on the TEST_CFG.AT_SHDN register bit.

Sequence Monitoring 2 is entered when ACT transitions 1→0. The actions taken are described in セクション 7.4.3.4.1.

7.4.3.4.1 ACT Transition 1→0

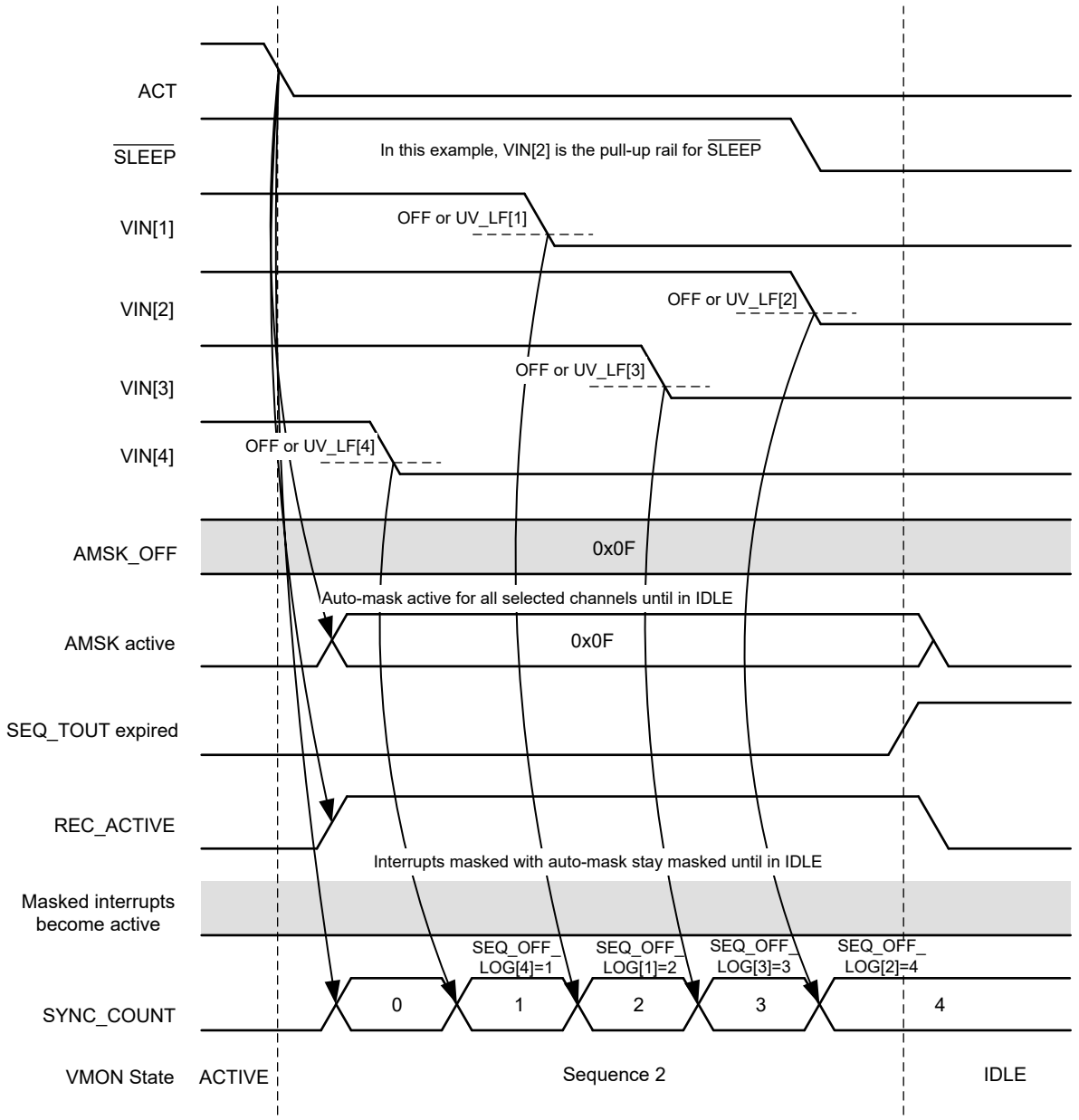

図 7-17. ACT 1→0 Transition

1. The TPS389006/08-Q1,TPS389R0-Q1 takes several actions on the ACT 1→0 transition:
   a. The synchronization counter is reset to 0.
   b. The REC_ACTIVE bit is set, and SEQ[1:0] bits are updated to 01b.
   c. If the sequence overwrite bit is enabled (EN_SEQ_OW=1), the sequence logging registers (SEQ_OFF_LOG[N]) are overwritten with new data. If there was data in the registers that was not read by the host (SEQ_OFF_RDY still set), the sequence overwrite flag (SEQ_OFF_OW) is set.
   d. If the timestamp overwrite bit is enabled (EN_TS_OW=1), the timestamp logging registers (SEQ_TIME_xSB[N]) are overwritten with new data. If there was data in the registers that was not read by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set.

e. If the sequence overwrite bit is disabled (EN_SEQ_OW=0) and there was data in the registers SEQ_OFF_LOG[N] that was not read and acknowledged by the host (SEQ_OFF_RDY still set), the sequence overwrite flag (SEQ_OFF_OW) is set, and the registers are not overwritten with new data.
f. If the timestamp overwrite bit is disabled (EN_TS_OW=0) and there was data in the registers SEQ_TIME_xSB[N] that was not read and acknowledged by the host (TS_RDY still set), the timestamp overwrite flag (TS_OW) is set, and the registers are not overwritten with new data.
g. The internal sequence timer is (re)started.

2. All TPS389006/08-Q1,TPS389R0-Q1 inputs selected with auto-mask register AMSK_OFF are set with masked (disabled) interrupts for UVLF, UVHF, and OVHF conditions.
3. As each rail passes the OFF or UVLF threshold (depending on SEQ_DN_THLD.OFF_UV[N] register setting), the rail is tagged with a counter corresponding to the order of falling edge transition. A timestamp is also logged.
   a. The tag value is stored in the relevant status register SEQ_OFF_LOG[N] if allowed as per overwrite settings and status. Also, the timestamp of the event is stored in registers SEQ_TIME_MSB[N] and SEQ_TIME_LSB[N] as allowed by the overwrite settings and status.
   b. The SEQ_OFF_LOG[N] register is compared to the expected sequence order value defined in register SEQ_OFF_EXP[N], and an interrupt is generated if different and if relevant interrupt enable bit is set (IEN_SEQ_OFF). Note that if overwrite settings and recording status do not allow writing new data to the logging registers, then the comparison cannot be performed and no interrupt will be generated.
4. After timeout, tagging stops.
   a. The REC_ACTIVE bit is cleared.
   b. If rails are down with the correct sequence, proceed to check TEST_CFG.AT_SHDN register bit.
   c. If any rail has a tag not matching the configured value in SEQ_OFF_EXP[N] register, NIRQ is asserted. TPS389006/08-Q1,TPS389R0-Q1 proceeds to check TEST_CFG.AT_SHDN register bit.
5. If TEST_CFG.AT_SHDN register bit is set, BIST is executed (next state depends on BIST results).
6. If TEST_CFG.AT_SHDN register bit is no set, the TPS389006/08-Q1,TPS389R0-Q1 enters IDLE state.

7.5 Register Maps

The register map is designed to support up to 16 channels through register banks, with the following organization:

- Bank 0 - Status Register Set Summary:
  - Vendor info and usage registers (bank independent)
  - Interrupt registers
  - Status registers
  - Bank selection register (bank independent)
  - Protection registers (bank independent)
  - Device configuration registers (bank independent)
- Bank 1 - Channel 1-8 Configuration Register Set Summary:
  - Vendor info and usage registers (bank independent)
  - Control registers (device global registers)
  - Monitor configuration registers (channel specific registers)
  - Sequence configuration registers (both device global and channel specific registers)
  - Bank selection register (bank independent)
  - Protection registers (bank independent)
  - Device configuration registers (bank independent)

Bank independent registers are accessible at the same address irrespective of the current bank selection. Access to other registers requires the proper bank being selected.

All registers are 8-bit wide, and are loaded at boot with the default value described here or with the OTP value programmed at the factory.

Unused registers addresses are reserved for future use and support up to 16 channels.

Write accesses to protected registers (see PROT1/2 details), invalid registers, or valid registers with invalid data, should be NACK'd.

7.5.1 BANK0 Registers

表 7-9 lists the memory-mapped registers for the BANK0 registers. All register offset addresses not listed in 表 7-9 should be considered as reserved locations and the register contents should not be modified.

表 7-9. BANK0 Registers

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x10	INT_SRC	F_OTHER	RESERVED				TEST	CONTROL	MONITOR
0x11	INT_MONITOR	SEQ_ON	SEQ_OFF	SEQ_EXS	SEQ_ENS	OV_LF	OV_HF	UV_LF	UV_HF
0x12	INT_UVHF	UVHF[N]							
0x14	INT_UVLF	UVLF[N]							
0x16	INT_OVHF	OVHF[N]							
0x18	INT_OVLF	OVLF[N]							
0x1A	INT_SEQ_ON	F_SEQ_ON[N]							
0x1C	INT_SEQ_OFF	F_SEQ_OFF[N]							
0x1E	INT_SEQ_EXS	F_SEQ_EXS[N]							
0x20	INT_SEQ_ENS	F_SEQ_ENS[N]							
0x22	INT_CONTROL	RESERVED			F_CRC	F_NIRQ	F_TSD	F_SYNC	F_PEC
0x23	INT_TEST	RESERVED				ECC_SEC	ECC_DED	I_BIST_C	BIST
0x24	INT_VENDOR	Self-Test_CRC	LDO_OV_Error	NRST_mismatch	Freq_DEV_Error	SHORT_DET	OPEN_DET	RESERVED	
0x30	VMON_STAT	FAILSAFE	ST_BIDT_C	ST_VDD	ST_NIRQ	ST_ACTSLP	ST_ACTSHDN	ST_SYNC	RESERVED
0x31	TEST_INFO	RESERVED		ECC_SEC	ECC_DED	BIST_VM	BIST_NVM	BIST_L	BIST_A
0x32	OFF_STAT	VIN[N]							
0x34	SEQ_REC_STAT	REC_ACTIVE	SEQ		TS_RDY	SEQ_ON_RDY	SEQ_OFF_RDY	SEQ_EXS_RDY	SEQ_ENS_RDY
0x35	SEQ_OW_STAT	RSVD			TS_OW	SEQ_ON_OW	SEQ_OFF_OW	SEQ_EXS_OW	SEQ_ENS_OW
0x36	SEQ_ORD_STAT	SYNC_COUNT[7:0]							
0x40	MON_LVL[1]	ADC[7:0]							
0x41	MON_LVL[2]	ADC[7:0]							
0x42	MON_LVL[3]	ADC[7:0]							
0x43	MON_LVL[4]	ADC[7:0]							
0x44	MON_LVL[5]	ADC[7:0]							
0x45	MON_LVL[6]	ADC[7:0]							
0x46	MON_LVL[7]	ADC[7:0]							
0x47	MON_LVL[8]	ADC[7:0]							
0x50	SEQ_ON_LOG[1]	ORDER[7:0]							
0x51	SEQ_ON_LOG[2]	ORDER[7:0]							
0x52	SEQ_ON_LOG[3]	ORDER[7:0]							
0x53	SEQ_ON_LOG[4]	ORDER[7:0]							
0x54	SEQ_ON_LOG[5]	ORDER[7:0]							
0x55	SEQ_ON_LOG[6]	ORDER[7:0]							

表 7-9. BANK0 Registers (続き)

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x56	SEQ_ON_LOG[7]	ORDER[7:0]							
0x57	SEQ_ON_LOG[8]	ORDER[7:0]							
0x60	SEQ_OFF_LOG[1]	ORDER[7:0]							
0x61	SEQ_OFF_LOG[2]	ORDER[7:0]							
0x62	SEQ_OFF_LOG[3]	ORDER[7:0]							
0x63	SEQ_OFF_LOG[4]	ORDER[7:0]							
0x64	SEQ_OFF_LOG[5]	ORDER[7:0]							
0x65	SEQ_OFF_LOG[6]	ORDER[7:0]							
0x66	SEQ_OFF_LOG[7]	ORDER[7:0]							
0x67	SEQ_OFF_LOG[8]	ORDER[7:0]							
0x70	SEQ_EXS_LOG[1]	ORDER[7:0]							
0x71	SEQ_EXS_LOG[2]	ORDER[7:0]							
0x72	SEQ_EXS_LOG[3]	ORDER[7:0]							
0x73	SEQ_EXS_LOG[4]	ORDER[7:0]							
0x74	SEQ_EXS_LOG[5]	ORDER[7:0]							
0x75	SEQ_EXS_LOG[6]	ORDER[7:0]							
0x76	SEQ_EXS_LOG[7]	ORDER[7:0]							
0x77	SEQ_EXS_LOG[8]	ORDER[7:0]							
0x80	SEQ_ENS_LOG[1]	ORDER[7:0]							
0x81	SEQ_ENS_LOG[2]	ORDER[7:0]							
0x82	SEQ_ENS_LOG[3]	ORDER[7:0]							
0x83	SEQ_ENS_LOG[4]	ORDER[7:0]							
0x84	SEQ_ENS_LOG[5]	ORDER[7:0]							
0x85	SEQ_ENS_LOG[6]	ORDER[7:0]							
0x86	SEQ_ENS_LOG[7]	ORDER[7:0]							
0x87	SEQ_ENS_LOG[8]	ORDER[7:0]							

表 7-9. BANK0 Registers (続き)

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x90	SEQ_TIME_MSB[1]	CLOCK[7:0]							
0x91	SEQ_TIME_LSB[1]	CLOCK[7:0]							
0x92	SEQ_TIME_MSB[2]	CLOCK[7:0]							
0x93	SEQ_TIME_LSB[2]	CLOCK[7:0]							
0x94	SEQ_TIME_MSB[3]	CLOCK[7:0]							
0x95	SEQ_TIME_LSB[3]	CLOCK[7:0]							
0x96	SEQ_TIME_MSB[4]	CLOCK[7:0]							
0x97	SEQ_TIME_LSB[4]	CLOCK[7:0]							
0x98	SEQ_TIME_MSB[5]	CLOCK[7:0]							
0x99	SEQ_TIME_LSB[5]	CLOCK[7:0]							
0x9A	SEQ_TIME_MSB[6]	CLOCK[7:0]							
0x9B	SEQ_TIME_LSB[6]	CLOCK[7:0]							
0x9C	SEQ_TIME_MSB[7]	CLOCK[7:0]							
0x9D	SEQ_TIME_LSB[7]	CLOCK[7:0]							
0x9E	SEQ_TIME_MSB[8]	CLOCK[7:0]							
0x9F	SEQ_TIME_LSB[8]	CLOCK[7:0]							
0xF0	BANK_SEL	RESERVED							BANK SELECTION
0xF1	PROT1	RESERVED		WRKC	WRKS	CFG	IEN	MON	SEQ
0xF2	PROT2	RESERVED		WRKC	WRKS	CFG	IEN	MON	SEQ
0xF3	PROT_MON2	RESERVED		MON[N]					
0xF9	I2CADDR	RESERVED	ADDR_NVM[3:0]				ADDR_STRAP[2:0]		
0xFA	DEV_CFG	RESERVED							SOC_IF

Complex bit access types are encoded to fit into small table cells. 表 7-10 shows the codes that are used for access types in this section.

表 7-10. BANK0 Access Type Codes

Access Type	Code	Description
Read Type		
R	R	Read
Write Type		
W	W	Write

表 7-10. BANK0 Access Type Codes (続き)

Access Type	Code	Description
W1C	W 1C	Write 1 to clear
Reset or Default Value		
-n		Value after reset or the default value

7.5.1.1 INT_SRC Register (Address = 0x10) [Reset = 0xX0]

INT_SRC is shown in 表 7-11.

Return to the Summary Table.

Global Interrupt Source Status register. This register contains fault interrupts on UV/OV HF/LF interrupts and internal fault interrupt and other interrupt. INT_SRC represents the reason why NIRQ was asserted. When the host processor receives NIRQ, the processor can read this register to quickly determine the source of the interrupt. If this register is clear, then the device did not assert NIRQ.

表 7-11. INT_SRC Register Field Descriptions

Bit	Field	Type	Reset	Description
7	F_OTHER	R	0b	Vendor specific internal fault. Details reported in INT_F_OTHER. This bit represents the ORed value of all bits in INT_F_OTHER. 0b = No fault reported in INT_F_OTHER 1b = Fault reported in INT_F_OTHER
6:3	RESERVED	R	b	Reserved
2	TEST	R	xb	Internal test or configuration load fault. Details reported in INT_TEST. Represents ORed value of all bits in INT_TEST. 0b = No test/configuration fault detected 1b = Test/configuration fault detected
1	CONTROL	R	xb	Control status or communication fault. Details reported in INT_CONTROL. Represents ORed value of all bits in INT_CONTROL. 0b = No status or communication fault detected 1b = Status or communication fault detected
0	MONITOR	R	xb	Voltage or sequence monitor fault. Details reported in INT_MONITOR. Represents ORed value of all bits in INT_MONITOR. 0b = No voltage or sequence fault detected 1b = Voltage or sequence fault detected

7.5.1.2 INT_MONITOR Register (Address = 0x11) [Reset = 0xX0]

INT_MONITOR is shown in 表 7-12.

Return to the Summary Table.

Voltage and Sequence Monitor Interrupt Status register. This register contains fault interrupts for sequence entry/exit from act/sleep modes and HF and LF faults.

表 7-12. INT_MONITOR Register Field Descriptions

Bit	Field	Type	Reset	Description
7	SEQ_ON	R	0b	Power ON Sequence Fault. Details reported in INT_SEQ_ON. Represents ORed value of all bits in INT_SEQ_ON. A Power ON Sequence fault occurs when the content of SEQ_ON_LOG[N] register does not match the value defined in SEQ_ON_EXP[N] register. 0b = No Power ON Sequence fault detected 1b = Power ON Sequence fault detected
6	SEQ_OFF	R	0b	Power OFF Sequence Fault. Details reported in INT_SEQ_OFF. Represents ORed value of all bits in INT_SEQ_OFF. A Power OFF Sequence fault occurs when the content of SEQ_OFF_LOG[N] register does not match the value defined in SEQ_OFF_EXP[N] register. 0b = No Power OFF Sequence fault detected 1b = Power OFF Sequence fault detected
5	SEQ_EXS	R	0b	Exit Sleep Sequence Fault. Details reported in INT_SEQ_EXS. Represents ORed value of all bits in INT_SEQ_EXS. An Exit Sleep Sequence fault occurs when the content of SEQ_EXS_LOG[N] register does not match the value defined in SEQ_EXS_EXP[N] register. 0b = No Exit Sleep Sequence fault detected 1b = Exit Sleep Sequence fault detected
4	SEQ_ENS	R	0b	Entry Sleep Sequence Fault. Details reported in INT_SEQ_ENS. Represents ORed value of all bits in INT_SEQ_ENS. An Entry Sleep Sequence fault occurs when the content of SEQ_ENS_LOG[N] register does not match the value defined in SEQ_ENS_EXP[N] register. 0b = No Entry Sleep Sequence fault detected 1b = Entry Sleep Sequence fault detected
3	OV_LF	R	xb	Overvoltage Low Frequency Fault. Details reported in INT_OVLF. Represents ORed value of all bits in INT_OVLF. 0b = No OVLF fault detected 1b = OVLF fault detected
2	OV_HF	R	xb	Overvoltage High Frequency Fault. Details reported in INT_OVHF. Represents ORed value of all bits in INT_OVHF. 0b = No OVHF fault detected 1b = OVHF fault detected
1	UV_LF	R	xb	Undervoltage Low Frequency Fault. Details reported in INT_UVLF. Represents ORed value of all bits in INT_UVLF. 0b = No UVLF fault detected 1b = UVLF fault detected
0	UV_HF	R	xb	Undervoltage High Frequency Fault. Details reported in INT_UVHF. Represents ORed value of all bits in INT_UVHF. 0b = No UVHF fault detected 1b = UVHF fault detected

7.5.1.3 INT_UVHF Register (Address = 0x12) [Reset = 0xX0]

INT_UVHF is shown in 表 7-13.

Return to the Summary Table.

High Frequency channel Undervoltage Interrupt Status register. This register contains informtation on which channel had a UV HF fault.

表 7-13. INT_UVHF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	UVHF[N]	R/W1C	xxxxb	Undervoltage High Frequency Fault for channel N (1 through 8). Trips if channel N High Frequency signal goes below UV_HF[N]. The recovery of the fault condition does NOT clear the bit. The fault can only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the UVHF fault condition is also removed (channel N High Frequency signal is above UV_HF[N]). 0b = Channel N has no UVHF fault detected (or interrupt disabled in IEN_UVHF register) 1b = Channel N has UVHF fault detected

7.5.1.4 INT_UVLF Register (Address = 0x14) [Reset = 0xX0]

INT_UVLF is shown in 表 7-14.

Return to the Summary Table.

Low Frequency channel Undervoltage Interrupt Status register. This register contains informtation on which channel had a UV LF fault.

表 7-14. INT_UVLF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	UVLF[N]	R/W1C	xxxxb	Undervoltage Low Frequency Fault for channel N (1 through 8). Trips if channel N Low Frequency signal goes below UV_LF[N]. The recovery of the fault condition does NOT clear the bit. The fault can only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the UVLF fault condition is also removed (channel N Low Frequency signal is above UV_LF[N]). 0b = Channel N has no UVLF fault detected (or interrupt disabled in IEN_UVLF register) 1b = Channel N has UVLF fault detected

7.5.1.5 INT_OVHF Register (Address = 0x16) [Reset = 0xX0]

INT_OVHF is shown in 表 7-15.

Return to the Summary Table.

High Frequency channel Overvoltage Interrupt Status register. This register contains informtation on which channel had an OV HF fault.

表 7-15. INT_OVHF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	OVHF[N]	R/W1C	xxxxb	Overvoltage High Frequency Fault for channel N (1 through 8). Trips if channel N High Frequency signal goes above OV_HF[N]. The recovery of the fault condition does NOT clear the bit.The faultcan only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the OVHF fault condition is also removed (channel N High Frequency signal is below OV_HF[N]). 0b = Channel N has noOVHF fault detected (or interrupt disabled in IEN_OVHF register) 1b = Channel N has OVHF fault detected

7.5.1.6 INT_OVLF Register (Address = 0x18) [Reset = 0xX0]

INT_OVLF is shown in 表 7-16.

Return to the Summary Table.

Low Frequency channel Overvoltage Interrupt Status register. This register contains informtation on which channel had an OV LF fault.

表 7-16. INT_OVLF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	OVLF[N]	R/W1C	xxxxb	Overvoltage Low Frequency Fault for channel N (1 through 8). Trips if channel N Low Frequency signal goes above OV_LF[N]. The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the OVLF fault condition is also removed (channel N Low Frequency signal is below OV_LF[N]). 0b = Channel N has no OVLF fault detected (or interrupt disabled in IEN_OVLF register) 1b = Channel N has OVLF fault detected

7.5.1.7 INT_SEQ_ON Register (Address = 0x1A) [Reset = 0xX0]

INT_SEQ_ON is shown in 表 7-17.

Return to the Summary Table.

Power ON Sequence (ACT/ $\overline{\text{SLEEP}}$ 0 to 1) Interrupt Status register. This register contains informtation on which channel did not follow on sequence.

表 7-17. INT_SEQ_ON Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	F_SEQ_ON[N]	R/W1C	xxxxb	Power ON Sequence Fault for channel N (1 through 8). Trips if channel N recorded Power ON Sequence counter in SEQ_ON_LOG[N] register does not match the value defined in SEQ_ON_EXP[N] register. The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit. The bit sets again during next sequence if the same fault is detected. 0b = Channel N has no Power ON Sequence fault detected (or interrupt disabled in IEN_SEQ_ON register) 1b = Channel N has Power ON Sequence fault detected

7.5.1.8 INT_SEQ_OFF Register (Address = 0x1C) [Reset = 0xX0]

INT_SEQ_OFF is shown in 表 7-18.

Return to the Summary Table.

Power OFF Sequence (ACT/ $\overline{\text{SLEEP}}$ 1 to 0) Interrupt Status register. This register contains informtation on which channel did not follow off sequence.

表 7-18. INT_SEQ_OFF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	F_SEQ_OFF[N]	R/W1C	xxxxb	Power OFF Sequence Fault for channel N (1 through 8). Trips if channel N recorded Power OFF Sequence counter in SEQ_OFF_LOG[N] register does not match the value defined in SEQ_OFF_EXP[N] register. The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit. The bit sets again during next sequence if the same fault is detected. 0b = Channel N has no Power OFF Sequence fault detected (or interrupt disabled in IEN_SEQ_OFF register) 1b = Channel N has Power OFF Sequence fault detected

7.5.1.9 INT_SEQ_EXS Register (Address = 0x1E) [Reset = 0xX0]

INT_SEQ_EXS is shown in 表 7-19.

Return to the Summary Table.

Exit Sleep Sequence (ACT/ $\overline{\text{SLEEP}}$ 0 to 1) Interrupt Status register. This register contains informtation on which channel did not follow sleep exit sequence.

表 7-19. INT_SEQ_EXS Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	F_SEQ_EXS[N]	R/W1C	xxxxb	Exit Sleep Sequence Fault for channel N (1 through 8). Trips if channel N recorded Exit Sleep Sequence counter in SEQ_EXS_LOG[N] register does not match the value defined in SEQ_EXS_EXP[N] register. The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit. The bit sets again during next sequence if the same fault is detected. 0b = Channel N has no Exit Sleep Sequence fault detected (or interrupt disabled in IEN_SEQ_EXS register) 1b = Channel N has Exit Sleep Sequence fault detected

7.5.1.10 INT_SEQ_ENS Register (Address = 0x20) [Reset = 0xX0]

INT_SEQ_ENS is shown in 表 7-20.

Return to the Summary Table.

Entry Sleep Sequence ($\overline{\text{SLEEP}}$ 1 to 0) Interrupt Status register. This register contains informtation on which channel did not follow sleep entry sequence.

表 7-20. INT_SEQ_ENS Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	F_SEQ_ENS[N]	R/W1C	xxxxb	Entry Sleep Sequence Fault for channel N (1 through 8). Trips if channel N recorded Entry Sleep Sequence counter in SEQ_ENS_LOG[N] register does not match the value defined in SEQ_ENS_EXP[N] register. 0b = Channel N has no Entry Sleep Sequence fault detected (or interrupt disabled in IEN_SEQ_ENS register) 1b = Channel N has Entry Sleep Sequence fault detected

7.5.1.11 INT_CONTROL Register (Address = 0x22) [Reset = 0xX0]

INT_CONTROL is shown in 表 7-21.

Return to the Summary Table.

Control and Communication Interrupt Status Register.

表 7-21. INT_CONTROL Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4	F_CRC	R/W1C	0b	Runtime register CRC Fault: The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit. The bit sets again during next register CRC check if the same fault is detected. 0b = No fault detected (or IEN_CONTROL.RT_CRC is disabled) 1b = Register CRC fault detected
3	F_NIRQ	R/W1C	xb	Interrupt pin fault (fault bit always enabled no enable bit available): The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the NIRQ fault condition is also removed. 0b = No fault detected on NIRQ pin 1b = Low resistance path to supply detected on NIRQ pin
2	F_TSD	R/W1C	xb	Thermal Shutdown fault: The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the TSD fault condition is also removed. 0b = No TSD fault detected (or IEN_CONTROL.TSD is disabled) 1b = TSD fault detected
1	F_SYNC	R/W1C	xb	$\overline{\text{SYNC}}$ pin fault: The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the $\overline{\text{SYNC}}$ fault condition is also removed. 0b = No fault detected on $\overline{\text{SYNC}}$ pin (or IEN_CONTROL.SYNC is disabled) 1b = Low resistance path to supply detected on $\overline{\text{SYNC}}$ pin
0	F_PEC	R/W1C	xb	Packet Error Checking fault: The recovery of the fault condition does NOT clear the bit.The fault only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit. The bit will be set again during next I2C transaction if the same fault is detected.

7.5.1.12 INT_TEST Register (Address = 0x23) [Reset = 0xX0]

INT_TEST is shown in 表 7-22.

Return to the Summary Table.

Internal Test and Configuration Load Interrupt Status Register.

表 7-22. INT_TEST Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	RESERVED	R	b	Reserved
3	ECC_SEC	R/W1C	xb	ECC single-error corrected on OTP configuration load: Write-1-to-clear clears the bit. The bit will be set again during next OTP configuration load if the same fault is detected. 0b = No single-error corrected (or IEN_TEST.ECC_SEC is disabled) 1b = Single-error corrected

表 7-22. INT_TEST Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
2	ECC_DED	R/W1C	xb	ECC double-error detected on OTP configuration load: The fault bit is always enabled (there is no associated interrupt enable bit). Write-1-to-clear clears the bit. The bit will be set again during next OTP configuration load if the same fault is detected. 0b = No double-error detected on OTP load 1b = Double-error detected on OTP load
1	I_BIST_C	R/W1C	xb	Indication of Built-In Self-Test complete: Write-1-to-clear clears the bit. The bit sets again on completion of next BIST execution.Write-1-to-clear clears the bit. The bit sets again on completion of next BIST execution. 0b = BIST not complete (or IEN_TEST.BIST_C is disabled) 1b = BIST complete
0	BIST	R/W1C	xb	Built-In Self-Test fault: Write-1-to-clear clears the bit. The bit sets again during next BIST execution if the same fault is detected. 0b = No BIST fault detected (or IEN_TEST.BIST is disabled) 1b = BIST fault detected

7.5.1.13 INT_VENDOR Register (Address = 0x24) [Reset = 0xX0]

INT_VENDOR is shown in 表 7-23.

Return to the Summary Table.

This register contains various internal faults and ADDR detect pin fault.

表 7-23. INT_VENDOR Register Field Descriptions

Bit	Field	Type	Reset	Description
7	Self-Test_CRC	R/W1C	0b	Startup register CRC 0b 0= Self-test Pass 0b 1 = Self-test Fail Write- 1-to clear
6	LDO_OV_Error	R/W1C	0b	Internal LDO fault: 0 = No internal LDO fault detected 1 = Internal LDO fault detected Write- 1-to-clear clears the bit.
5	NRST_mismatch	R/W1C	0b	NRST PIN drive state and read back state error 1b = Mismatch fault detected The recovery of the fault condition does NOT clear the bit.The fault can only be cleared by the host with a write-1-to-clear. Write-1-to-clear clears the bit only if the NRST fault condition is also removed.
4	Freq_DEV_Error	R/W1C	0b	Internal Oscillator fault: 0 = No internal oscillator fault detected 1 = Internal oscillator fault detected Write- 1-to-clear clears the bit.
3	SHORT_DET	R/W1C	xb	Address Pin fault: 0 = No address pin fault detected 1 = Address pin fault detected Write- 1-to-clear clears the bit.
2	OPEN_DET	R/W1C	xb	Address Pin fault: 0 = No address pin fault detected 1 = Address pin fault detected Write- 1-to-clear clears the bit.

表 7-23. INT_VENDOR Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
1:0	RESERVED	R	b	Reserved

7.5.1.14 VMON_STAT Register (Address = 0x30) [Reset = 0xX0]

VMON_STAT is shown in 表 7-24.

Return to the Summary Table.

Status flags for internal operations and other non critical conditions. Status register showing completion of BIST, whether active or sleep or active/shutdown.

表 7-24. VMON_STAT Register Field Descriptions

Bit	Field	Type	Reset	Description
7	FAILSAFE	R	0b	Fail Safe state: 0 = Not in Fail Safe state 1 = In Fail Safe state
6	ST_BIDT_C	R	0b	Built-In Self-Test state: 0 = BIST not complete 1 = BIST complete
5	ST_VDD	R	0b	Current state of VDD pin: 0 = VDD pin is low. 1 = VDD pin is high.
4	ST_NIRQ	R	0b	Current state of NIRQ input: 0 = NIRQ pin driven low by system. 1 = NIRQ pin driven high by system.
3	ST_ACTSLP	R	xb	Current state of SLEEP input: 0 = SLEEP pin driven low by system. 1 = SLEEP pin driven high by system.
2	ST_ACTSHDN	R	xb	Current state of ACT input: 0 = ACT pin driven low by system. 1 = ACT pin driven high by system.
1	ST_SYNC	R	xb	Current state of $\overline{\text{SYNC}}$ pin: 0 = $\overline{\text{SYNC}}$ pin is low. 1 = $\overline{\text{SYNC}}$ pin is high.
0	RESERVED	R	b	Reserved

7.5.1.15 TEST_INFO Register (Address = 0x31) [Reset = 0xX0]

TEST_INFO is shown in 表 7-25.

Return to the Summary Table.

Internal Self-Test and ECC information.

表 7-25. TEST_INFO Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5	ECC_SEC	R	0b	Status of ECC single-error correction on OTP configuration load. 0 = no error correction applied 1 = single-error correction applied
4	ECC_DED	R	0b	Status of ECC double-error detection on OTP configuration load. 0 = no double-error detected 1 = double-error detected

表 7-25. TEST_INFO Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
3	BIST_VM	R	xb	Status of Volatile Memory test output from BIST. 0 = Volatile Memory test pass 1 = Volatile Memory test fail
2	BIST_NVM	R	xb	Status of Non-Volatile Memory test output from BIST. 0 = Non-Volatile Memory test pass 1 = Non-Volatile Memory test fail
1	BIST_L	R	xb	Status of Logic test output from BIST. 0 = Logic test pass 1 = Logic test fail
0	BIST_A	R	xb	Status of Analog test output from BIST. 0 = Analog test pass 1 = Analog test fail

7.5.1.16 OFF_STAT Register (Address = 0x32) [Reset = 0xX0]

OFF_STAT is shown in 表 7-26.

Return to the Summary Table.

Channel OFF status.

表 7-26. OFF_STAT Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	VIN[N]	R	xxxxb	This register represents the OFF status of each channel: 0 = channel N is NOT OFF 1 = channel N is OFF (below OFF threshold)

7.5.1.17 SEQ_REC_STAT Register (Address = 0x34) [Reset = 0xX0]

SEQ_REC_STAT is shown in 表 7-27.

Return to the Summary Table.

Sequence recording status register.

表 7-27. SEQ_REC_STAT Register Field Descriptions

Bit	Field	Type	Reset	Description
7	REC_ACTIVE	R	0b	Indicates the status of sequence logging (recording): 0 = No sequence recording active. 1 = ACT or $\overline{\text{SLEEP}}$ or SEQ_REC_CTL.REC_START initiated a power sequence and recording is active.
6:5	SEQ	R	0b	Current sequence being recorded: 00b = Power ON (ACT 01) 01b = Power OFF (ACT 10) 10b = Sleep Exit ($\overline{\text{SLEEP}}$ 01) 11b = Sleep Entry ($\overline{\text{SLEEP}}$ 10)
4	TS_RDY	R	0b	Timestamp data availability in SEQ_TIME_xSB registers: If EN_TS_OW= 0 this bit is cleared when TS_ACK is written to 1 by the host. If EN_TS_OW= 1 this bit is cleared when all the SEQ_TIME_xSB[N] registers for the enabled channels (in VIN_CH_EN register) are read. If the bit is set and REC_ACTIVE is also set, then the data in SEQ_TIME_xSB registers is being overwritten. 0 = No new data available or data already read. 1 = New data available (data still needs to be read).

表 7-27. SEQ_REC_STAT Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
3	SEQ_ON_RDY	R	xb	Power ON sequence data availability in SEQ_ON_LOG registers: If EN_SEQ_OW= 0 this bit is cleared when SEQ_ON_ACK is written to 1 by the host. If EN_SEQ_OW= 1 this bit is cleared when all the SEQ_ON_LOG registers for the enabled channels (in VIN_CH_EN register) are read. If the bit is set and REC_ACTIVE is set and SEQ[1: 0]= 00b, then the data in SEQ_ON_LOG registers is being overwritten. 0 = No new data available or data already read. 1 = New data available (data still needs to be read).
2	SEQ_OFF_RDY	R	xb	Power OFF sequence data availability in SEQ_OFF_LOG registers: If EN_SEQ_OW= 0 this bit is cleared when SEQ_OFF_ACK is written to 1 by the host. If EN_SEQ_OW= 1 this bit is cleared when all the SEQ_OFF_LOG registers for the enabled channels (in VIN_CH_EN register) are read. If the bit is set and REC_ACTIVE is set and SEQ[1: 0]= 01b, then the data in SEQ_OFF_LOG registers is being overwritten. 0 = No new data available or data already read. 1 = New data available (data still needs to be read).
1	SEQ_EXS_RDY	R	xb	Sleep Exit sequence data availability in SEQ_EXS_LOG registers: If EN_SEQ_OW= 0 this bit is cleared when SEQ_EXS_ACK is written to 1 by the host. If EN_SEQ_OW= 1 this bit is cleared when all the SEQ_EXS_LOG registers for the enabled channels (in VIN_CH_EN register) are read. If the bit is set and REC_ACTIVE is set and SEQ[1: 0]= 10b, then the data in SEQ_EXS_LOG registers is being overwritten. 0 = No new data available or data already read. 1 = New data available (data still needs to be read).
0	SEQ_ENS_RDY	R	xb	Sleep Entry sequence data availability in SEQ_ENS_LOG registers: If EN_SEQ_OW= 0 this bit is cleared when SEQ_ENS_ACK is written to 1 by the host. If EN_SEQ_OW= 1 this bit is cleared when all the SEQ_ENS_LOG registers for the enabled channels (in VIN_CH_EN register) are read. If the bit is set and REC_ACTIVE is set and SEQ[1: 0]= 11b, then the data in SEQ_ENS_LOG registers is being overwritten. 0 = No new data available or data already read. 1 = New data available (data still needs to be read).

7.5.1.18 SEQ_OW_STAT Register (Address = 0x35) [Reset = 0xX0]

SEQ_OW_STAT is shown in 表 7-28.

Return to the Summary Table.

Sequence recording overwrite status register.

表 7-28. SEQ_OW_STAT Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RSVD	R	0b	RSVD
4	TS_OW	R	0b	Timestamp data overwritten status: 0 = No data was overwritten 1 = Data was overwritten (if VMON_MISC.EN_TS_OW= 1), or data can not be written (if VMON_MISC.EN_TS_OW= 0)
3	SEQ_ON_OW	R	xb	Power ON sequence data overwritten status: 0 = No data was overwritten 1 = Data was overwritten (if VMON_MISC.EN_SEQ_OW= 1), or data can not be written (if VMON_MISC.EN_SEQ_OW= 0)
2	SEQ_OFF_OW	R	xb	Power OFF sequence data overwritten status: 0 = No data was overwritten 1 = Data was overwritten (if VMON_MISC.EN_SEQ_OW= 1), or data can not be written (if VMON_MISC.EN_SEQ_OW= 0)
1	SEQ_EXS_OW	R	xb	Sleep Exit sequence data overwritten status: 0 = No data was overwritten 1 = Data was overwritten (if VMON_MISC.EN_SEQ_OW= 1), or data can not be written (if VMON_MISC.EN_SEQ_OW= 0)
0	SEQ_ENS_OW	R	xb	Sleep Entry sequence data overwritten status: 0 = No data was overwritten 1 = Data was overwritten (if VMON_MISC.EN_SEQ_OW= 1), or data can not be written (if VMON_MISC.EN_SEQ_OW= 0)

7.5.1.19 SEQ_ORD_STAT Register (Address = 0x36) [Reset = 0xX0]

SEQ_ORD_STAT is shown in 表 7-29.

Return to the Summary Table.

Sequencing/$\overline{\text{SYNC}}$ counter (rail order) register value.

表 7-29. SEQ_ORD_STAT Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	SYNC_COUNT[7:0]	R	xxxxb	This register represents the counter value during a power/sleep sequence. It corresponds to the number of $\overline{\text{SYNC}}$ falling edges detected, and used as tag value for monitored channels.

7.5.1.20 MON_LVL[1] Register (Address = 0x40) [Reset = 0xX0]

MON_LVL[1] is shown in 表 7-30.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-30. MON_LVL[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 1. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.21 MON_LVL[2] Register (Address = 0x41) [Reset = 0xX0]

MON_LVL[2] is shown in 表 7-31.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-31. MON_LVL[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 2. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.22 MON_LVL[3] Register (Address = 0x42) [Reset = 0xX0]

MON_LVL[3] is shown in 表 7-32.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-32. MON_LVL[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 3. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.23 MON_LVL[4] Register (Address = 0x43) [Reset = 0xX0]

MON_LVL[4] is shown in 表 7-33.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-33. MON_LVL[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 4. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.24 MON_LVL[5] Register (Address = 0x44) [Reset = 0xX0]

MON_LVL[5] is shown in 表 7-34.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-34. MON_LVL[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 5. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.25 MON_LVL[6] Register (Address = 0x45) [Reset = 0xX0]

MON_LVL[6] is shown in 表 7-35.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-35. MON_LVL[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 6. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.26 MON_LVL[7] Register (Address = 0x46) [Reset = 0xX0]

MON_LVL[7] is shown in 表 7-36.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-36. MON_LVL[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 5. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.27 MON_LVL[8] Register (Address = 0x47) [Reset = 0xX0]

MON_LVL[8] is shown in 表 7-37.

Return to the Summary Table.

For ADC readout -of each channel - 8bits

表 7-37. MON_LVL[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ADC[7:0]	R	xxxxb	This register represents the 8-bit voltage level of channel 6. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling set to 1x, the 8-bit value represents the range 0.2V to 1.475V with 1LSB=5mV. With scaling set to 4x, the 8-bit value represents the range 0.8V to 5.9V with 1LSB=20mV.

7.5.1.28 SEQ_ON_LOG[1] Register (Address = 0x50) [Reset = 0xX0]

SEQ_ON_LOG[1] is shown in 表 7-38.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-38. SEQ_ON_LOG[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 1. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.29 SEQ_ON_LOG[2] Register (Address = 0x51) [Reset = 0xX0]

SEQ_ON_LOG[2] is shown in 表 7-39.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-39. SEQ_ON_LOG[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 2. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.30 SEQ_ON_LOG[3] Register (Address = 0x52) [Reset = 0xX0]

SEQ_ON_LOG[3] is shown in 表 7-40.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-40. SEQ_ON_LOG[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 3. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.31 SEQ_ON_LOG[4] Register (Address = 0x53) [Reset = 0xX0]

SEQ_ON_LOG[4] is shown in 表 7-41.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-41. SEQ_ON_LOG[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 4. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.32 SEQ_ON_LOG[5] Register (Address = 0x54) [Reset = 0xX0]

SEQ_ON_LOG[5] is shown in 表 7-42.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-42. SEQ_ON_LOG[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 5. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.33 SEQ_ON_LOG[6] Register (Address = 0x55) [Reset = 0xX0]

SEQ_ON_LOG[6] is shown in 表 7-43.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-43. SEQ_ON_LOG[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 6. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.34 SEQ_ON_LOG[7] Register (Address = 0x56) [Reset = 0xX0]

SEQ_ON_LOG[7] is shown in 表 7-44.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-44. SEQ_ON_LOG[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 7. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.35 SEQ_ON_LOG[8] Register (Address = 0x57) [Reset = 0xX0]

SEQ_ON_LOG[8] is shown in 表 7-45.

Return to the Summary Table.

Channel N Power ON sequence order value (ACT/ $\overline{\text{SLEEP}}$ 0 to 1).

表 7-45. SEQ_ON_LOG[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power ON sequence order value for channel 8. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage rising level passes the UV_LF[N] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.36 SEQ_OFF_LOG[1] Register (Address = 0x60) [Reset = 0xX0]

SEQ_OFF_LOG[1] is shown in 表 7-46.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-46. SEQ_OFF_LOG[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 1. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.37 SEQ_OFF_LOG[2] Register (Address = 0x61) [Reset = 0xX0]

SEQ_OFF_LOG[2] is shown in 表 7-47.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-47. SEQ_OFF_LOG[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 2. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.38 SEQ_OFF_LOG[3] Register (Address = 0x62) [Reset = 0xX0]

SEQ_OFF_LOG[3] is shown in 表 7-48.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-48. SEQ_OFF_LOG[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 3. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.39 SEQ_OFF_LOG[4] Register (Address = 0x63) [Reset = 0xX0]

SEQ_OFF_LOG[4] is shown in 表 7-49.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-49. SEQ_OFF_LOG[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 4. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.40 SEQ_OFF_LOG[5] Register (Address = 0x64) [Reset = 0xX0]

SEQ_OFF_LOG[5] is shown in 表 7-50.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-50. SEQ_OFF_LOG[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 5. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.41 SEQ_OFF_LOG[6] Register (Address = 0x65) [Reset = 0xX0]

SEQ_OFF_LOG[6] is shown in 表 7-51.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-51. SEQ_OFF_LOG[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 6. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.42 SEQ_OFF_LOG[7] Register (Address = 0x66) [Reset = 0xX0]

SEQ_OFF_LOG[7] is shown in 表 7-52.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-52. SEQ_OFF_LOG[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 7. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.43 SEQ_OFF_LOG[8] Register (Address = 0x67) [Reset = 0xX0]

SEQ_OFF_LOG[8] is shown in 表 7-53.

Return to the Summary Table.

Channel N Power OFF sequence order value (ACT 1 to 0).

表 7-53. SEQ_OFF_LOG[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Power OFF sequence order value for channel 8. The sequence order value is the tag assigned to the channel during the sequence triggered by ACT. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.44 SEQ_EXS_LOG[1] Register (Address = 0x70) [Reset = 0xX0]

SEQ_EXS_LOG[1] is shown in 表 7-54.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-54. SEQ_EXS_LOG[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 1. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[1] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.45 SEQ_EXS_LOG[2] Register (Address = 0x71) [Reset = 0xX0]

SEQ_EXS_LOG[2] is shown in 表 7-55.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-55. SEQ_EXS_LOG[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 2. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[2] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.46 SEQ_EXS_LOG[3] Register (Address = 0x72) [Reset = 0xX0]

SEQ_EXS_LOG[3] is shown in 表 7-56.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-56. SEQ_EXS_LOG[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 3. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[3] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.47 SEQ_EXS_LOG[4] Register (Address = 0x73) [Reset = 0xX0]

SEQ_EXS_LOG[4] is shown in 表 7-57.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-57. SEQ_EXS_LOG[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 4. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[4] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.48 SEQ_EXS_LOG[5] Register (Address = 0x74) [Reset = 0xX0]

SEQ_EXS_LOG[5] is shown in 表 7-58.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-58. SEQ_EXS_LOG[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 5. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[5] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.49 SEQ_EXS_LOG[6] Register (Address = 0x75) [Reset = 0xX0]

SEQ_EXS_LOG[6] is shown in 表 7-59.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-59. SEQ_EXS_LOG[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 6. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[6] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.50 SEQ_EXS_LOG[7] Register (Address = 0x76) [Reset = 0xX0]

SEQ_EXS_LOG[7] is shown in 表 7-60.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-60. SEQ_EXS_LOG[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 7. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[5] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.51 SEQ_EXS_LOG[8] Register (Address = 0x77) [Reset = 0xX0]

SEQ_EXS_LOG[8] is shown in 表 7-61.

Return to the Summary Table.

Channel N Sleep Exit sequence order value ($\overline{\text{SLEEP}}$ 0 to 1).

表 7-61. SEQ_EXS_LOG[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Exit sequence order value for channel 8. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage rising level passes the UV_LF[6] threshold. The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.52 SEQ_ENS_LOG[1] Register (Address = 0x80) [Reset = 0xX0]

SEQ_ENS_LOG[1] is shown in 表 7-62.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-62. SEQ_ENS_LOG[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 1. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.53 SEQ_ENS_LOG[2] Register (Address = 0x81) [Reset = 0xX0]

SEQ_ENS_LOG[2] is shown in 表 7-63.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-63. SEQ_ENS_LOG[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 2. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.54 SEQ_ENS_LOG[3] Register (Address = 0x82) [Reset = 0xX0]

SEQ_ENS_LOG[3] is shown in 表 7-64.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-64. SEQ_ENS_LOG[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 3. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.55 SEQ_ENS_LOG[4] Register (Address = 0x83) [Reset = 0xX0]

SEQ_ENS_LOG[4] is shown in 表 7-65.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-65. SEQ_ENS_LOG[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 4. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.56 SEQ_ENS_LOG[5] Register (Address = 0x84) [Reset = 0xX0]

SEQ_ENS_LOG[5] is shown in 表 7-66.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-66. SEQ_ENS_LOG[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 5. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.57 SEQ_ENS_LOG[6] Register (Address = 0x85) [Reset = 0xX0]

SEQ_ENS_LOG[6] is shown in 表 7-67.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-67. SEQ_ENS_LOG[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 6. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.58 SEQ_ENS_LOG[7] Register (Address = 0x86) [Reset = 0xX0]

SEQ_ENS_LOG[7] is shown in 表 7-68.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-68. SEQ_ENS_LOG[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 7. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.59 SEQ_ENS_LOG[8] Register (Address = 0x87) [Reset = 0xX0]

SEQ_ENS_LOG[8] is shown in 表 7-69.

Return to the Summary Table.

Channel N Sleep Entry sequence order value ($\overline{\text{SLEEP}}$ 1 to 0).

表 7-69. SEQ_ENS_LOG[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R	xxxxb	This register stores the Sleep Entry sequence order value for channel 8. The sequence order value is the tag assigned to the channel during the sequence triggered by SLEEP. The tag is assigned when the voltage falling level passes the OFF threshold (200mV). The tag value is the SYNC_ORD_COUNT at the time the threshold is passed.

7.5.1.60 SEQ_TIME_MSB[1] Register (Address = 0x90) [Reset = 0xX0]

SEQ_TIME_MSB[1] is shown in 表 7-70.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-70. SEQ_TIME_MSB[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 1. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[1] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.61 SEQ_TIME_LSB[1] Register (Address = 0x91) [Reset = 0xX0]

SEQ_TIME_LSB[1] is shown in 表 7-71.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-71. SEQ_TIME_LSB[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 1. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[1] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.62 SEQ_TIME_MSB[2] Register (Address = 0x92) [Reset = 0xX0]

SEQ_TIME_MSB[2] is shown in 表 7-72.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-72. SEQ_TIME_MSB[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 2. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[2] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.63 SEQ_TIME_LSB[2] Register (Address = 0x93) [Reset = 0xX0]

SEQ_TIME_LSB[2] is shown in 表 7-73.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-73. SEQ_TIME_LSB[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 2. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[2] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.64 SEQ_TIME_MSB[3] Register (Address = 0x94) [Reset = 0xX0]

SEQ_TIME_MSB[3] is shown in 表 7-74.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-74. SEQ_TIME_MSB[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 3. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[3] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.65 SEQ_TIME_LSB[3] Register (Address = 0x95) [Reset = 0xX0]

SEQ_TIME_LSB[3] is shown in 表 7-75.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-75. SEQ_TIME_LSB[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 3. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[3] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.66 SEQ_TIME_MSB[4] Register (Address = 0x96) [Reset = 0xX0]

SEQ_TIME_MSB[4] is shown in 表 7-76.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-76. SEQ_TIME_MSB[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 4. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[4] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.67 SEQ_TIME_LSB[4] Register (Address = 0x97) [Reset = 0xX0]

SEQ_TIME_LSB[4] is shown in 表 7-77.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-77. SEQ_TIME_LSB[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 4. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[4] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power 200mVd Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.68 SEQ_TIME_MSB[5] Register (Address = 0x98) [Reset = 0xX0]

SEQ_TIME_MSB[5] is shown in 表 7-78.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-78. SEQ_TIME_MSB[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 5. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[5] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.69 SEQ_TIME_LSB[5] Register (Address = 0x99) [Reset = 0xX0]

SEQ_TIME_LSB[5] is shown in 表 7-79.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-79. SEQ_TIME_LSB[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 5. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[5] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.70 SEQ_TIME_MSB[6] Register (Address = 0x9A) [Reset = 0xX0]

SEQ_TIME_MSB[6] is shown in 表 7-80.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-80. SEQ_TIME_MSB[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 6. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[6] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.71 SEQ_TIME_LSB[6] Register (Address = 0x9B) [Reset = 0xX0]

SEQ_TIME_LSB[6] is shown in 表 7-81.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-81. SEQ_TIME_LSB[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 6. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[6] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.72 SEQ_TIME_MSB[7] Register (Address = 0x9C) [Reset = 0xX0]

SEQ_TIME_MSB[7] is shown in 表 7-82.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-82. SEQ_TIME_MSB[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 7. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[7] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.73 SEQ_TIME_LSB[7] Register (Address = 0x9D) [Reset = 0xX0]

SEQ_TIME_LSB[7] is shown in 表 7-83.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-83. SEQ_TIME_LSB[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 7. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[7] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.74 SEQ_TIME_MSB[8] Register (Address = 0x9E) [Reset = 0xX0]

SEQ_TIME_MSB[8] is shown in 表 7-84.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-84. SEQ_TIME_MSB[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the MSB of the sequence timestamp for channel 8. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[8] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.75 SEQ_TIME_LSB[8] Register (Address = 0x9F) [Reset = 0xX0]

SEQ_TIME_LSB[8] is shown in 表 7-85.

Return to the Summary Table.

Channel N Sequence timestamp value MSB and LSB (all sequences).

表 7-85. SEQ_TIME_LSB[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	CLOCK[7:0]	R	xxxxb	This register stores the LSB of the sequence timestamp for channel 8. The sequence timer value is the time assigned to the channel during the sequence triggered by ACT or SLEEP. The timestamp is stored when the voltage rising level passes the UV_LF[8] threshold for Power ON and Sleep Exit sequences (ACT 01 or SLEEP 01). The timestamp is stored when the voltage falling level passes the OFF threshold (200mV) for Power OFF and Sleep Entry sequences (ACT 10 or SLEEP 10). The least significant bit corresponds to 50µs (equal to tSEQ_LSB).

7.5.1.76 BANK_SEL Register (Address = 0xF0) [Reset = 0x00]

BANK_SEL is shown in 表 7-86.

Return to the Summary Table.

Bank select=0 for Bank 0 and 1 for Bank 1

表 7-86. BANK_SEL Register Field Descriptions

Bit	Field	Type	Reset	Description
7:1	RESERVED	R	b	Reserved
0	BANK SELECTION	R/W	b	Register Bank selection number.

7.5.1.77 PROT1 Register (Address = 0xF1) [Reset = 0x00]

PROT1 is shown in 表 7-87.

Return to the Summary Table.

Protection selection registers. To write-protect a register group, the host must set the relevant bit in both registers. For security, registers PROT1 and PROT2 need to have POR value = 0x00 and become read-only once set until power cycle. Once set to 1, the bit cannot be cleared to 0 by the host. They can be cleared (and allow writing different VMON registers configurations) through: A power cycle A reset through VMON_CTL.RESET BIST executed on exiting Sequence 2 (if TEST_CFG.AT_SHDN=1).

表 7-87. PROT1 Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5	WRKC	R/W	b	0b 0 = Control Working (WRKC) registers are writeable. 0b 1 = Writes to control working registers are ignored.
4	WRKS	R/W	b	0b 0 = Sequence Working (WRKS) registers are writeable. 0b 1 = Writes to sequence working registers are ignored.

表 7-87. PROT1 Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
3	CFG	R/W	b	0b 0 = Configuration (CFG) registers are writeable. 0b 1 = Writes to configuration registers are ignored.
2	IEN	R/W	b	0b 0 = Interrupt Enable (IEN) registers are writeable. 0b 1 = Writes to interrupt enable registers are ignored.
1	MON	R/W	b	0b 0 = Monitor (MON[N]) registers are writeable. 0b 1 = Writes to monitor registers selected in PROT_MON 1 register are ignored.
0	SEQ	R/W	b	0b 0 = Sequence (SEQ) Registers are writeable. 0b 1 = Writes to sequence registers are ignored.

7.5.1.78 PROT2 Register (Address = 0xF2) [Reset = 0x00]

PROT2 is shown in 表 7-88.

Return to the Summary Table.

Protection selection registers. To write-protect a register group, the host must set the relevant bit in both registers. For security, registers PROT1 and PROT2 need to have POR value = 0x00 and become read-only once set until power cycle. Once set to 1, the bit cannot be cleared to 0 by the host. They can be cleared (and allow writing different VMON registers configurations) through: A power cycle A reset through VMON_CTL.RESET BIST executed on exiting Sequence 2 (if TEST_CFG.AT_SHDN=1).

表 7-88. PROT2 Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5	WRKC	R/W	b	0b 0 = Control Working (WRKC) registers are writeable. 0b 1 = Writes to control working registers are ignored.
4	WRKS	R/W	b	0b 0 = Sequence Working (WRKS) registers are writeable. 0b 1 = Writes to sequence working registers are ignored.
3	CFG	R/W	b	0b 0 = Configuration (CFG) registers are writeable. 0b 1 = Writes to configuration registers are ignored.
2	IEN	R/W	b	0b 0 = Interrupt Enable (IEN) registers are writeable. 0b 1 = Writes to interrupt enable registers are ignored.
1	MON	R/W	b	0b 0 = Monitor (MON[N]) registers are writeable. 0b 1 = Writes to monitor registers selected in PROT_MON 1 register are ignored.

表 7-88. PROT2 Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
0	SEQ	R/W	b	0b 0 = Sequence (SEQ) Registers are writeable. 0b 1 = Writes to sequence registers are ignored.

7.5.1.79 PROT_MON2 Register (Address = 0xF3) [Reset = 0xC1]

PROT_MON2 is shown in 表 7-89.

Return to the Summary Table.

Monitor channels configuration protection.

表 7-89. PROT_MON2 Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5:0	MON[N]	R/W	1b	This register selects the monitor channels configurations that will be protected once PROT 1, PROT 2 registers are written to protect the MON group. 0 = Monitor configuration registers for channel N are writeable. 1 = Writes to monitor configuration registers for channel N are ignored.

7.5.1.80 I2CADDR Register (Address = 0xF9) [Reset = 0xX0]

I2CADDR is shown in 表 7-90.

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3 LSB bits are decided based on resistor value and 5 MSB bits are based on OTP NVM. ADDR_NVM has default value of 30 (Factory default setting)

表 7-90. I2CADDR Register Field Descriptions

Bit	Field	Type	Reset	Description
7	RESERVED	R	b	Reserved
6:3	ADDR_NVM[3:0]	R	xb	I2C address four most significant bits. Set in NVM.
2:0	ADDR_STRAP[2:0]	R	xxxb	I2C address three least significant bits. Set by the strap level detected on ADDR pin, from 000b to 111b.

7.5.1.81 DEV_CFG Register (Address = 0xFA) [Reset = 0xX0]

DEV_CFG is shown in 表 7-91.

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Status of I2C interface voltage levels, 0 for 3.3V I/F and 1 for 1.2/1.8V interface (Factory default setting)

表 7-91. DEV_CFG Register Field Descriptions

Bit	Field	Type	Reset	Description
7:1	RESERVED	R	b	Reserved

表 7-91. DEV_CFG Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
0	SOC_IF	R	xb	Host SoC Interface (includes I 2C, ACT, SLEEP, and SYNC). 0 = 3. 3V 1 = 1. 2V/ 1. 8V

7.5.2 BANK1 Registers

表 7-92 lists the memory-mapped registers for the BANK1 registers. All register offset addresses not listed in 表 7-92 should be considered as reserved locations and the register contents should not be modified.

表 7-92. BANK1 Registers

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x10	VMON_CTL	DIAG_EN_SCALE		SLP_PWR	RESERVED	RESET_PROT	SYNC_RST	FORCE_SYNC	FORCE_NIRQ
0x11	VMON_MISC	RESERVED				EN_TS_OW	EN_SEQ_OW	REQ_PEC	EN_PEC
0x12	TEST_CFG	RESERVED				AT_SHDN	RESERVED	AT_POR	
0x13	IEN_UVHF	MON[N]							
0x14	IEN_UVLF	MON[N]							
0x15	IEN_OVHF	MON[N]							
0x16	IEN_OVLF	MON[N]							
0x17	IEN_SEQ_ON	RESERVED		MON[N]					
0x18	IEN_SEQ_OFF	RESERVED		MON[N]					
0x19	IEN_SEQ_EXS	RESERVED		MON[N]					
0x1A	IEN_SEQ_ENS	RESERVED		MON[N]					
0x1B	IEN_CONTROL	RESERVED			RT_CRC Int	RESERVED	TSD Int	SYNC Int	PEC Int
0x1C	IEN_TEST	RESERVED				ECC_SEC	RESERVED	BIST_Complete_INT	BIST_Fail_INT
0x1D	IEN_VENDOR	RESERVED							RESERVED
0x1E	MON_CH_EN	MON[N]							
0x1F	VRANGE_MULT	MON[N]							
0x20	UV_HF[1]	THRESHOLD[7:0]							
0x21	OV_HF[1]	THRESHOLD[7:0]							
0x22	UV_LF[1]	THRESHOLD[7:0]							
0x23	OV_LF[1]	THRESHOLD[7:0]							
0x24	FLT_HF[1]	OV_DEB[3:0]				UV_DEB[3:0]			
0x25	FC_LF[1]	RESERVED			UV_HF_1 to NRST	THRESHOLD[2:0]			
0x30	UV_HF[2]	THRESHOLD[7:0]							
0x31	OV_HF[2]	THRESHOLD[7:0]							
0x32	UV_LF[2]	THRESHOLD[7:0]							
0x33	OV_LF[2]	THRESHOLD[7:0]							
0x34	FLT_HF[2]	OV_DEB[3:0]				UV_DEB[3:0]			
0x35	FC_LF[2]	RESERVED			UV_HF_2 to NRST	THRESHOLD[2:0]			
0x40	UV_HF[3]	THRESHOLD[7:0]							
0x41	OV_HF[3]	THRESHOLD[7:0]							
0x42	UV_LF[3]	THRESHOLD[7:0]							
0x43	OV_LF[3]	THRESHOLD[7:0]							
0x44	FLT_HF[3]	OV_DEB[3:0]				UV_DEB[3:0]			
0x45	FC_LF[3]	RESERVED			UV_HF_3 to NRST	THRESHOLD[2:0]			
0x50	UV_HF[4]	THRESHOLD[7:0]							
0x51	OV_HF[4]	THRESHOLD[7:0]							
0x52	UV_LF[4]	THRESHOLD[7:0]							
0x53	OV_LF[4]	THRESHOLD[7:0]							

表 7-92. BANK1 Registers (続き)

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x54	FLT_HF[4]	OV_DEB[3:0]				UV_DEB[3:0]			
0x55	FC_LF[4]	RESERVED			UV_HF_4 to NRST		THRESHOLD[2:0]		
0x60	UV_HF[5]	THRESHOLD[7:0]							
0x61	OV_HF[5]	THRESHOLD[7:0]							
0x62	UV_LF[5]	THRESHOLD[7:0]							
0x63	OV_LF[5]	THRESHOLD[7:0]							
0x64	FLT_HF[5]	OV_DEB[3:0]				UV_DEB[3:0]			
0x65	FC_LF[5]	RESERVED			UV_HF_5 to NRST		THRESHOLD[2:0]		
0x70	UV_HF[6]	THRESHOLD[7:0]							
0x71	OV_HF[6]	THRESHOLD[7:0]							
0x72	UV_LF[6]	THRESHOLD[7:0]							
0x73	OV_LF[6]	THRESHOLD[7:0]							
0x74	FLT_HF[6]	OV_DEB[3:0]				UV_DEB[3:0]			
0x75	FC_LF[6]	RESERVED			UV_HF_6 to NRST		THRESHOLD[2:0]		
0x80	UV_HF[7]	THRESHOLD[7:0]							
0x81	OV_HF[7]	THRESHOLD[7:0]							
0x82	UV_LF[7]	THRESHOLD[7:0]							
0x83	OV_LF[7]	THRESHOLD[7:0]							
0x84	FLT_HF[7]	OV_DEB[3:0]				UV_DEB[3:0]			
0x85	FC_LF[7]	RESERVED					THRESHOLD[2:0]		
0x90	UV_HF[8]	THRESHOLD[7:0]							
0x91	OV_HF[8]	THRESHOLD[7:0]							
0x92	UV_LF[8]	THRESHOLD[7:0]							
0x93	OV_LF[8]	THRESHOLD[7:0]							
0x94	FLT_HF8]	OV_DEB[3:0]				UV_DEB[3:0]			
0x95	FC_LF[8]	RESERVED					THRESHOLD[2:0]		
0x9F	TI_CONTROL	ENTER_BIST	RSVD	Manual Reset	RESERVED		Reset delay time		
0xA0	SEQ_REC_CTL	REC_START	SEQ[1:0]		TS_ACK	SEQ_ON_ACK	SEQ_OFF_ACK	SEQ_EXS_ACK	SEQ_ENS_ACK
0xA1	AMSK_ON	MON[N]							
0xA2	AMSK_OFF	MON[N]							
0xA3	AMSK_EXS	MON[N]							
0xA4	AMSK_ENS	MON[N]							
0xA5	SEQ_TOUT_MSB	MILLISEC[7:0]							
0xA6	SEQ_TOUT_LSB	MILLISEC[7:0]							
0xA7	SEQ_SYNC	PULSE_WIDTH[7:0]							
0xA8	SEQ_UP_THLD	MON[N]							
0xA9	SEQ_DN_THLD	MON[N]							
0xB0	SEQ_ON_EXP[1]	ORDER[7:0]							
0xB1	SEQ_ON_EXP[2]	ORDER[7:0]							

表 7-92. BANK1 Registers (続き)

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0xB2	SEQ_ON_EXP[3]	ORDER[7:0]							
0xB3	SEQ_ON_EXP[4]	ORDER[7:0]							
0xB4	SEQ_ON_EXP[5]	ORDER[7:0]							
0xB5	SEQ_ON_EXP[6]	ORDER[7:0]							
0xB6	SEQ_ON_EXP[7]	ORDER[7:0]							
0xB7	SEQ_ON_EXP[8]	ORDER[7:0]							
0xC0	SEQ_OFF_EXP[1]	ORDER[7:0]							
0xC1	SEQ_OFF_EXP[2]	ORDER[7:0]							
0xC2	SEQ_OFF_EXP[3]	ORDER[7:0]							
0xC3	SEQ_OFF_EXP[4]	ORDER[7:0]							
0xC4	SEQ_OFF_EXP[5]	ORDER[7:0]							
0xC5	SEQ_OFF_EXP[6]	ORDER[7:0]							
0xC6	SEQ_OFF_EXP[7]	ORDER[7:0]							
0xC7	SEQ_OFF_EXP[8]	ORDER[7:0]							
0xD0	SEQ_EXS_EXP[1]	ORDER[7:0]							
0xD1	SEQ_EXS_EXP[2]	ORDER[7:0]							
0xD2	SEQ_EXS_EXP[3]	ORDER[7:0]							
0xD3	SEQ_EXS_EXP[4]	ORDER[7:0]							
0xD4	SEQ_EXS_EXP[5]	ORDER[7:0]							
0xD5	SEQ_EXS_EXP[6]	ORDER[7:0]							
0xD6	SEQ_EXS_EXP[7]	ORDER[7:0]							
0xD7	SEQ_EXS_EXP[8]	ORDER[7:0]							
0xE0	SEQ_ENS_EXP[1]	ORDER[7:0]							
0xE1	SEQ_ENS_EXP[2]	ORDER[7:0]							
0xE2	SEQ_ENS_EXP[3]	ORDER[7:0]							
0xE3	SEQ_ENS_EXP[4]	ORDER[7:0]							

表 7-92. BANK1 Registers (続き)

Address	Acronym	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0xE4	SEQ_ENS_EXP[5]	ORDER[7:0]							
0xE5	SEQ_ENS_EXP[6]	ORDER[7:0]							
0xE6	SEQ_ENS_EXP[7]	ORDER[7:0]							
0xE7	SEQ_ENS_EXP[8]	ORDER[7:0]							

Complex bit access types are encoded to fit into small table cells. 表 7-93 shows the codes that are used for access types in this section.

表 7-93. BANK1 Access Type Codes

Access Type	Code	Description
Read Type		
R	R	Read
Write Type		
W	W	Write
Reset or Default Value		
-*n*		Value after reset or the default value

7.5.2.1 VMON_CTL Register (Address = 0x10) [Reset = 0xX0]

VMON_CTL is shown in 表 7-94.

Return to the Summary Table.

Voltage Monitor device control register.

表 7-94. VMON_CTL Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	DIAG_EN_SCALE	R/W	b	Diag EN Scale 00 = No force on GAINSEL of SVS COMPs 01 = Forced to 1x 10 = Forced to 2x 11 = Forced to 4x
5	SLP_PWR	R/W	b	Sleep Power Bit 0 = Sleep low power mode 1 = Sleep high power mode
4	RESERVED	R	b	Reserved
3	RESET_PROT	R/W	b	Reset 0 = Always reads 0 1 = Full device Reset
2	SYNC_RST	R/W	b	$\overline{\text{SYNC}}$ counter reset (SEQ_ORD_STAT.SYNC_COUNT). 0 = Always reads 0 1 = Reset $\overline{\text{SYNC}}$ counter

表 7-94. VMON_CTL Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
1	FORCE_SYNC	R/W	b	Force $\overline{\text{SYNC}}$ assertion 0 =$\overline{\text{SYNC}}$ pin is de-asserted and controlled by the sequence monitoring logic. 1 =$\overline{\text{SYNC}}$ pin is asserted (forced low)
0	FORCE_NIRQ	R/W	b	Force NIRQ assertion 0 = NIRQ pin is de-asserted and controlled by interrupt registers faults 1 = NIRQ pin is asserted (forced low)

7.5.2.2 VMON_MISC Register (Address = 0x11) [Reset = 0x0C]

VMON_MISC is shown in 表 7-95.

Return to the Summary Table.

Miscellaneous voltage monitoring configurations.

表 7-95. VMON_MISC Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	RESERVED	R	b	Reserved
3	EN_TS_OW	R/W	1b	Allow Timestamp recording overwrite 0 = Disabled. If sequence timestamp data is available in the SEQ_TIME_xSB[N] registers and the SEQ_REC_STAT.TS_RDY bit is set (data not read yet), a new sequence does not overwrite the existing data. 1 = Enabled (default). Sequence timestamp data is overwritten with a new sequence, irrelevant of the SEQ_REC_STAT.TS_RDY bit.
2	EN_SEQ_OW	R/W	1b	Allow Sequence Order recording overwrite 0 = Disabled. If sequence order data is available in the SEQ_ON_LOG[N], SEQ_OFF_LOG[N], SEQ_EXS_LOG[N], or SEQ_ENS_LOG[N] registers, and the respective SEQ_REC_STAT.SEQ_ON_RDY, SEQ_REC_STAT.SEQ_OFF_RDY, SEQ_REC_STAT.SEQ_EXS_RDY, or SEQ_REC_STAT.SEQ_ENS_RDY bit is set (data not read yet), a new sequence does not overwrite the existing data. 1 = Enabled (default). Sequence order data is overwritten with a new sequence, regradless of the SEQ_REC_STAT.SEQ_ON_RDY, SEQ_REC_STAT.SEQ_OFF_RDY, SEQ_REC_STAT.SEQ_EXS_RDY, or SEQ_REC_STAT.SEQ_ENS_RDY bit.
1	REQ_PEC	R/W	b	Require PEC byte (valid only if EN_PEC is 1): 0 = missing PEC byte is treated as good PEC 1 = missing PEC byte is treated as bad PEC, triggering a fault
0	EN_PEC	R/W	b	PEC: 0 = PEC disabled (default) 1 = PEC enabled

7.5.2.3 TEST_CFG Register (Address = 0x12) [Reset = 0xX0]

TEST_CFG is shown in 表 7-96.

Return to the Summary Table.

Built-In Self Test BIST execution configuration.

表 7-96. TEST_CFG Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	RESERVED	R	b	Reserved
3	AT_SHDN	R/W	xb	Run BIST when exiting ACTIVE state due to ACT transitioning 1 to 0. Device ready after tCFG_WB. This bit cannot be set in OTP/NVM. Always defaults to 0 when loading configuration from OTP/NVM.
2	RESERVED	R	b	
1:0	AT_POR	R/W	xxb	Run BIST at POR. Device ready after tCFG_WB. 00b = Valid OTP configuration, skip BIST at POR 01b = Corrupt OTP configuration, run BIST at POR 10b = Corrupt OTP configuration, run BIST at POR 11b = Valid OTP configuration, run BIST at POR

7.5.2.4 IEN_UVHF Register (Address = 0x13) [Reset = 0x00]

IEN_UVHF is shown in 表 7-97.

Return to the Summary Table.

High Frequency channel Undervoltage Interrupt Enable register.

表 7-97. IEN_UVHF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	Undervoltage High Frequency fault Interrupt Enable for VIN channel N (1 through 8). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.5 IEN_UVLF Register (Address = 0x14) [Reset = 0x00]

IEN_UVLF is shown in 表 7-98.

Return to the Summary Table.

Low Frequency channel Undervoltage Interrupt Enable register.

表 7-98. IEN_UVLF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	Undervoltage Low Frequency fault Interrupt Enable for VIN channel N (1 through 8). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.6 IEN_OVHF Register (Address = 0x15) [Reset = 0x00]

IEN_OVHF is shown in 表 7-99.

Return to the Summary Table.

High Frequency channel Overvoltage Interrupt Enable register.

表 7-99. IEN_OVHF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	Overvoltage High Frequency fault Interrupt Enable for VIN channel N (1 through 8). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.7 IEN_OVLF Register (Address = 0x16) [Reset = 0x00]

IEN_OVLF is shown in 表 7-100.

Return to the Summary Table.

Low Frequency channel Overvoltage Interrupt Enable register.

表 7-100. IEN_OVLF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	Overvoltage Low Frequency fault Interrupt Enable for VIN channel N (1 through 8). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.8 IEN_SEQ_ON Register (Address = 0x17) [Reset = 0x00]

IEN_SEQ_ON is shown in 表 7-101.

Return to the Summary Table.

Power ON Sequence ACT transition 0 to 1 Interrupt Enable register.

表 7-101. IEN_SEQ_ON Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5:0	MON[N]	R/W	b	Power ON Sequence Fault Interrupt Enable for VIN channel N (1 through 6). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.9 IEN_SEQ_OFF Register (Address = 0x18) [Reset = 0x00]

IEN_SEQ_OFF is shown in 表 7-102.

Return to the Summary Table.

Power OFF Sequence ACT transition 1 to 0 Interrupt Enable register.

表 7-102. IEN_SEQ_OFF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved

表 7-102. IEN_SEQ_OFF Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
5:0	MON[N]	R/W	b	Power OFF Sequence Fault Interrupt Enable for VIN channel N (1 through 6). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.10 IEN_SEQ_EXS Register (Address = 0x19) [Reset = 0x00]

IEN_SEQ_EXS is shown in 表 7-103.

Return to the Summary Table.

Exit Sleep Sequence $\overline{\text{SLEEP}}$ transition 0 to 1 Interrupt Enable register.

表 7-103. IEN_SEQ_EXS Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5:0	MON[N]	R/W	b	Exit Sleep Sequence Fault Interrupt Enable for VIN channel N (1 through 6). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.11 IEN_SEQ_ENS Register (Address = 0x1A) [Reset = 0x00]

IEN_SEQ_ENS is shown in 表 7-104.

Return to the Summary Table.

Entry Sleep Sequence $\overline{\text{SLEEP}}$ transition 1 to 0 Interrupt Enable register.

表 7-104. IEN_SEQ_ENS Register Field Descriptions

Bit	Field	Type	Reset	Description
7:6	RESERVED	R	b	Reserved
5:0	MON[N]	R/W	b	Entry Sleep Sequence Fault Interrupt Enable for VIN channel N (1 through 6). 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.12 IEN_CONTROL Register (Address = 0x1B) [Reset = 0x0X]

IEN_CONTROL is shown in 表 7-105.

Return to the Summary Table.

Control and Communication Fault Interrupt Enable register.

表 7-105. IEN_CONTROL Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4	RT_CRC Int	R/W	b	Runtime register Cyclic Redundancy Check (CRC) fault interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled
3	RESERVED	R	b	Reserved

表 7-105. IEN_CONTROL Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
2	TSD Int	R/W	b	Thermal Shutdown fault interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled
1	SYNC Int	R/W	b	$\overline{\text{SYNC}}$ pin fault (short to supply or ground detected on $\overline{\text{SYNC}}$ pin) interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled
0	PEC Int	R/W	b	PEC fault (mismatch) interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled

7.5.2.13 IEN_TEST Register (Address = 0x1C) [Reset = 0x0X]

IEN_TEST is shown in 表 7-106.

Return to the Summary Table.

Internal Test and Configuration Load Fault Interrupt Enable register.

表 7-106. IEN_TEST Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	RESERVED	R	b	Reserved
3	ECC_SEC	R/W	b	ECC single-error correction fault (on OTP load) interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled
2	RESERVED	R	b	Reserved
1	BIST_Complete_INT	R/W	b	Built-In Self-Test complete interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled
0	BIST_Fail_INT	R/W	b	Built-In Self-Test fault interrupt enable: 0 = Interrupt disabled 1 = Interrupt enabled Although expected to be always enabled, it is desirable to have the option to disable the interrupt.

7.5.2.14 IEN_VENDOR Register (Address = 0x1D) [Reset = 0xX0]

IEN_VENDOR is shown in 表 7-107.

Return to the Summary Table.

Vendor Specific Internal Interrupt Enable register.

表 7-107. IEN_VENDOR Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	RESERVED	R	b	Reserved

7.5.2.15 MON_CH_EN Register (Address = 0x1E) [Reset = 0x00]

MON_CH_EN is shown in 表 7-108.

Return to the Summary Table.

Channel 1-8 Voltage Monitoring Enable register.

表 7-108. MON_CH_EN Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	Voltage Monitoring Enable for VIN channel N (1 through 8). 0 = Channel Monitor disabled 1 = Channel Monitor enabled

7.5.2.16 VRANGE_MULT Register (Address = 0x1F) [Reset = 0x00]

VRANGE_MULT is shown in 表 7-109.

Return to the Summary Table.

Channel 1-8 Voltage Monitoring Range/Scaling register.

表 7-109. VRANGE_MULT Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	Voltage Monitoring Range/Scaling for VIN channel N (1 through 8). 0 = 1x scaling (0. 2V to 1. 475V with 5mV steps) 1 = 4x scaling (0. 8V to 5. 9V with 20mV steps)

7.5.2.17 UV_HF[1] Register (Address = 0x20) [Reset = 0x00]

UV_HF[1] is shown in 表 7-110.

Return to the Summary Table.

Channel 1 High Frequency channel Undervoltage threshold.

表 7-110. UV_HF[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.18 OV_HF[1] Register (Address = 0x21) [Reset = 0xFF]

OV_HF[1] is shown in 表 7-111.

Return to the Summary Table.

Channel 1 High Frequency channel Overvoltage threshold.

表 7-111. OV_HF[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.19 UV_LF[1] Register (Address = 0x22) [Reset = 0x00]

UV_LF[1] is shown in 表 7-112.

Return to the Summary Table.

Channel 1 Low Frequency channel Undervoltage threshold.

表 7-112. UV_LF[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.20 OV_LF[1] Register (Address = 0x23) [Reset = 0xFF]

OV_LF[1] is shown in 表 7-113.

Return to the Summary Table.

Channel 1 Low Frequency channel Overvoltage threshold.

表 7-113. OV_LF[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.21 FLT_HF[1] Register (Address = 0x24) [Reset = 0x00]

FLT_HF[1] is shown in 表 7-114.

Return to the Summary Table.

Channel 1 debounce filter for High Frequency Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-114. FLT_HF[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.22 FC_LF[1] Register (Address = 0x25) [Reset = 0x14]

FC_LF[1] is shown in 表 7-115.

Return to the Summary Table.

Channel 1 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies. The register also sets the mapping for OV_HF[1]/UV_HF[1] faults to the Reset pin

表 7-115. FC_LF[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4:3	UV_HF_1 to NRST	R/W	10b	Mapping to NRST 00 = HF faults not mapped 01 = UV_HF_ 1 mapped 10 = OV_HF_ 1 mapped 11 = UV_HF_ 1 and OV_HF_ 1 mapped
2:0	THRESHOLD[2:0]	R/W	100b	Low frequency cutoff. 000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.23 UV_HF[2] Register (Address = 0x30) [Reset = 0x00]

UV_HF[2] is shown in 表 7-116.

Return to the Summary Table.

Channel 2 High Frequency channel Undervoltage threshold.

表 7-116. UV_HF[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.24 OV_HF[2] Register (Address = 0x31) [Reset = 0xFF]

OV_HF[2] is shown in 表 7-117.

Return to the Summary Table.

Channel 2 High Frequency channel Overvoltage threshold.

表 7-117. OV_HF[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.25 UV_LF[2] Register (Address = 0x32) [Reset = 0x00]

UV_LF[2] is shown in 表 7-118.

Return to the Summary Table.

Channel 2 Low Frequency channel Undervoltage threshold.

表 7-118. UV_LF[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.26 OV_LF[2] Register (Address = 0x33) [Reset = 0xFF]

OV_LF[2] is shown in 表 7-119.

Return to the Summary Table.

Channel 2 Low Frequency channel Overvoltage threshold.

表 7-119. OV_LF[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.27 FLT_HF[2] Register (Address = 0x34) [Reset = 0x00]

FLT_HF[2] is shown in 表 7-120.

Return to the Summary Table.

Channel 2 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-120. FLT_HF[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.28 FC_LF[2] Register (Address = 0x35) [Reset = 0x14]

FC_LF[2] is shown in 表 7-121.

Return to the Summary Table.

Channel 2 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies. The register also sets the mapping for OV_HF[2]/UV_HF[2] faults to the Reset pin

表 7-121. FC_LF[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4:3	UV_HF_2 to NRST	R/W	10b	Mapping to NRST 00 = HF faults not mapped 01 = UV_HF_ 2 mapped 10 = OV_HF_ 2 mapped 11 = UV_HF_ 2 and OV_HF_ 2 mapped

表 7-121. FC_LF[2] Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.29 UV_HF[3] Register (Address = 0x40) [Reset = 0x00]

UV_HF[3] is shown in 表 7-122.

Return to the Summary Table.

Channel 3 High Frequency channel Undervoltage threshold.

表 7-122. UV_HF[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.30 OV_HF[3] Register (Address = 0x41) [Reset = 0xFF]

OV_HF[3] is shown in 表 7-123.

Return to the Summary Table.

Channel 3 High Frequency channel Overvoltage threshold.

表 7-123. OV_HF[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.31 UV_LF[3] Register (Address = 0x42) [Reset = 0x00]

UV_LF[3] is shown in 表 7-124.

Return to the Summary Table.

Channel 3 Low Frequency channel Undervoltage threshold.

表 7-124. UV_LF[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.32 OV_LF[3] Register (Address = 0x43) [Reset = 0xFF]

OV_LF[3] is shown in 表 7-125.

Return to the Summary Table.

Channel 3 Low Frequency channel Overvoltage threshold.

表 7-125. OV_LF[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.33 FLT_HF[3] Register (Address = 0x44) [Reset = 0x00]

FLT_HF[3] is shown in 表 7-126.

Return to the Summary Table.

Channel 3 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-126. FLT_HF[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.34 FC_LF[3] Register (Address = 0x45) [Reset = 0x14]

FC_LF[3] is shown in 表 7-127.

Return to the Summary Table.

Channel 3 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies.The register also sets the mapping for OV_HF[3]/UV_HF[3] faults to the Reset pin

表 7-127. FC_LF[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4:3	UV_HF_3 to NRST	R/W	10b	Mapping to NRST 00 = HF faults not mapped 01 = UV_HF_ 3 mapped 10 = OV_HF_ 3 mapped 11 = UV_HF_ 3 and OV_HF_ 3 mapped
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.35 UV_HF[4] Register (Address = 0x50) [Reset = 0x00]

UV_HF[4] is shown in 表 7-128.

Return to the Summary Table.

Channel 4 High Frequency channel Undervoltage threshold.

表 7-128. UV_HF[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.36 OV_HF[4] Register (Address = 0x51) [Reset = 0xFF]

OV_HF[4] is shown in 表 7-129.

Return to the Summary Table.

Channel 4 High Frequency channel Overvoltage threshold.

表 7-129. OV_HF[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.37 UV_LF[4] Register (Address = 0x52) [Reset = 0x00]

UV_LF[4] is shown in 表 7-130.

Return to the Summary Table.

Channel 4 Low Frequency channel Undervoltage threshold.

表 7-130. UV_LF[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.38 OV_LF[4] Register (Address = 0x53) [Reset = 0xFF]

OV_LF[4] is shown in 表 7-131.

Return to the Summary Table.

Channel 4 Low Frequency channel Overvoltage threshold.

表 7-131. OV_LF[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.39 FLT_HF[4] Register (Address = 0x54) [Reset = 0x00]

FLT_HF[4] is shown in 表 7-132.

Return to the Summary Table.

Channel 4 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-132. FLT_HF[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.40 FC_LF[4] Register (Address = 0x55) [Reset = 0x14]

FC_LF[4] is shown in 表 7-133.

Return to the Summary Table.

Channel 4 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies.The register also sets the mapping for OV_HF[4]/UV_HF[4] faults to the Reset pin

表 7-133. FC_LF[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4:3	UV_HF_4 to NRST	R/W	10b	Mapping to NRST 00 = HF faults not mapped 01 = UV_HF_ 4 mapped 10 = OV_HF_ 4 mapped 11 = UV_HF_ 4 and OV_HF_ 4 mapped
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.41 UV_HF[5] Register (Address = 0x60) [Reset = 0x00]

UV_HF[5] is shown in 表 7-134.

Return to the Summary Table.

Channel 5 High Frequency channel Undervoltage threshold.

表 7-134. UV_HF[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.42 OV_HF[5] Register (Address = 0x61) [Reset = 0xFF]

OV_HF[5] is shown in 表 7-135.

Return to the Summary Table.

Channel 5 High Frequency channel Overvoltage threshold.

表 7-135. OV_HF[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.43 UV_LF[5] Register (Address = 0x62) [Reset = 0x00]

UV_LF[5] is shown in 表 7-136.

Return to the Summary Table.

Channel 5 Low Frequency channel Undervoltage threshold.

表 7-136. UV_LF[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.44 OV_LF[5] Register (Address = 0x63) [Reset = 0xFF]

OV_LF[5] is shown in 表 7-137.

Return to the Summary Table.

Channel 5 Low Frequency channel Overvoltage threshold.

表 7-137. OV_LF[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.45 FLT_HF[5] Register (Address = 0x64) [Reset = 0x00]

FLT_HF[5] is shown in 表 7-138.

Return to the Summary Table.

Channel 5 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-138. FLT_HF[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.46 FC_LF[5] Register (Address = 0x65) [Reset = 0x14]

FC_LF[5] is shown in 表 7-139.

Return to the Summary Table.

Channel 5 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies.The register also sets the mapping for OV_HF[5]/UV_HF[5] faults to the Reset pin for parts with reset pin

表 7-139. FC_LF[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4:3	UV_HF_5 to NRST	R/W	10b	Mapping to NRST 00 = HF faults not mapped 01 = UV_HF_ 5 mapped 10 = OV_HF_ 5 mapped 11 = UV_HF_ 5 and OV_HF_ 5 mapped

表 7-139. FC_LF[5] Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.47 UV_HF[6] Register (Address = 0x70) [Reset = 0x00]

UV_HF[6] is shown in 表 7-140.

Return to the Summary Table.

Channel 6 High Frequency channel Undervoltage threshold.

表 7-140. UV_HF[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.48 OV_HF[6] Register (Address = 0x71) [Reset = 0xFF]

OV_HF[6] is shown in 表 7-141.

Return to the Summary Table.

Channel 6 High Frequency channel Overvoltage threshold.

表 7-141. OV_HF[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.49 UV_LF[6] Register (Address = 0x72) [Reset = 0x00]

UV_LF[6] is shown in 表 7-142.

Return to the Summary Table.

Channel 6 Low Frequency channel Undervoltage threshold.

表 7-142. UV_LF[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.50 OV_LF[6] Register (Address = 0x73) [Reset = 0xFF]

OV_LF[6] is shown in 表 7-143.

Return to the Summary Table.

Channel 6 Low Frequency channel Overvoltage threshold.

表 7-143. OV_LF[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.51 FLT_HF[6] Register (Address = 0x74) [Reset = 0x00]

FLT_HF[6] is shown in 表 7-144.

Return to the Summary Table.

Channel 6 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-144. FLT_HF[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.52 FC_LF[6] Register (Address = 0x75) [Reset = 0x14]

FC_LF[6] is shown in 表 7-145.

Return to the Summary Table.

Channel 6 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies. The register also sets the mapping for OV_HF[6]/UV_HF[6] faults to the Reset pin for parts with reset pin

表 7-145. FC_LF[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:5	RESERVED	R	b	Reserved
4:3	UV_HF_6 to NRST	R/W	10b	Mapping to NRST 00 = HF faults not mapped 01 = UV_HF_ 6 mapped 10 = OV_HF_ 6 mapped 11 = UV_HF_ 6 and OV_HF_ 6 mapped
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.53 UV_HF[7] Register (Address = 0x80) [Reset = 0x00]

UV_HF[7] is shown in 表 7-146.

Return to the Summary Table.

Channel 7 High Frequency channel Undervoltage threshold.

表 7-146. UV_HF[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.54 OV_HF[7] Register (Address = 0x81) [Reset = 0xFF]

OV_HF[7] is shown in 表 7-147.

Return to the Summary Table.

Channel 7 High Frequency channel Overvoltage threshold.

表 7-147. OV_HF[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.55 UV_LF[7] Register (Address = 0x82) [Reset = 0x00]

UV_LF[7] is shown in 表 7-148.

Return to the Summary Table.

Channel 7 Low Frequency channel Undervoltage threshold.

表 7-148. UV_LF[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.56 OV_LF[7] Register (Address = 0x83) [Reset = 0xFF]

OV_LF[7] is shown in 表 7-149.

Return to the Summary Table.

Channel 7 Low Frequency channel Overvoltage threshold.

表 7-149. OV_LF[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.57 FLT_HF[7] Register (Address = 0x84) [Reset = 0x00]

FLT_HF[7] is shown in 表 7-150.

Return to the Summary Table.

Channel 7 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-150. FLT_HF[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.58 FC_LF[7] Register (Address = 0x85) [Reset = 0x14]

FC_LF[7] is shown in 表 7-151.

Return to the Summary Table.

Channel 7 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies. The register also sets the mapping for OV_HF[6]/UV_HF[6] faults to the Reset pin for parts with reset pin

表 7-151. FC_LF[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:3	RESERVED	R	b	Reserved
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.59 UV_HF[8] Register (Address = 0x90) [Reset = 0x00]

UV_HF[8] is shown in 表 7-152.

Return to the Summary Table.

Channel 8 High Frequency channel Undervoltage threshold.

表 7-152. UV_HF[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.60 OV_HF[8] Register (Address = 0x91) [Reset = 0xFF]

OV_HF[8] is shown in 表 7-153.

Return to the Summary Table.

Channel 8 High Frequency channel Overvoltage threshold.

表 7-153. OV_HF[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for High Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.61 UV_LF[8] Register (Address = 0x92) [Reset = 0x00]

UV_LF[8] is shown in 表 7-154.

Return to the Summary Table.

Channel 8 Low Frequency channel Undervoltage threshold.

表 7-154. UV_LF[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	b	Undervoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.62 OV_LF[8] Register (Address = 0x93) [Reset = 0xFF]

OV_LF[8] is shown in 表 7-155.

Return to the Summary Table.

Channel 8 Low Frequency channel Overvoltage threshold.

表 7-155. OV_LF[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	THRESHOLD[7:0]	R/W	11111111b	Overvoltage threshold for Low Frequency component of monitored channel. The 8-bit value interpretation depends on the scaling setting in register VRANGE_MULT. With scaling = 1x, the 8-bit value represents the range 0.2V to 1.475V with 1 LSB = 5mV. With scaling = 4x, the 8-bit value represents the range 0.8V to 5.9V with 1 LSB = 20mV.

7.5.2.63 FLT_HF8] Register (Address = 0x94) [Reset = 0x00]

FLT_HF8] is shown in 表 7-156.

Return to the Summary Table.

Channel 8 debounce filter for HF Fault. The smallest value supported is 0.4 us, The largest is 102.4 us.

表 7-156. FLT_HF8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:4	OV_DEB[3:0]	R/W	b	Overvoltage comparator output debounce time (dont assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs
3:0	UV_DEB[3:0]	R/W	b	Undervoltage comparator output debounce time (don't assert until output is stable for debounce time) for High Frequency monitoring path. 0000b = 0.1µs 1000b = 25.6µs 0001b = 0.2µs 1001b = 51.2µs 0010b = 0.4µs 1010b = 102.4µs 0011b = 0.8µs 1011b = 102.4µs 0100b = 1.6µs 1100b = 102.4µs 0101b = 3.2µs 1101b = 102.4µs 0110b = 6.4µs 1110b = 102.4µs 0111b = 12.8µs 1111b = 102.4µs

7.5.2.64 FC_LF[8] Register (Address = 0x95) [Reset = 0x14]

FC_LF[8] is shown in 表 7-157.

Return to the Summary Table.

Channel 8 Low Frequency Path Cutoff Frequency 3dB point. The register changes the filter properties of the programmable LPF such that the total frequency response meets these cutoff frequencies. The register also sets the mapping for OV_HF[6]/UV_HF[6] faults to the Reset pin for parts with reset pin

表 7-157. FC_LF[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:3	RESERVED	R	b	Reserved
2:0	THRESHOLD[2:0]	R/W	100b	000b = Invalid 001b = Invalid 010b = 250Hz 011b = 500Hz 100b = 1kHz (default) 101b = 2kHz 110b = 4kHz 111b = Invalid

7.5.2.65 TI_CONTROL Register (Address = 0x9F) [Reset = 0x02]

TI_CONTROL is shown in 表 7-158.

Return to the Summary Table.

Manual BIST entry and Reset delay setting register.

表 7-158. TI_CONTROL Register Field Descriptions

Bit	Field	Type	Reset	Description
7	ENTER_BIST	R/W	b	Manual BIST 1= Enter BIST
6	RSVD	R/W	b	RSVD
5	Manual Reset	R/W	b	Manual Reset: 0 = Reset not asserted 1 = Reset asserted
4:3	RESERVED	R	b	Reserved

表 7-158. TI_CONTROL Register Field Descriptions (続き)

Bit	Field	Type	Reset	Description
2:0	Reset delay time	R/W	10b	Reset delay time 000b = 200µs 001b = 1ms 010b = 10ms (default) 011b = 16ms 100b = 20ms 101b = 70ms 110b = 100ms 111b = 200ms

7.5.2.66 SEQ_REC_CTL Register (Address = 0xA0) [Reset = 0x00]

SEQ_REC_CTL is shown in 表 7-159.

Return to the Summary Table.

Sequence control register.

表 7-159. SEQ_REC_CTL Register Field Descriptions

Bit	Field	Type	Reset	Description
7	REC_START	R/W	b	Software start sequence logging (recording): 0 = Always read 0 1 = Initiate power sequence (selected by SEQ[1:0]) recording.
6:5	SEQ[1:0]	R/W	b	Sequence to record (and compare for faults to corresponding expected sequence order registers): 00b = Power ON (same as ACT 0 to 1) 01b = Power OFF (ACT 1 to 0) 10b = Sleep Exit ($\overline{\text{SLEEP}}$ 0 to 1) 11b = Sleep Entry ($\overline{\text{SLEEP}}$ 1 to 0)
4	TS_ACK	R/W	b	Timestamp data OK to overwrite. Valid and used only if VMON_MISC.EN_TS_OW=0. 00b = Always read 0 01b = Acknowledge Timestamp data and OK to overwrite. SEQ_REC_STAT.TS_RDY and SEQ_OW_STAT.TS_OW are cleared.
3	SEQ_ON_ACK	R/W	b	Power ON sequence data OK to overwrite. Valid and used only if VMON_MISC.EN_SEQ_OW=0. 00b = Always read 0 01b = Acknowledge Power ON sequence data and OK to overwrite. SEQ_REC_STAT.SEQ_ON_RDY and SEQ_OW_STAT.SEQ_ON_OW are cleared.
2	SEQ_OFF_ACK	R/W	b	Power OFF sequence data OK to overwrite. Valid and used only if VMON_MISC.EN_SEQ_OW=0. 00b = Always read 0 01b = Acknowledge Power OFF sequence data and OK to overwrite. SEQ_REC_STAT.SEQ_OFF_RDY and SEQ_OW_STAT.SEQ_OFF_OW are cleared.
1	SEQ_EXS_ACK	R/W	b	Sleep Exit sequence data OK to overwrite. Valid and used only if VMON_MISC.EN_SEQ_OW=0. 00b = Always read 0 01b = Acknowledge Sleep Exit sequence data and OK to overwrite. SEQ_REC_STAT.SEQ_EXS_RDY and SEQ_OW_STAT.SEQ_EXS_OW are cleared.
0	SEQ_ENS_ACK	R/W	b	Sleep Entry sequence data OK to overwrite. Valid and used only if VMON_MISC.EN_SEQ_OW=0. 00b = Always read 0 01b = Acknowledge Sleep Entry sequence data and OK to overwrite. SEQ_REC_STAT.SEQ_ENS_RDY and SEQ_OW_STAT.SEQ_ENS_OW are cleared.

7.5.2.67 AMSK_ON Register (Address = 0xA1) [Reset = 0xFF]

AMSK_ON is shown in 表 7-160.

Return to the Summary Table.

Auto-mask ON register. This register is used to mask UVLF, UVHF, and OVHF interrupts on ACT transition 0 to 1 transitions.

表 7-160. AMSK_ON Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	11111111b	Auto-mask on ACT 0 to 1 transition for IEN_UVLF, IEN_UVHF, and IEN_OVHF for VIN channel N (1 through 8). 00b = Channel interrupts not auto-masked 01b = Channel interrupts auto-masked

7.5.2.68 AMSK_OFF Register (Address = 0xA2) [Reset = 0xFF]

AMSK_OFF is shown in 表 7-161.

Return to the Summary Table.

Auto-mask OFF register. This register is used to mask UVLF, UVHF, and OVHF interrupts on ACT transition 1 to 0 transitions.

表 7-161. AMSK_OFF Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	11111111b	Auto-mask on ACT 1 to 0 transition for IEN_UVLF, IEN_UVHF, and IEN_OVHF for VIN channel N (1 through 8). 00b = Channel interrupts not auto-masked 01b = Channel interrupts auto-masked

7.5.2.69 AMSK_EXS Register (Address = 0xA3) [Reset = 0xFF]

AMSK_EXS is shown in 表 7-162.

Return to the Summary Table.

Auto-mask EXIT register. This register is used to mask UVLF, UVHF, and OVHF interrupts on $\overline{\text{SLEEP}}$ transition 0 to 1 transitions.

表 7-162. AMSK_EXS Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	11111111b	Auto-mask on $\overline{\text{SLEEP}}$ 0 to 1 transition for IEN_UVLF, IEN_UVHF, and IEN_OVHF for VIN channel N (1 through 8). 00b = Channel interrupts not auto-masked 01b = Channel interrupts auto-masked

7.5.2.70 AMSK_ENS Register (Address = 0xA4) [Reset = 0xFF]

AMSK_ENS is shown in 表 7-163.

Return to the Summary Table.

Auto-mask ENTRY register. This register is used to mask UVLF, UVHF, and OVHF interrupts on $\overline{\text{SLEEP}}$ transition 1 to 0 transitions.

表 7-163. AMSK_ENS Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	11111111b	Auto-mask on $\overline{\text{SLEEP}}$ 1 to 0 transition for IEN_UVLF, IEN_UVHF, and IEN_OVHF for VIN channel N (1 through 8). 00b = Channel interrupts not auto-masked 01b = Channel interrupts auto-masked

7.5.2.71 SEQ_TOUT_MSB Register (Address = 0xA5) [Reset = 0x00]

SEQ_TOUT_MSB is shown in 表 7-164.

Return to the Summary Table.

Sequence timeout most significant bits register.

表 7-164. SEQ_TOUT_MSB Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MILLISEC[7:0]	R/W	b	ACT and $\overline{\text{SLEEP}}$ transition sequence timeout. After the timeout, the auto-masks (AMSK_xxx) are released and the IEN_xVxF interrupts become active. 0x0 000 = 1ms 0x0 001 = 2ms While the max value is not specified, it is desirable to be able to set this timeout up to 4s, and at least 256ms (using only the lower byte at address 0xA 6).

7.5.2.72 SEQ_TOUT_LSB Register (Address = 0xA6) [Reset = 0x00]

SEQ_TOUT_LSB is shown in 表 7-165.

Return to the Summary Table.

Sequence timeout least significant bits register.

表 7-165. SEQ_TOUT_LSB Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MILLISEC[7:0]	R/W	b	ACT and $\overline{\text{SLEEP}}$ transition sequence timeout. After the timeout, the auto-masks (AMSK_xxx) are released and the IEN_xVxF interrupts become active. 0x0 000 = 1ms 0x0 001 = 2ms While the max value is not specified, it is desirable to be able to set this timeout up to 4s, and at least 256ms (using only the lower byte at address 0xA 6).

7.5.2.73 SEQ_SYNC Register (Address = 0xA7) [Reset = 0x00]

SEQ_SYNC is shown in 表 7-166.

Return to the Summary Table.

Sequence $\overline{\text{SYNC}}$ pulse duration from 50 us to 2600 us.

表 7-166. SEQ_SYNC Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	PULSE_WIDTH[7:0]	R/W	b	Pulse width for $\overline{\text{SYNC}}$ synchronization pulse. 00000000b = 50µs 00000001b = 60µs 00000010b = 70µs ... 11111101b = 2580µs 11111110b = 2590µs 11111111b = 2600µs

7.5.2.74 SEQ_UP_THLD Register (Address = 0xA8) [Reset = 0x1F]

SEQ_UP_THLD is shown in 表 7-167.

Return to the Summary Table.

Threshold selection register for up sequence tagging ACT and SLEEP transition 0 to 1 transitions.

表 7-167. SEQ_UP_THLD Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	11111b	OFF (200 mV) or UV (UV_LF[N] register) threshold selection for Power ON and Exit Sleep sequence tagging: 00b = Use OFF threshold (200 mV) 01b = Use UV threshold (UV_LF[N] register) 0b = OFF 1b = UVLF

7.5.2.75 SEQ_DN_THLD Register (Address = 0xA9) [Reset = 0x00]

SEQ_DN_THLD is shown in 表 7-168.

Return to the Summary Table.

Threshold selection register for down sequence tagging ACT and SLEEP transition 1 to 0 transitions.

表 7-168. SEQ_DN_THLD Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	MON[N]	R/W	b	OFF (200 mV) or UV (UV_LF[N] register) threshold selection for Power OFF and Enter Sleep sequence tagging: 00b = Use OFF threshold (200 mV) 01b = Use UV threshold (UV_LF[N] register) 0b = OFF 1b = UVLF

7.5.2.76 SEQ_ON_EXP[1] Register (Address = 0xB0) [Reset = 0x00]

SEQ_ON_EXP[1] is shown in 表 7-169.

Return to the Summary Table.

Channel 1 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 1.

表 7-169. SEQ_ON_EXP[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 1. This sequence order value is compared with the SEQ_ON_LOG[1] register assigned to the channel during the sequence triggered by ACT.

7.5.2.77 SEQ_ON_EXP[2] Register (Address = 0xB1) [Reset = 0x00]

SEQ_ON_EXP[2] is shown in 表 7-170.

Return to the Summary Table.

Channel 2 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 2.

表 7-170. SEQ_ON_EXP[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 2. This sequence order value is compared with the SEQ_ON_LOG[2] register assigned to the channel during the sequence triggered by ACT.

7.5.2.78 SEQ_ON_EXP[3] Register (Address = 0xB2) [Reset = 0x00]

SEQ_ON_EXP[3] is shown in 表 7-171.

Return to the Summary Table.

Channel 3 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 3

表 7-171. SEQ_ON_EXP[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 3. This sequence order value is compared with the SEQ_ON_LOG[3] register assigned to the channel during the sequence triggered by ACT.

7.5.2.79 SEQ_ON_EXP[4] Register (Address = 0xB3) [Reset = 0x00]

SEQ_ON_EXP[4] is shown in 表 7-172.

Return to the Summary Table.

Channel 4 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 4.

表 7-172. SEQ_ON_EXP[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 4. This sequence order value is compared with the SEQ_ON_LOG[4] register assigned to the channel during the sequence triggered by ACT.

7.5.2.80 SEQ_ON_EXP[5] Register (Address = 0xB4) [Reset = 0x00]

SEQ_ON_EXP[5] is shown in 表 7-173.

Return to the Summary Table.

Channel 5 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 5.

表 7-173. SEQ_ON_EXP[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 5. This sequence order value is compared with the SEQ_ON_LOG[5] register assigned to the channel during the sequence triggered by ACT.

7.5.2.81 SEQ_ON_EXP[6] Register (Address = 0xB5) [Reset = 0x00]

SEQ_ON_EXP[6] is shown in 表 7-174.

Return to the Summary Table.

Channel 6 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 6.

表 7-174. SEQ_ON_EXP[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 6. This sequence order value is compared with the SEQ_ON_LOG[6] register assigned to the channel during the sequence triggered by ACT.

7.5.2.82 SEQ_ON_EXP[7] Register (Address = 0xB6) [Reset = 0x00]

SEQ_ON_EXP[7] is shown in 表 7-175.

Return to the Summary Table.

Channel 7 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 7.

表 7-175. SEQ_ON_EXP[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 7. This sequence order value is compared with the SEQ_ON_LOG[5] register assigned to the channel during the sequence triggered by ACT.

7.5.2.83 SEQ_ON_EXP[8] Register (Address = 0xB7) [Reset = 0x00]

SEQ_ON_EXP[8] is shown in 表 7-176.

Return to the Summary Table.

Channel 8 Power ON sequence order expected value register. This register is used to set the value of the expected power-on sequence order for channel 8.

表 7-176. SEQ_ON_EXP[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power ON sequence order value for channel 8. This sequence order value is compared with the SEQ_ON_LOG[6] register assigned to the channel during the sequence triggered by ACT.

7.5.2.84 SEQ_OFF_EXP[1] Register (Address = 0xC0) [Reset = 0x00]

SEQ_OFF_EXP[1] is shown in 表 7-177.

Return to the Summary Table.

Channel 1 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 1.

表 7-177. SEQ_OFF_EXP[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 1. This sequence order value is compared with the SEQ_OFF_LOG[1] register assigned to the channel during the sequence triggered by ACT

7.5.2.85 SEQ_OFF_EXP[2] Register (Address = 0xC1) [Reset = 0x00]

SEQ_OFF_EXP[2] is shown in 表 7-178.

Return to the Summary Table.

Channel 2 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 2.

表 7-178. SEQ_OFF_EXP[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 2. This sequence order value is compared with the SEQ_OFF_LOG[2] register assigned to the channel during the sequence triggered by ACT

7.5.2.86 SEQ_OFF_EXP[3] Register (Address = 0xC2) [Reset = 0x00]

SEQ_OFF_EXP[3] is shown in 表 7-179.

Return to the Summary Table.

Channel 3 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 3.

表 7-179. SEQ_OFF_EXP[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 3. This sequence order value is compared with the SEQ_OFF_LOG[3] register assigned to the channel during the sequence triggered by ACT

7.5.2.87 SEQ_OFF_EXP[4] Register (Address = 0xC3) [Reset = 0x00]

SEQ_OFF_EXP[4] is shown in 表 7-180.

Return to the Summary Table.

Channel 4 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 4.

表 7-180. SEQ_OFF_EXP[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 4. This sequence order value is compared with the SEQ_OFF_LOG[4] register assigned to the channel during the sequence triggered by ACT

7.5.2.88 SEQ_OFF_EXP[5] Register (Address = 0xC4) [Reset = 0x00]

SEQ_OFF_EXP[5] is shown in 表 7-181.

Return to the Summary Table.

Channel 5 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 5.

表 7-181. SEQ_OFF_EXP[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 5. This sequence order value is compared with the SEQ_OFF_LOG[5] register assigned to the channel during the sequence triggered by ACT

7.5.2.89 SEQ_OFF_EXP[6] Register (Address = 0xC5) [Reset = 0x00]

SEQ_OFF_EXP[6] is shown in 表 7-182.

Return to the Summary Table.

Channel 6 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 6.

表 7-182. SEQ_OFF_EXP[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 6. This sequence order value is compared with the SEQ_OFF_LOG[6] register assigned to the channel during the sequence triggered by ACT

7.5.2.90 SEQ_OFF_EXP[7] Register (Address = 0xC6) [Reset = 0x00]

SEQ_OFF_EXP[7] is shown in 表 7-183.

Return to the Summary Table.

Channel 7 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 7.

表 7-183. SEQ_OFF_EXP[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 7. This sequence order value is compared with the SEQ_OFF_LOG[5] register assigned to the channel during the sequence triggered by ACT

7.5.2.91 SEQ_OFF_EXP[8] Register (Address = 0xC7) [Reset = 0x00]

SEQ_OFF_EXP[8] is shown in 表 7-184.

Return to the Summary Table.

Channel 8 Power OFF sequence order expected value register. This register is used to set the value of the expected power-off sequence order for channel 8.

表 7-184. SEQ_OFF_EXP[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Power OFF sequence order value for channel 8. This sequence order value is compared with the SEQ_OFF_LOG[6] register assigned to the channel during the sequence triggered by ACT

7.5.2.92 SEQ_EXS_EXP[1] Register (Address = 0xD0) [Reset = 0x00]

SEQ_EXS_EXP[1] is shown in 表 7-185.

Return to the Summary Table.

Channel 1 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 1

表 7-185. SEQ_EXS_EXP[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 1. This sequence order value is compared with the SEQ_EXS_LOG[1] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.93 SEQ_EXS_EXP[2] Register (Address = 0xD1) [Reset = 0x00]

SEQ_EXS_EXP[2] is shown in 表 7-186.

Return to the Summary Table.

Channel 2 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 2

表 7-186. SEQ_EXS_EXP[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 2. This sequence order value is compared with the SEQ_EXS_LOG[2] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.94 SEQ_EXS_EXP[3] Register (Address = 0xD2) [Reset = 0x00]

SEQ_EXS_EXP[3] is shown in 表 7-187.

Return to the Summary Table.

Channel 3 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 3

表 7-187. SEQ_EXS_EXP[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 3. This sequence order value is compared with the SEQ_EXS_LOG[3] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.95 SEQ_EXS_EXP[4] Register (Address = 0xD3) [Reset = 0x00]

SEQ_EXS_EXP[4] is shown in 表 7-188.

Return to the Summary Table.

Channel 4 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 4

表 7-188. SEQ_EXS_EXP[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 4. This sequence order value is compared with the SEQ_EXS_LOG[4] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.96 SEQ_EXS_EXP[5] Register (Address = 0xD4) [Reset = 0x00]

SEQ_EXS_EXP[5] is shown in 表 7-189.

Return to the Summary Table.

Channel 5 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 5

表 7-189. SEQ_EXS_EXP[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 5. This sequence order value is compared with the SEQ_EXS_LOG[5] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.97 SEQ_EXS_EXP[6] Register (Address = 0xD5) [Reset = 0x00]

SEQ_EXS_EXP[6] is shown in 表 7-190.

Return to the Summary Table.

Channel 6 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 6

表 7-190. SEQ_EXS_EXP[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 6. This sequence order value is compared with the SEQ_EXS_LOG[6] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.98 SEQ_EXS_EXP[7] Register (Address = 0xD6) [Reset = 0x00]

SEQ_EXS_EXP[7] is shown in 表 7-191.

Return to the Summary Table.

Channel 7 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 7

表 7-191. SEQ_EXS_EXP[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 7. This sequence order value is compared with the SEQ_EXS_LOG[5] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.99 SEQ_EXS_EXP[8] Register (Address = 0xD7) [Reset = 0x00]

SEQ_EXS_EXP[8] is shown in 表 7-192.

Return to the Summary Table.

Channel 8 Sleep Exit sequence order expected value register. This register is used to set the value of the expected sleep exit sequence order for channel 8

表 7-192. SEQ_EXS_EXP[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Exit sequence order value for channel 8. This sequence order value is compared with the SEQ_EXS_LOG[6] register assigned to the channel during the sequence triggered by ACT/ $\overline{\text{SLEEP}}$.

7.5.2.100 SEQ_ENS_EXP[1] Register (Address = 0xE0) [Reset = 0x00]

SEQ_ENS_EXP[1] is shown in 表 7-193.

Return to the Summary Table.

Channel 1 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 1

表 7-193. SEQ_ENS_EXP[1] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 1. This sequence order value is compared with the SEQ_ENS_LOG[1] register assigned to the channel during the sequence triggered by $\overline{\text{SLEEP}}$.

7.5.2.101 SEQ_ENS_EXP[2] Register (Address = 0xE1) [Reset = 0x00]

SEQ_ENS_EXP[2] is shown in 表 7-194.

Return to the Summary Table.

Channel 2 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 2

表 7-194. SEQ_ENS_EXP[2] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 2. This sequence order value is compared with the SEQ_ENS_LOG[2] register assigned to the channel during the sequence triggered by SLEEP.

7.5.2.102 SEQ_ENS_EXP[3] Register (Address = 0xE2) [Reset = 0x00]

SEQ_ENS_EXP[3] is shown in 表 7-195.

Return to the Summary Table.

Channel 3 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 3

表 7-195. SEQ_ENS_EXP[3] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 3. This sequence order value is compared with the SEQ_ENS_LOG[3] register assigned to the channel during the sequence triggered by SLEEP.

7.5.2.103 SEQ_ENS_EXP[4] Register (Address = 0xE3) [Reset = 0x00]

SEQ_ENS_EXP[4] is shown in 表 7-196.

Return to the Summary Table.

Channel 4 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 4

表 7-196. SEQ_ENS_EXP[4] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 4. This sequence order value is compared with the SEQ_ENS_LOG[4] register assigned to the channel during the sequence triggered by SLEEP.

7.5.2.104 SEQ_ENS_EXP[5] Register (Address = 0xE4) [Reset = 0x00]

SEQ_ENS_EXP[5] is shown in 表 7-197.

Return to the Summary Table.

Channel 5 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 5

表 7-197. SEQ_ENS_EXP[5] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 5. This sequence order value is compared with the SEQ_ENS_LOG[5] register assigned to the channel during the sequence triggered by SLEEP.

7.5.2.105 SEQ_ENS_EXP[6] Register (Address = 0xE5) [Reset = 0x00]

SEQ_ENS_EXP[6] is shown in 表 7-198.

Return to the Summary Table.

Channel 6 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 6

表 7-198. SEQ_ENS_EXP[6] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 6. This sequence order value is compared with the SEQ_ENS_LOG[6] register assigned to the channel during the sequence triggered by SLEEP.

7.5.2.106 SEQ_ENS_EXP[7] Register (Address = 0xE6) [Reset = 0x00]

SEQ_ENS_EXP[7] is shown in 表 7-199.

Return to the Summary Table.

Channel 7 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 7

表 7-199. SEQ_ENS_EXP[7] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 7. This sequence order value is compared with the SEQ_ENS_LOG[5] register assigned to the channel during the sequence triggered by SLEEP.

7.5.2.107 SEQ_ENS_EXP[8] Register (Address = 0xE7) [Reset = 0x00]

SEQ_ENS_EXP[8] is shown in 表 7-200.

Return to the Summary Table.

Channel 8 Sleep Entry sequence order expected value register. This register is used to set the value of the expected sleep entry sequence order for channel 8

表 7-200. SEQ_ENS_EXP[8] Register Field Descriptions

Bit	Field	Type	Reset	Description
7:0	ORDER[7:0]	R/W	b	Expected Sleep Entry sequence order value for channel 8. This sequence order value is compared with the SEQ_ENS_LOG[6] register assigned to the channel during the sequence triggered by SLEEP.

8 Application and Implementation

注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for design purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

Modern SOC and FPGA devices typically have multiple power rails to provide power to the different blocks within the IC. Accurate voltage level and timing requirements are common and must be met in order to ensure proper operation of these devices. By utilizing TPS389006-Q1 along with a multichannel voltage sequencer, the power up and power down sequencing requirements as well as the core voltage requirements of the target SOC or FPGA device can be met. This design focuses on meeting the timing requirements for an SOC by using the TPS389006-Q1.

8.2 Typical Application

8.2.1 Multichannel Sequencer and Monitor

A typical application for the TPS389006 is shown in 図 8-1. TPS389006 is used to provide the proper voltage monitoring for the target SOC device. A multichannel voltage monitor TPS389006 is used to monitor the voltage rails as these rails power up and power down to make sure that the correct sequence occurs in both occasions. A safety microcontroller is also used to provide ACT, $\overline{\text{SLEEP}}$, and I^{2}C commands to the TPS389006 monitor the NIRQ pin for active faults. The ACT signal from the safety microcontroller determines when the TPS389006 enters into ACTIVE or IDLE states while the NIRQ pin of the TPS389006 acts as a latched interrupt pin that is set when a fault has occurred. The host microcontroller can clear the fault by writing 1 to the affected registers. The power rails for the safety microcontroller are not shown in 図 8-1 for simplicity.

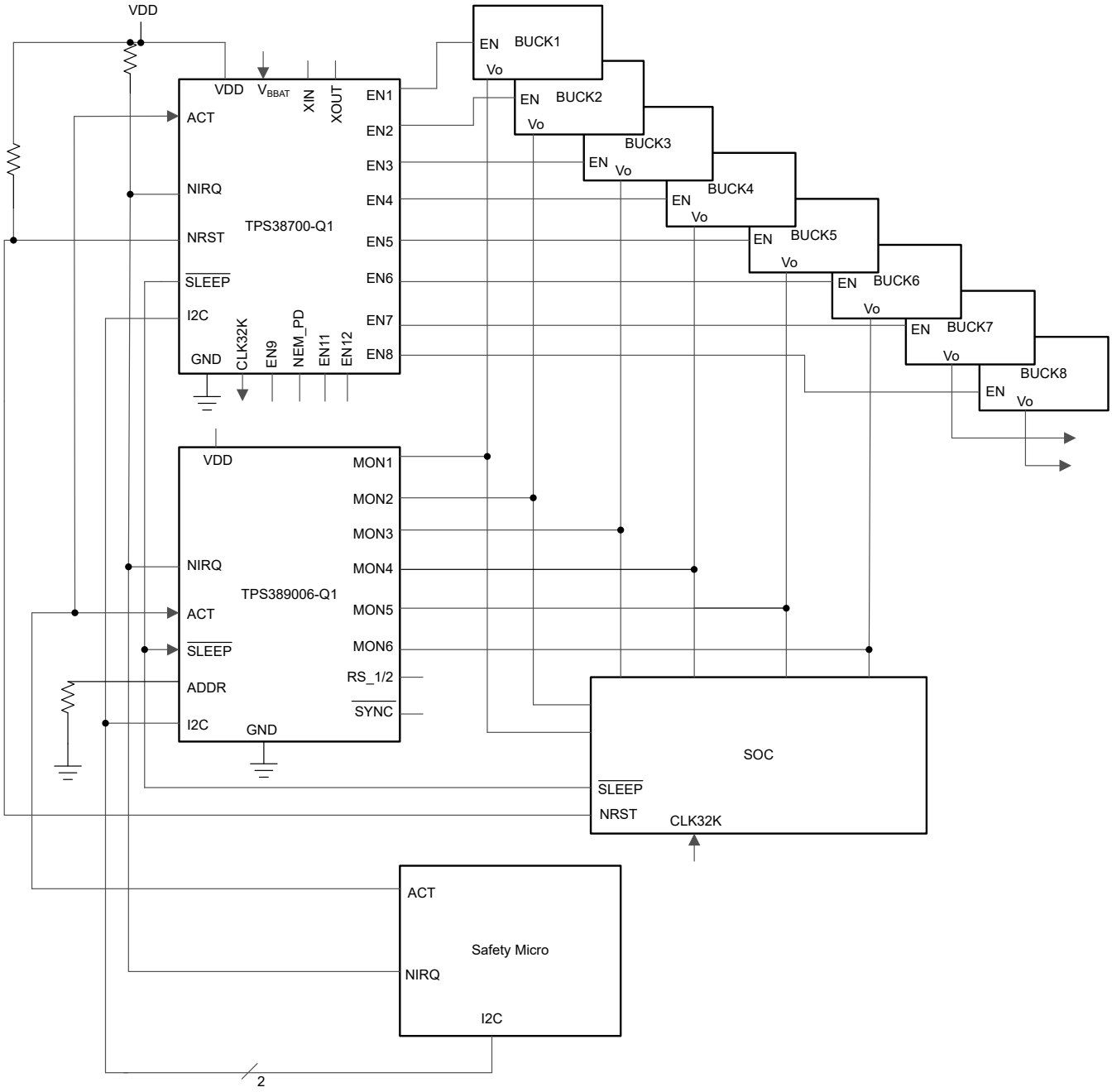

図 8-1. TPS389006 Voltage Monitor Design Block Diagram

8.2.2 Design Requirements

Six different voltage rails supplied by DC/DC converters need to be properly monitored in this design. All detected failures in sequencing will be reported via an external hardware interrupt signal. All detected failures will be logged in internal registers and be accessible to an external processor via I^2C.

8.2.3 Detailed Design Procedure

TPS389006-Q1 device option comes preprogrammed with default values for over voltage, under voltage, expected sequences on power up and down. Please follow the design requirements outlined below.

- NIRQ pin requires a pull up resistor in the range of 10kΩ to 100kΩ.
- SDA and SCL lines require pull up resistors in the range of 10kΩ.
- The ACT pin is driven by an external safety microcontroller. When the ACT pin is driven high, the device enters into ACTIVE mode. When the ACT pin is driven low, the device enters into SLEEP mode.
- The safety microcontroller is used to clear fault interrupts reported through the NIRQ interrupt pin and the INT_SCR1 and INT_SCR2 registers. The interrupt flags can only be cleared by the host micrcontroller with a write-1-to-clear operation; interrupt flags are not automatically cleared if the fault condition is no longer present.

8.2.4 Application Curves

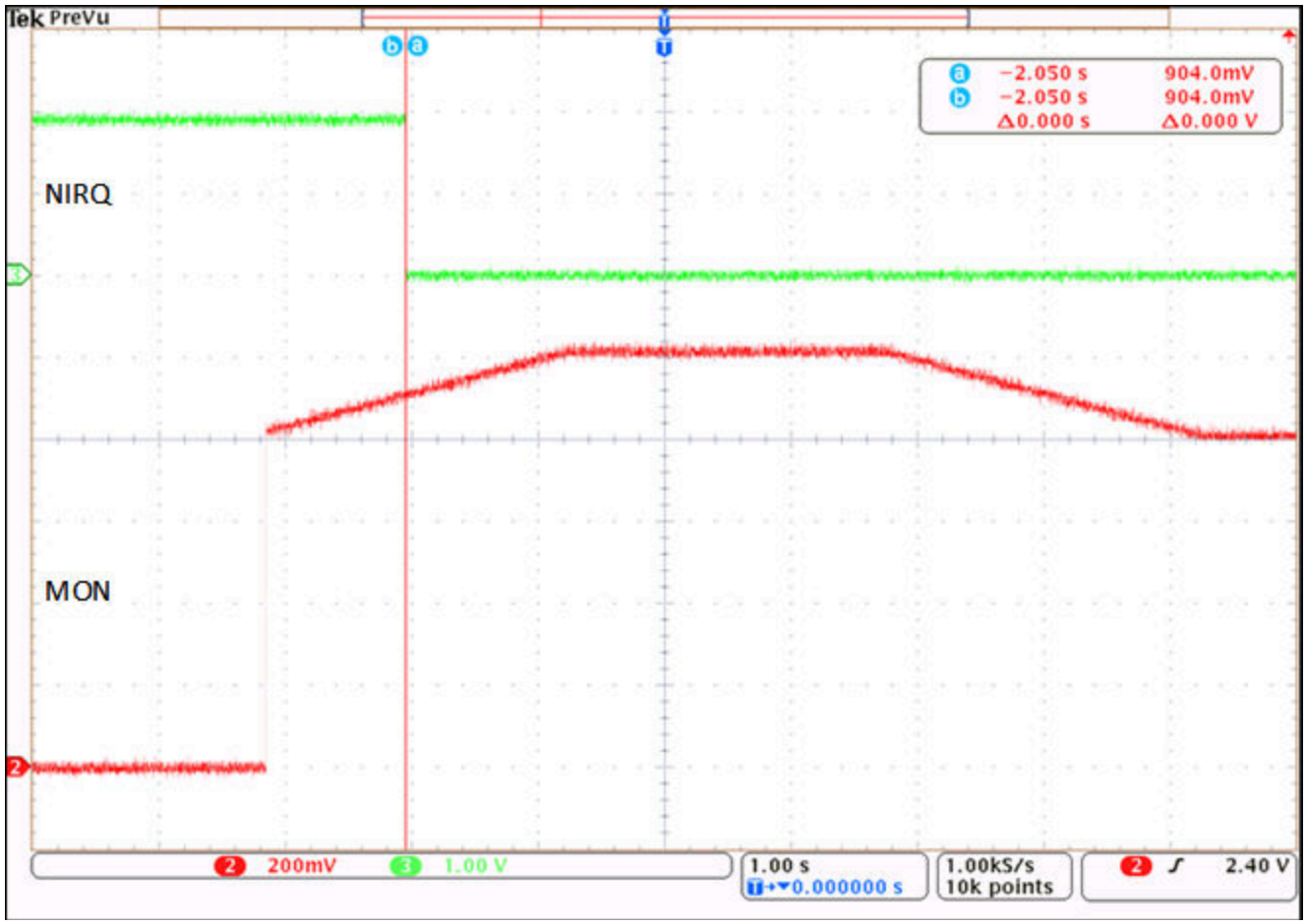

図 8-2. NIRQ Triggered After an Overvoltage Fault

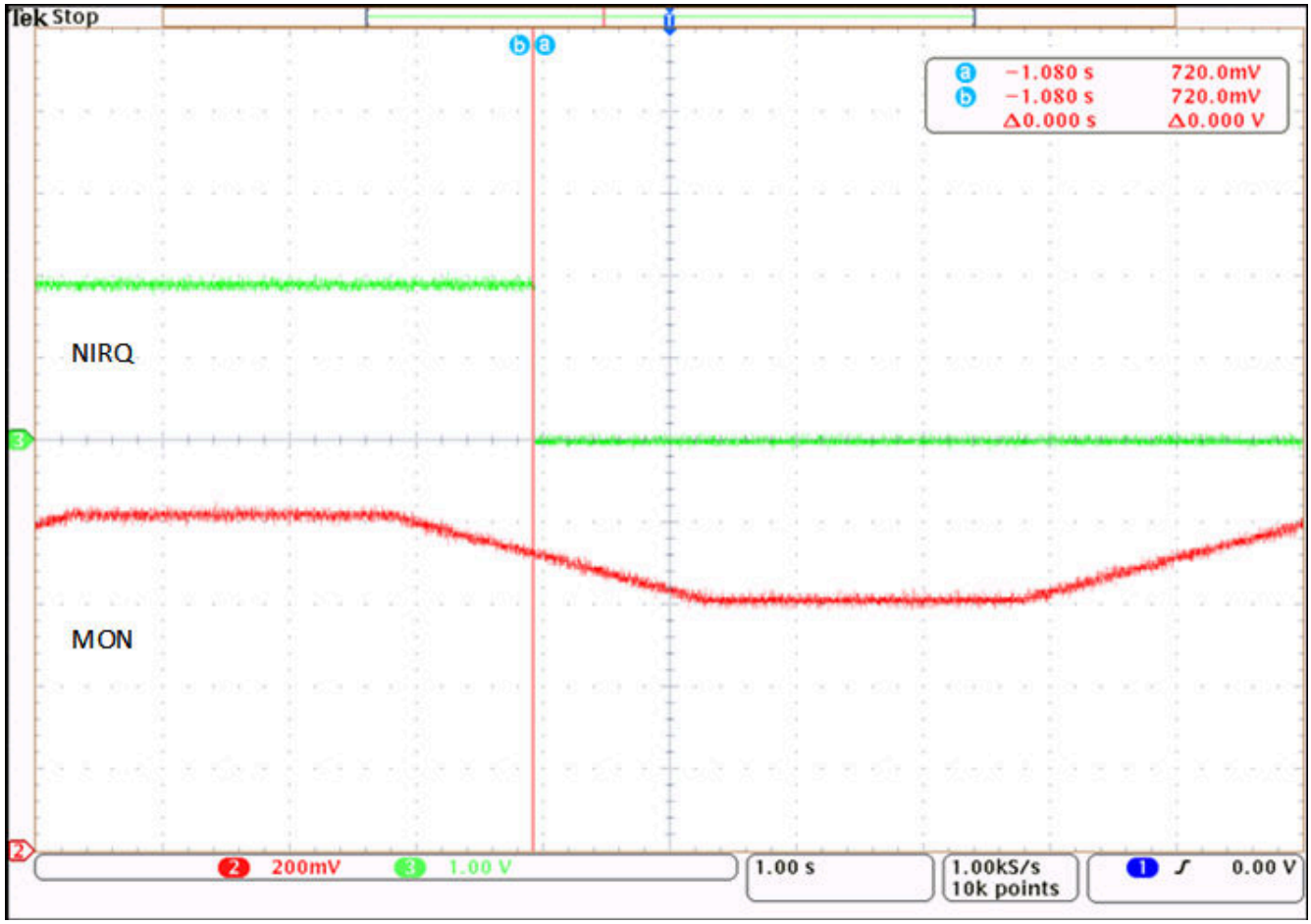

図 8-3. NIRQ Triggered After an Undervoltage Fault

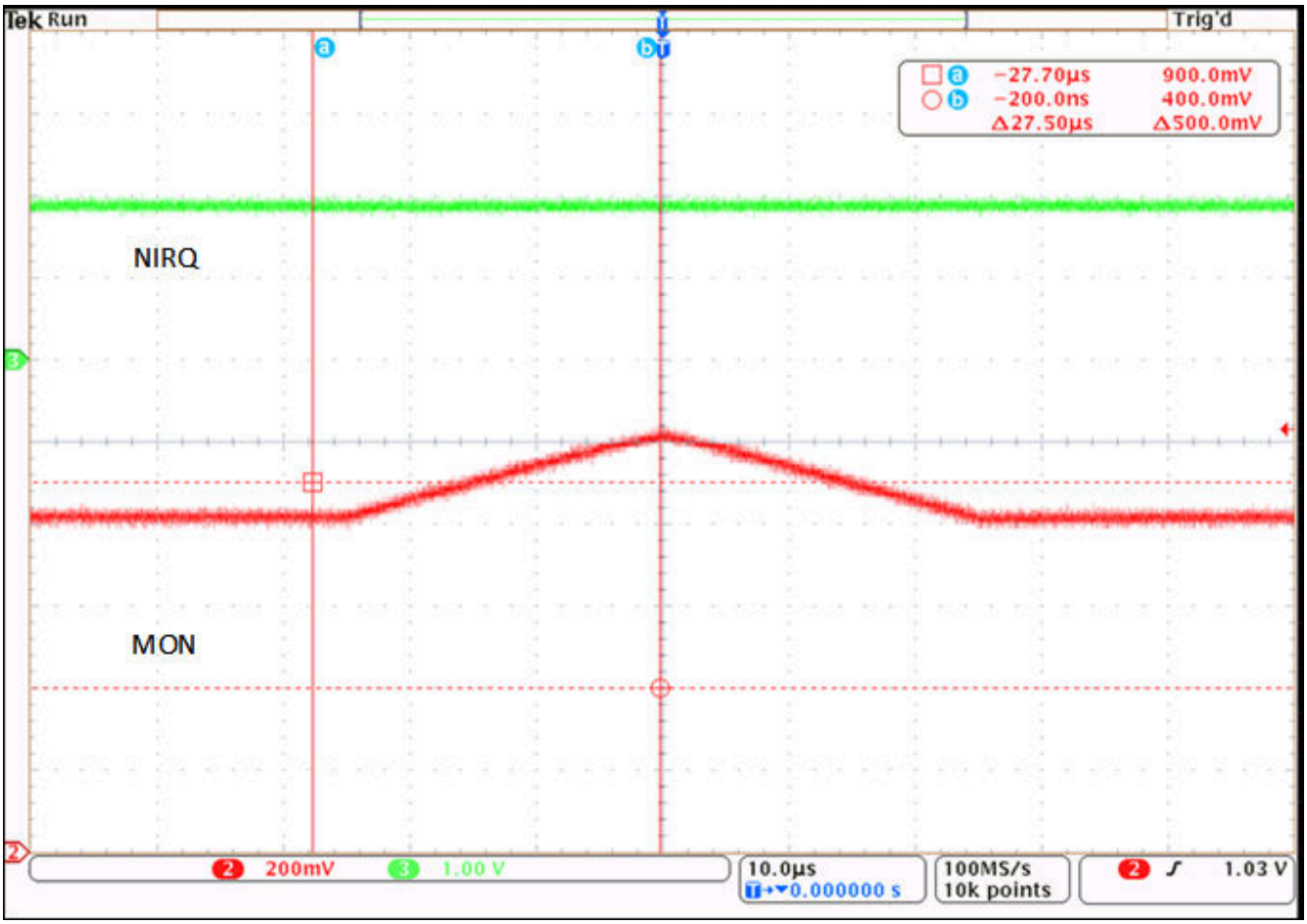

図 8-4. NIRQ Not Triggered on Overvoltage Fault with 51.2us OV Debounce Filter

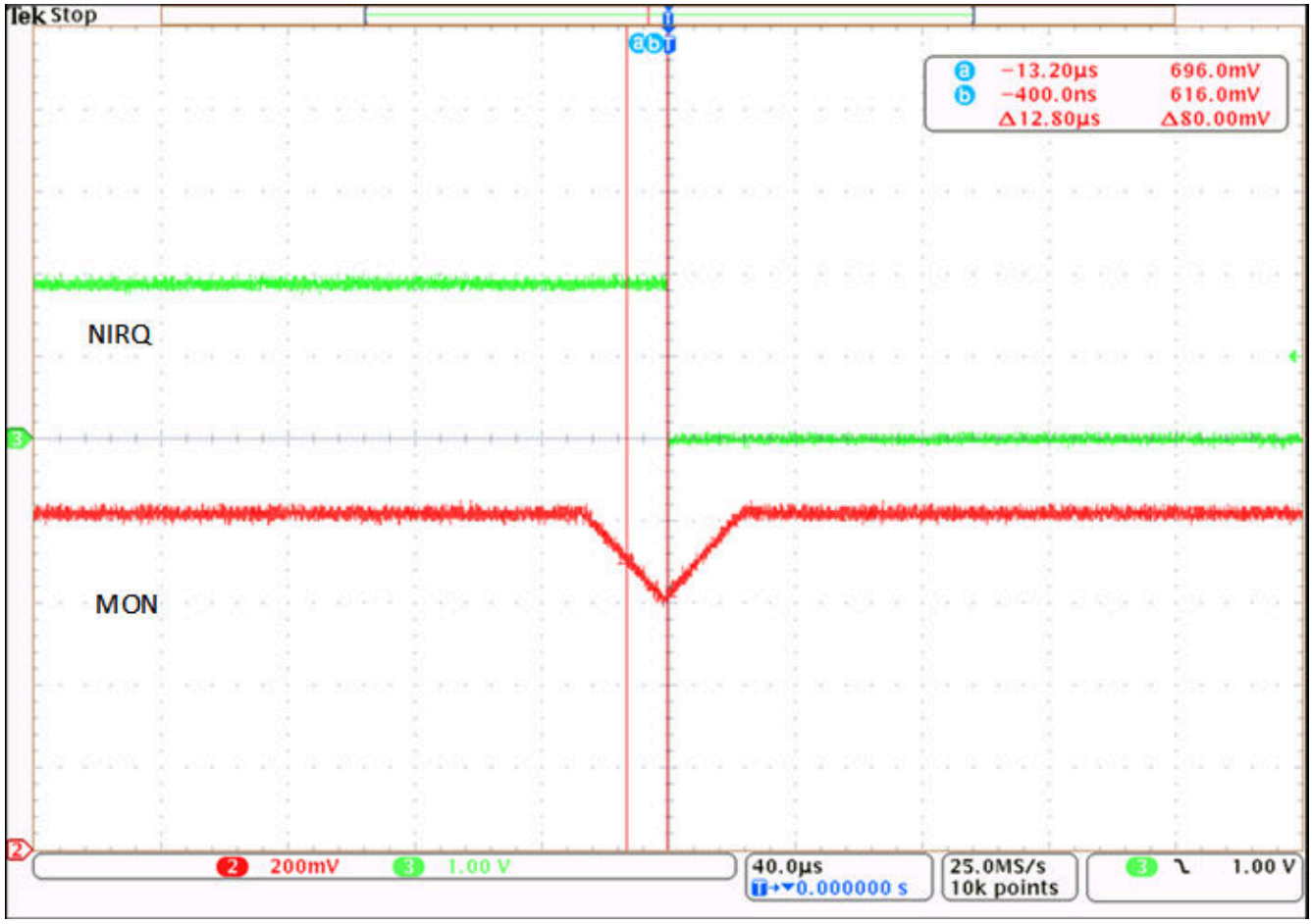

図 8-5. NIRQ Triggered on Undervoltage Fault with 12.8us UV Debounce Filter

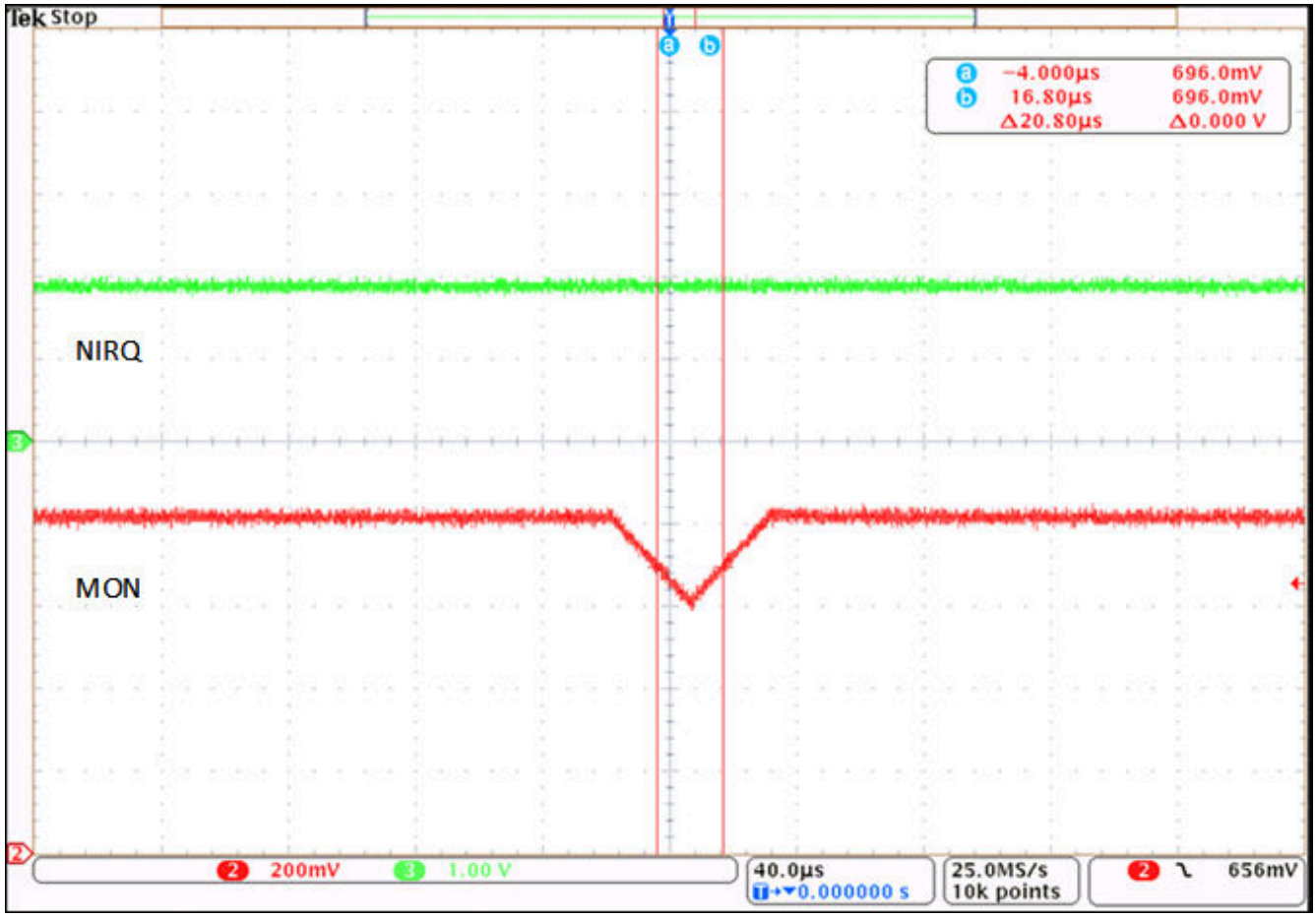

図 8-6. NIRQ Not Triggered on Undervoltage Fault with 25us UV Debounce Filter

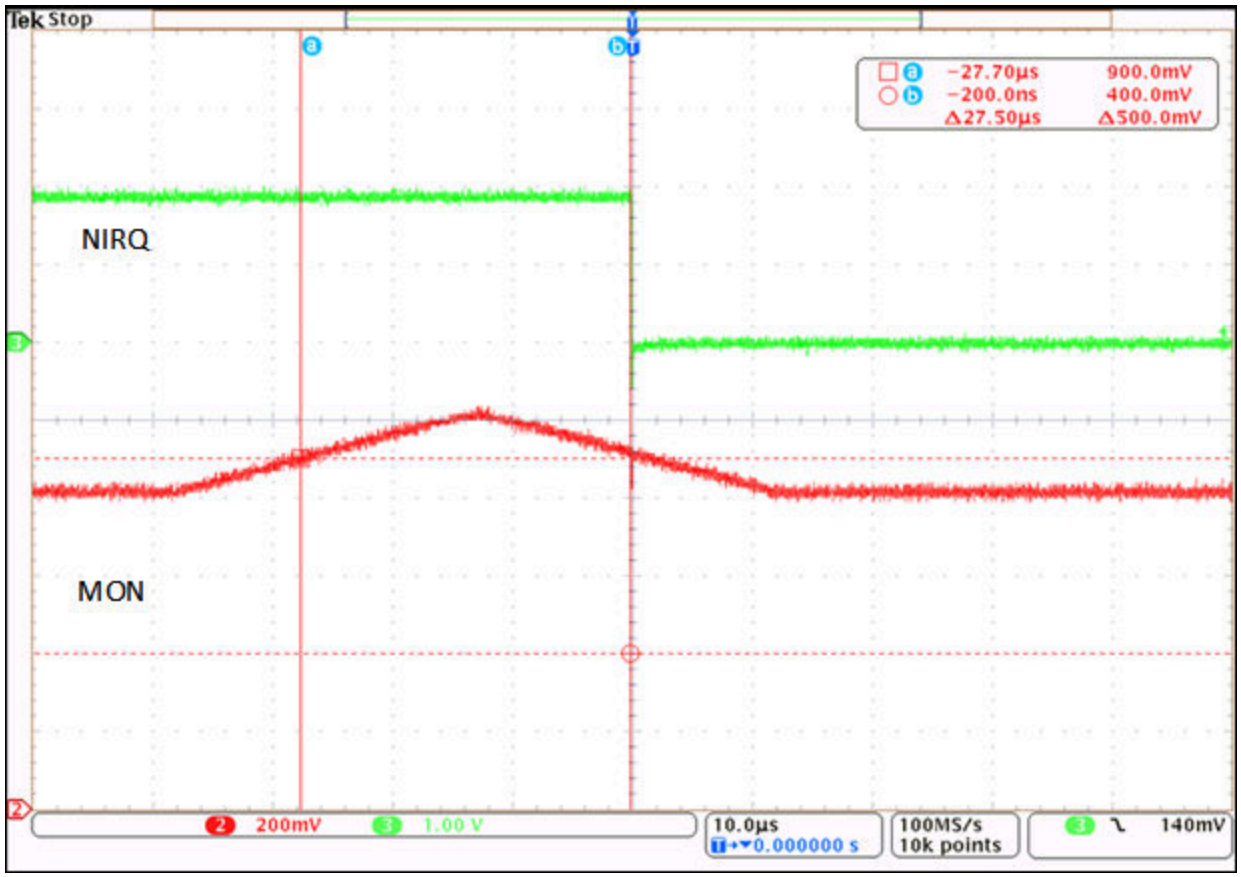

図 8-7. NIRQ Triggered on Overvoltage Fault with 25us OV Debounce Filter

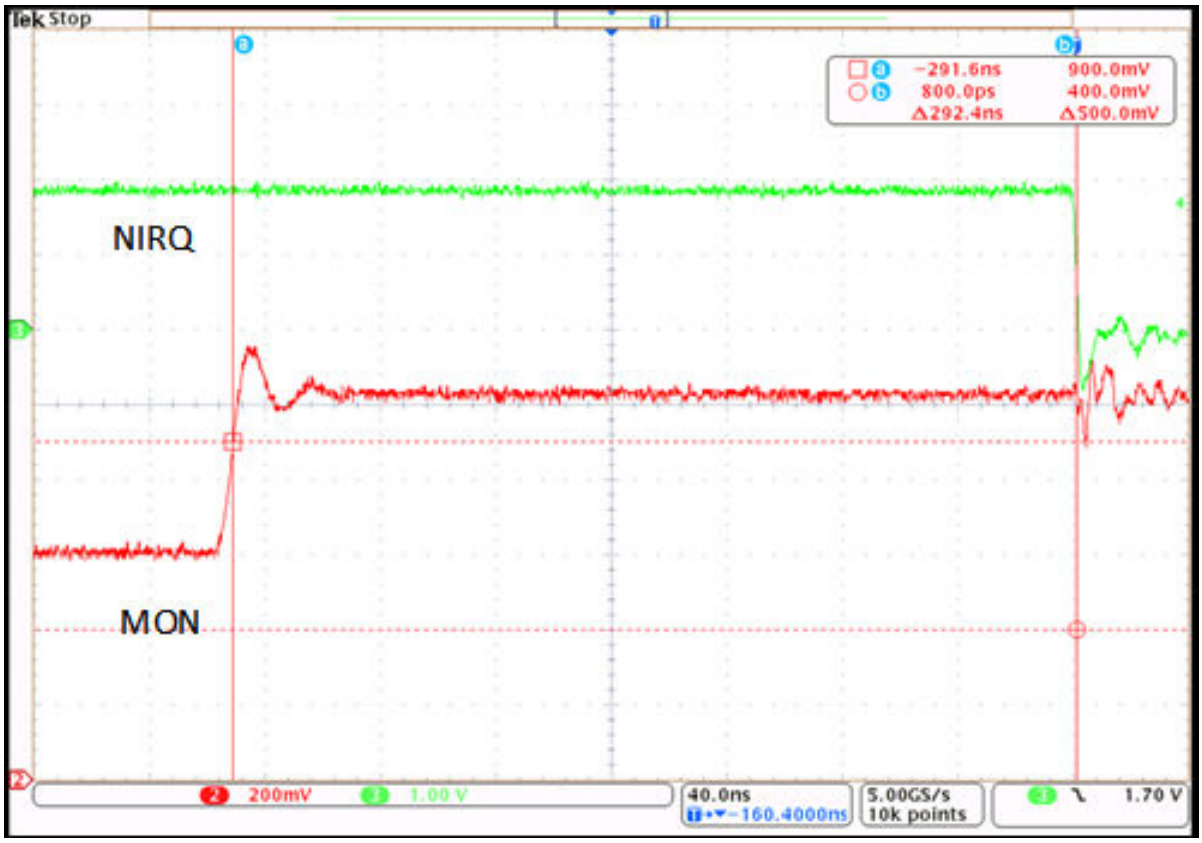

図 8-8. NIRQ Propagation Delay Resulting from Overvoltage Fault

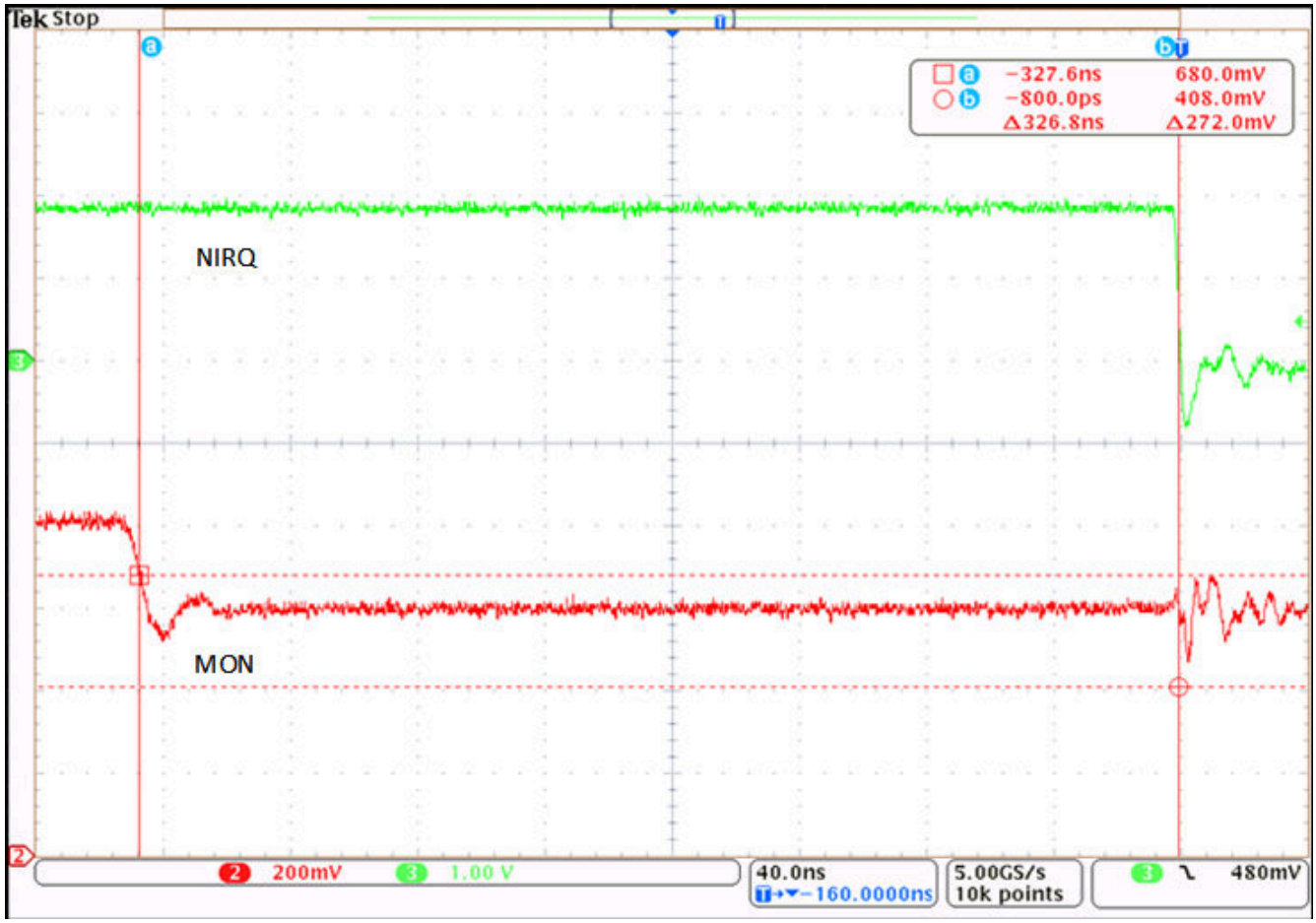

図 8-9. NIRQ Propagation Delay Resulting from Undervoltage Fault

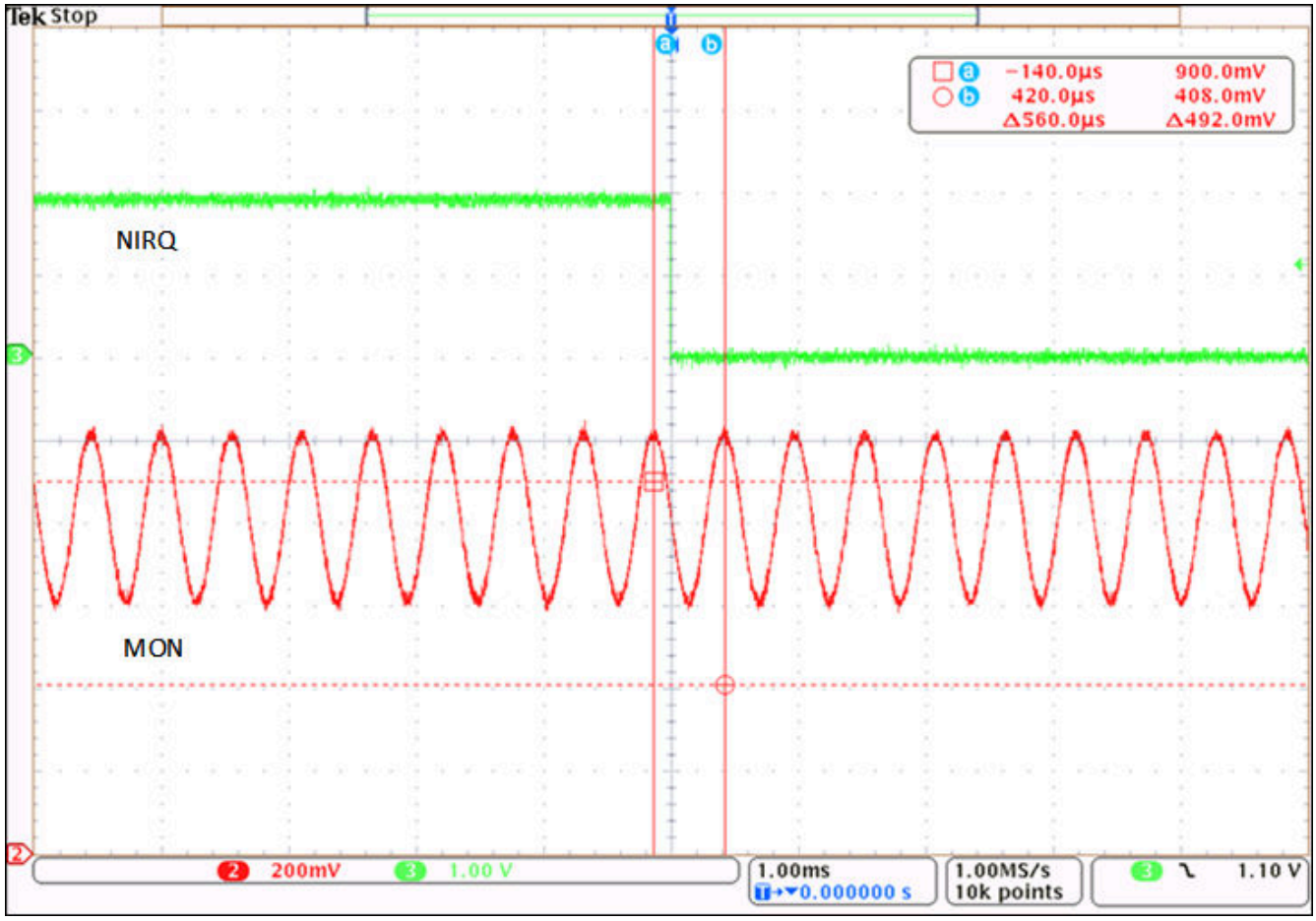

図 8-10. 1kHz Low Pass Filter Setting. NIRQ Triggered at 1.8kHz Signal with a 0.8V DC Component and 200mVp-p AC Signal. OV and UV Thresholds Set to 0.9V and 0.7V. Reduced the Frequency From 2kHz Until the NIRQ Pin Went Low.

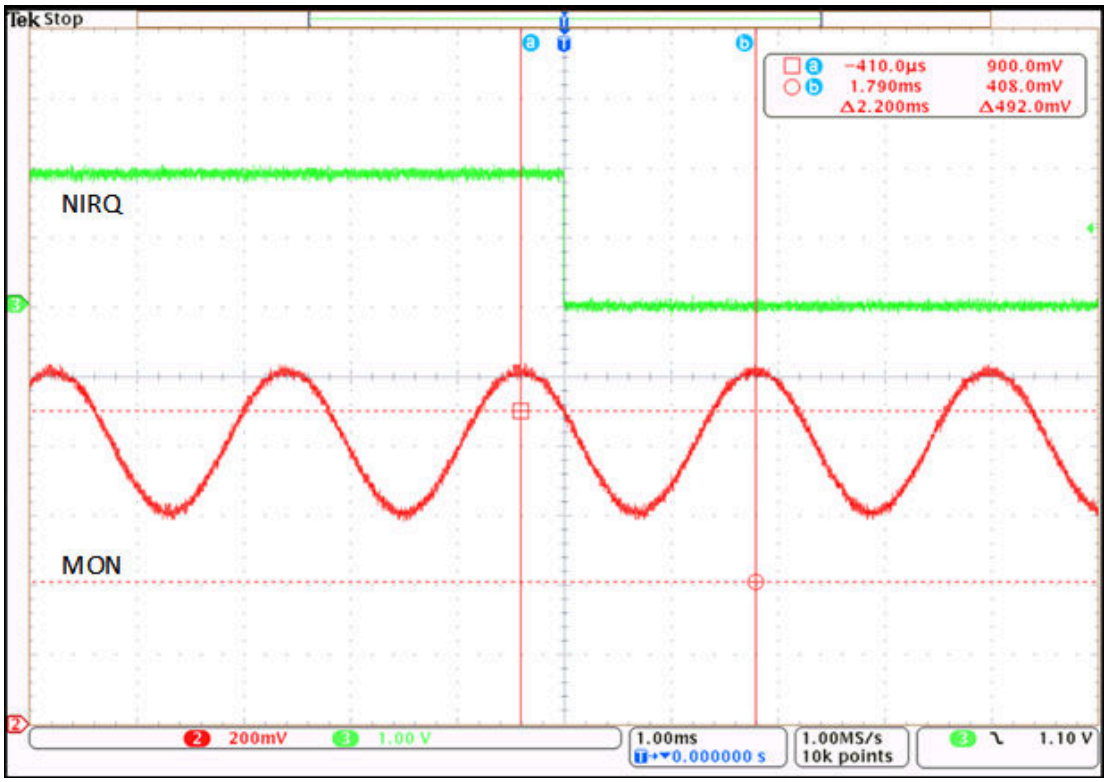

図 8-11. 250Hz Low Pass Filter setting. NIRQ Triggered at 455Hz Signal With a 0.8V DC Component and 200mVp-p AC Signal. OV and UV Thresholds Set to 0.9V and 0.7V. Reduced the Frequency From 500Hz Until the NIRQ Pin Went Low.

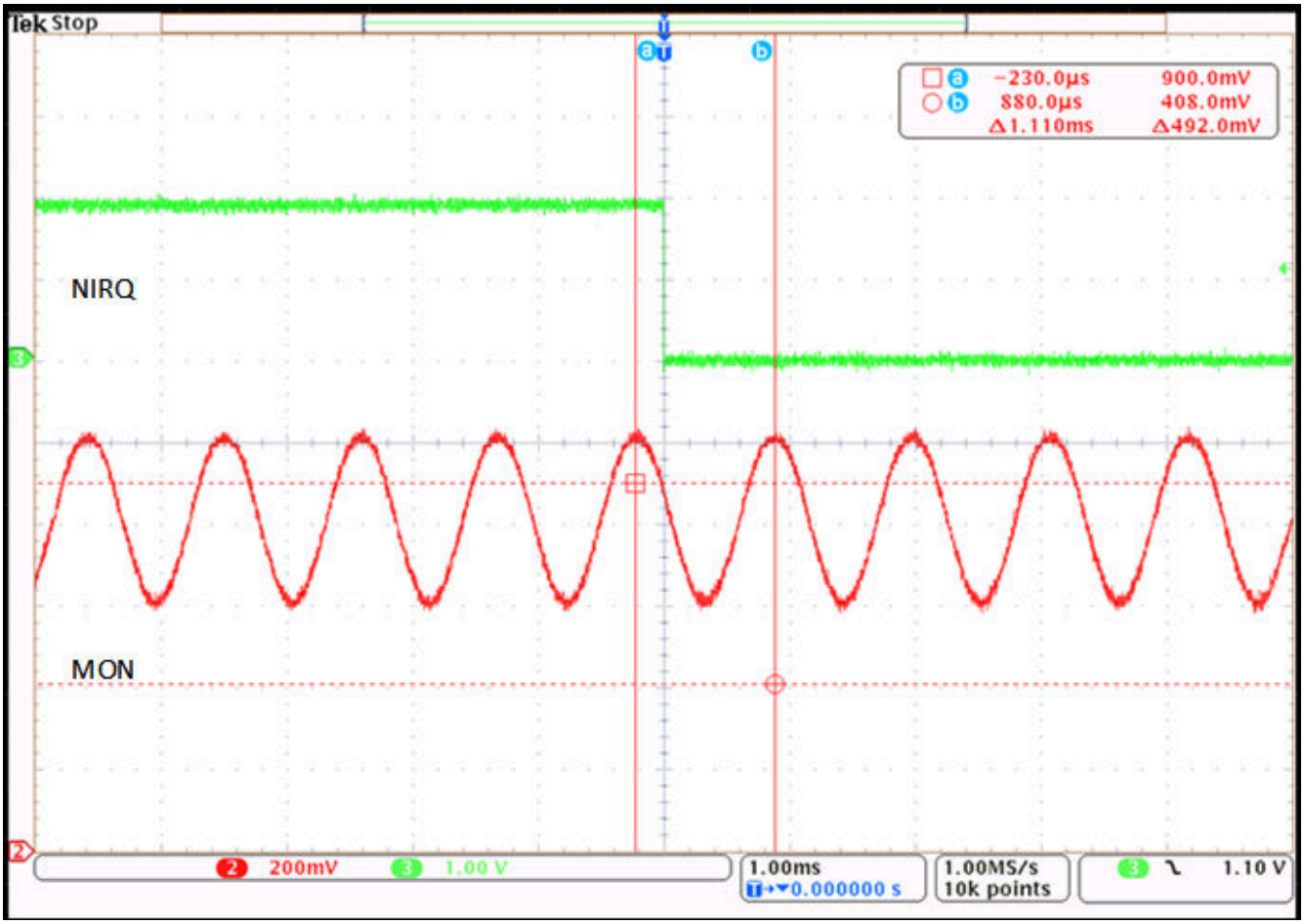

図 8-12. 500Hz Low Pass Filter Setting. NIRQ Triggered at 0.9kHz Signal With a 0.8V DC Component and 200mVp-p AC Signal. OV and UV Thresholds Set to 0.9V and 0.7V. Reduced the Frequency From 1kHz Until the NIRQ Pin Went Low.

8.3 Power Supply Recommendations

8.3.1 Power Supply Guidelines

This device is designed to operate from an input supply with a voltage range between 2.5V to 5.5V. The device has a 6V absolute maximum rating on the VDD pin. Good analog practice is to place a 0.1µF to 1µF capacitor between the VDD pin and the GND pin depending on the input voltage supply noise. If the voltage supply providing power to VDD is susceptible to any large voltage transient that exceed maximum specifications, additional precautions must be taken. See SNVA849 for more information.

8.4 Layout

8.4.1 Layout Guidelines

- Place the external components as close to the device as possible. This configuration prevents parasitic errors from occurring.
- Avoid using long traces for the VDD supply node. The VDD capacitor, along with parasitic inductance from the supply to the capacitor, can form an LC circuit and create ringing with peak voltages above the maximum VDD voltage.
- Avoid using long traces of voltage to the MON pin. Long traces increase parasitic inductance and cause inaccurate monitoring and diagnostics.

- If differential voltage sensing is required for MON1 and/or MON2, route RS_1/2 pin to the point of measurement
- Do not run sensitive analog traces in parallel with digital traces. Avoid crossing digital and analog traces if possible, and only make perpendicular crossings when absolutely necessary.

8.4.2 Layout Example

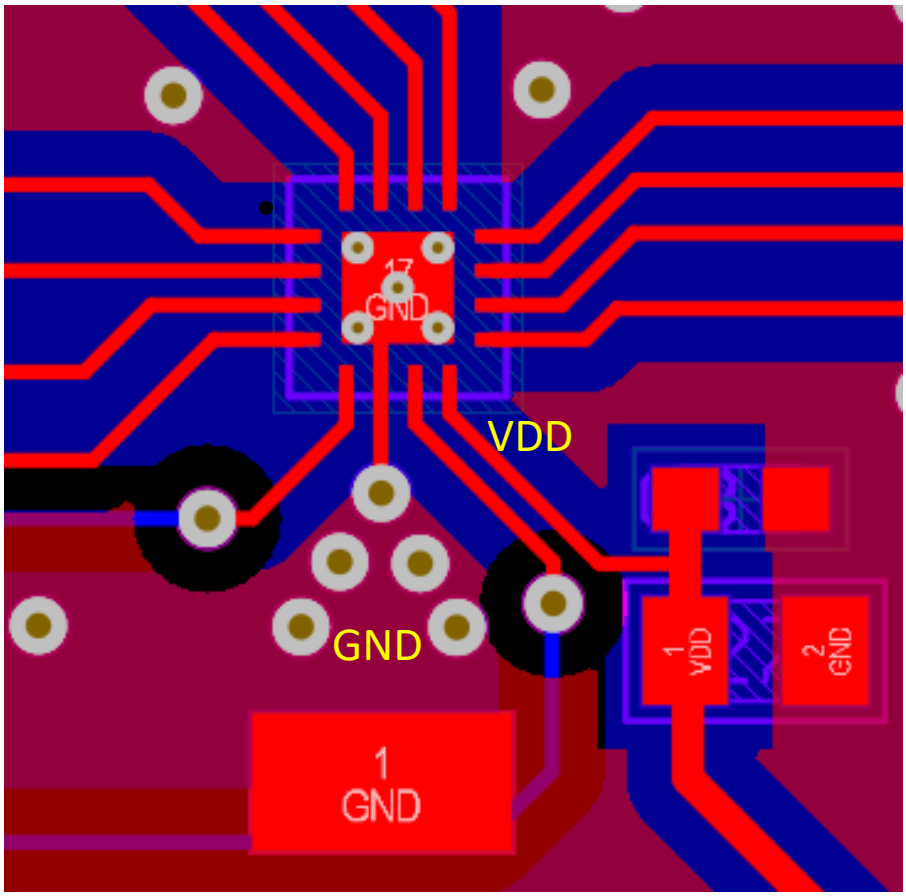

図 8-13. Recommended Layout

9 Device and Documentation Support

9.1 Device Nomenclature

表 9-1 表 9-2 and 表 9-3 show how to decode the function of the device based on the part number.

表 9-1. Device Thresholds TPS389006-Q1,TPS389R06-Q1

ORDERING CODE	Thresholds	VMON1 (V)	VMON2 (V)	VMON3 (V)	VMON4 (V)	VMON5 (V)	VMON6 (V)
TPS389006ADJRTER	UV_HF/OV_HF	0.47/0.53	0.47/0.53	0.66/0.74	0.66/0.74	0.66/0.74	0.66/0.74
	UV_LF/OV_LF	0.5/0.7	0.5/0.7	0.5/0.7	0.5/0.7	0.5/0.7	0.5/0.7
TPS389006007RTER	UV_HF/OV_HF	1.4/2.1	1.4/2.1	1.4/2.1	1.4/2.1	1.4/2.1	1.4/2.1
	UV_LF/OV_LF	1.4/2.1	1.4/2.1	1.4/2.1	1.4/2.1	1.4/2.1	1.4/2.1
TPS389R06ADJRTER Preview	UV_HF/OV_HF	0.705/0.795	0.705/0.795	0.705/0.795	0.705/0.795	3.1/3.5	4.7/5.3
	UV_LF/OV_LF	0.705/0.795	0.705/0.795	0.705/0.795	0.705/0.795	3.1/3.5	4.7/5.3

表 9-2. Device Thresholds TPS389008-Q1

ORDERING CODE	Thresholds	VMON1 (V)	VMON2 (V)	VMON3 (V)	VMON4 (V)	VMON5 (V)	VMON6 (V)	VMON7 (V)	VMON8 (V)
TPS389008M6HRTER Preview	UV_HF/OV_HF	0.83/0.91	1.68/1.92	1.68/1.92	0.81/0.91	0.70/0.80	1.005/1.09	0.46/0.535	1.68/1.92
	UV_LF/OV_LF								
TPS389008M62RTER Preview	UV_HF/OV_HF	0.705/0.80	0.805/0.90	1.05/1.18	1.13/1.27	0.70/0.80	1.035/1.165	3.1/3.5	2.24/2.56
	UV_LF/OV_LF								
TPS389008M67RTER Preview	UV_HF/OV_HF	0.775/0.825	1.165/1.235	0.775/0.825	1.165/1.235	0.815/0.865	1.165/1.235	1.74/1.86	4.74/5.26
	UV_LF/OV_LF								
TPS389008M64RTER Preview	UV_HF/OV_HF	0.755/0.845	0.5/1.0	1.05/1.18	0.80/0.90	1.68/1.92	0.755/0.845	1.68/1.92	1.05/1.15
	UV_LF/OV_LF								
TPS389008M66RTER Preview	UV_HF/OV_HF	1.03/1.155	4.7/5.3	1.13/1.27	1.12/1.25	0.755/0.845	3.1/3.5	1.03/1.155	4.74/5.26
	UV_LF/OV_LF								

表 9-3. Device Configuration Table

ORDERING CODE	FUNCTIONS	SCALING	OV/UV DEBOUNCE	LF CUTOFF	I²C ADDRESS	BIST	SEQ TIMEOUT/ RESET DELAY	PEC(1)	I²C PULL-UP VOLTAGE (V)	ACT/SLEEP
TPS389006ADJRTER	Monitor LF/HF	1/1/1/1/1/1	102.4µsec	1kHz	Resistor strap	at POR	25ms/NA	Disable	3.3	Level
TPS389006007RTER	Monitor LF/HF	4/4/4/4/4/4	25.6µsec	1kH	Resistor Strap	At POR	100ms/NA	Disable	3.3	Level
TPS389R06ADJRTER Preview	Monitor LF/HF	1/1/1/1/4/4	51.2µsec	1kH	Resistor Strap	At POR	50ms/20ms	Disable	3.3	Level

表 9-3. Device Configuration Table (続き)

ORDERING CODE	FUNCTIONS	SCALING	OV/UV DEBOUNCE	LF CUTOFF	I²C ADDRESS	BIST	SEQ TIMEOUT/ RESET DELAY	PEC(1)	I²C PULL-UP VOLTAGE (V)	ACT/SLEEP
TPS389008M6xRTER Preview	Monitor LF/HF	1 or 4 based on thresholds	51.2µsec	1kH	Resistor Strap	At POR	100ms/NA	Disable	3.3	Level

(1) For parts with PEC enabled:
  a. PEC calculation is based on initializing to 0x00.
  b. In case of a PEC violation there needs to be a subsequent I²C transaction before NIRQ is asserted.
  c. If incorrect PEC device asserts NIRQ.
  d. If there is an extra byte after successfully writing the correct PEC byte, NIRQ is asserted and the write fails.

9.2 Documentation Support

9.3 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、www.tij.co.jp のデバイス製品フォルダを開いてください。[通知] をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取ることができます。 変更の詳細については、改訂されたドキュメントに含まれている改訂履歴をご覧ください。

9.4 サポート・リソース

テキサス・インスツルメンツ E2E™ サポート・フォーラムは、エンジニアが検証済みの回答と設計に関するヒントをエキスパートから迅速かつ直接得ることができる場所です。既存の回答を検索したり、独自の質問をしたりすることで、設計で必要な支援を迅速に得ることができます。

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9.5 Trademarks

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9.6 静電気放電に関する注意事項

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ESD による破損は、わずかな性能低下からデバイスの完全な故障まで多岐にわたります。精密な IC の場合、パラメータがわずかに変化するだけで公表されている仕様から外れる可能性があるため、破損が発生しやすくなっています。

9.7 用語集

テキサス・インスツルメンツ用語集　　この用語集には、用語や略語の一覧および定義が記載されています。

10 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Changes from Revision C (October 2024) to Revision D (October 2024)	Page
• 製品フォルダの GPN と一致するように型番を更新	1

Changes from Revision B (May 2023) to Revision C (October 2024)	Page
• Updated pinout and ordering code nomenclature	4
• Added pinout and pin description for TPS389008-Q1 and TPS389R0-Q1	6
• Updated Abs max for ACT,SLEEP,SCL,SDA from VDD+0.3V to 6V and added NRST to Abs max and Recommended Operating Conditions	8
• Updated abs max to 6V from VDD+0.3	8
• Pin current max updated	8
• Updated recommended operating max to 5.5V from VDD	8
• Added electrical characteristics for NRST pin	9
• Added electrical characteristic for NRST pin	9
• Added timing characteristics for NRST pin	11
• Removed max numbers for $t_{HD:DAT}$ to confirm to I^2C standard	11
• NRST pin description added	24

- Added Device Thresholds and Configuration table details for TPS389R0-Q1 and TPS389008-Q1..... 133

Changes from Revision A (March 2022) to Revision B (May 2023)	Page
• 最初の公開リリース	1

11 Mechanical, Packaging, and Orderable Information

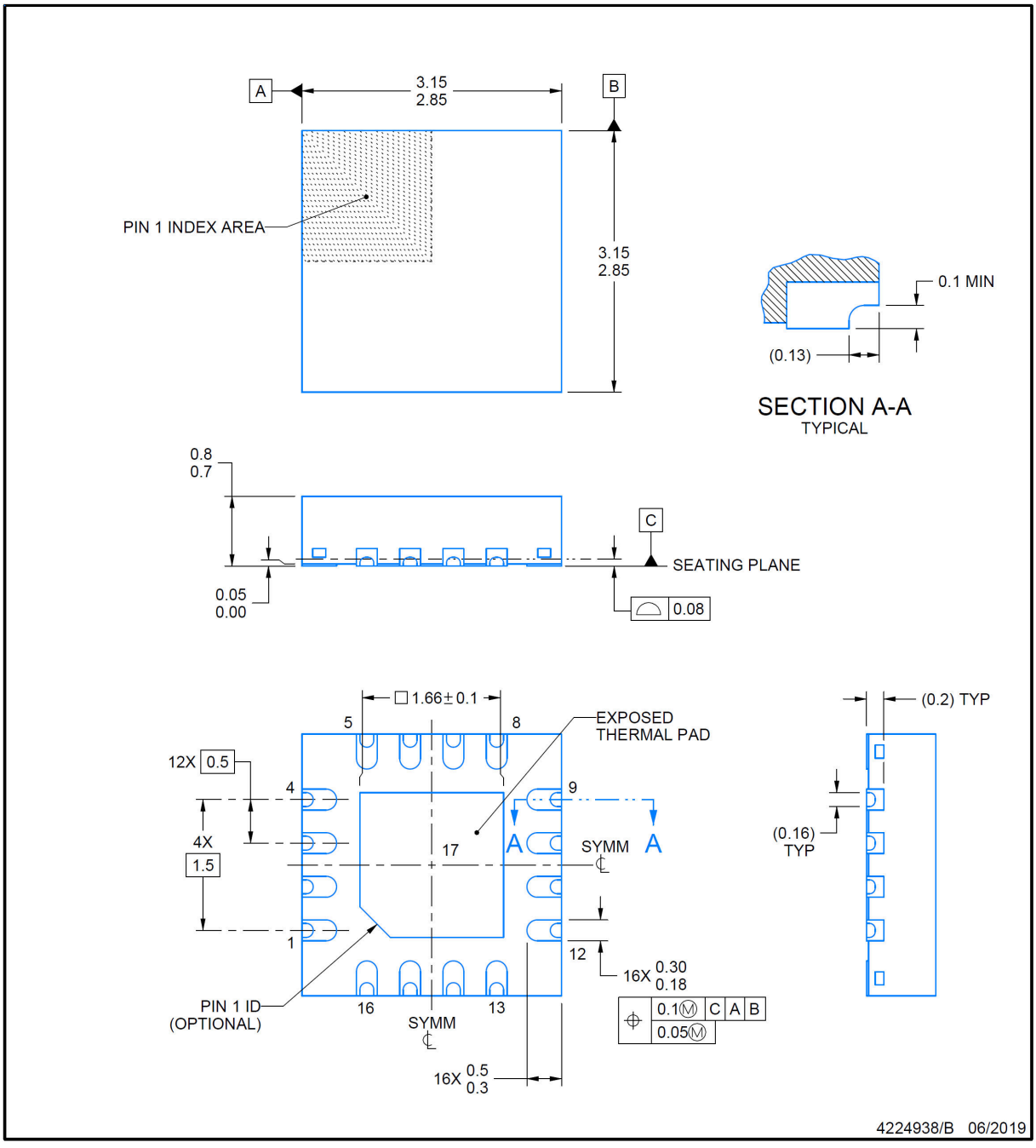
The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGE OUTLINE

RTE0016K

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

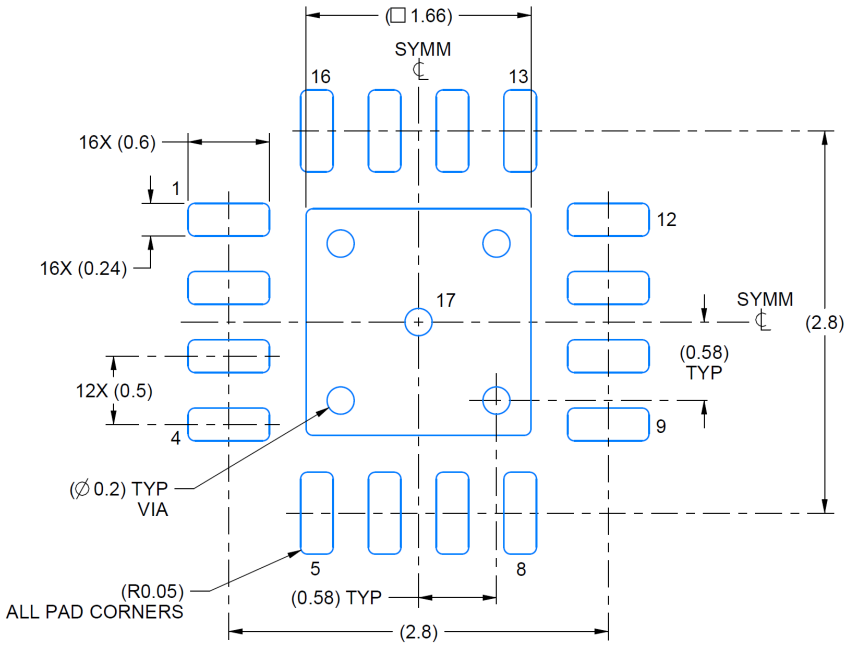
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

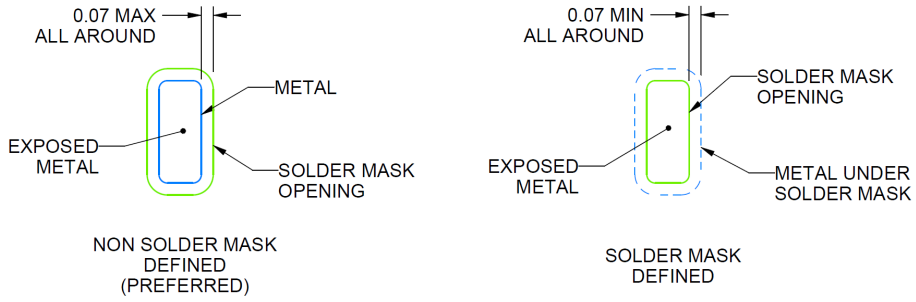
RTE0016K

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:20X



SOLDER MASK DETAILS

4224938/B 06/2019

NOTES: (continued)

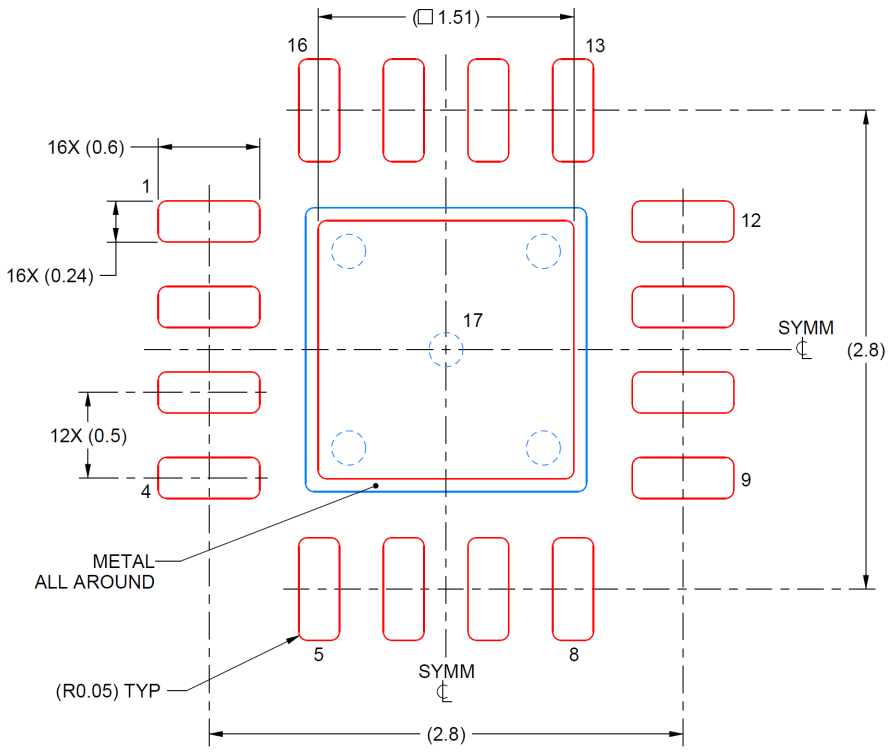
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RTE0016K

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17:
84% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:25X

4224938/B 06/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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郵送先住所:Texas Instruments, Post Office Box 655303, Dallas, Texas 75265

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PPS389R06ADJRTERQ1	ACTIVE	WQFN	RTE	16	3000	TBD	Call TI	Call TI	-40 to 125		Samples
TPS389006004RTERQ1	ACTIVE	WQFN	RTE	16	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		6004Q	Samples
TPS38900603NRTERQ1	ACTIVE	WQFN	RTE	16	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	0603Q	Samples
TPS389006ADJRTERQ1	ACTIVE	WQFN	RTE	16	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	6ADJQ	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals.
TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS389006-Q1 :

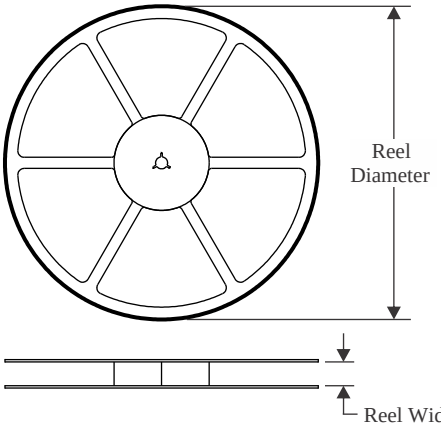
- Catalog : TPS389006

NOTE: Qualified Version Definitions:

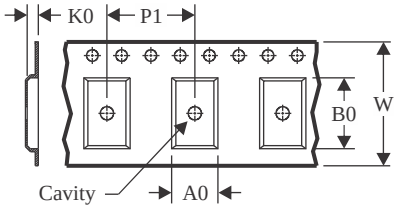
- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

REEL DIMENSIONS

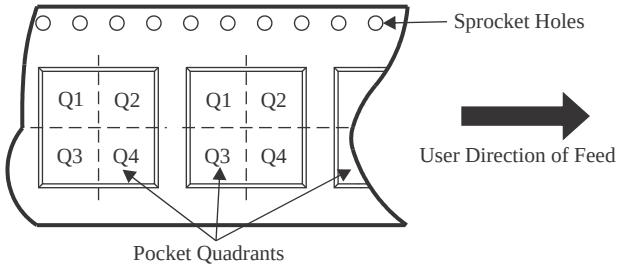


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

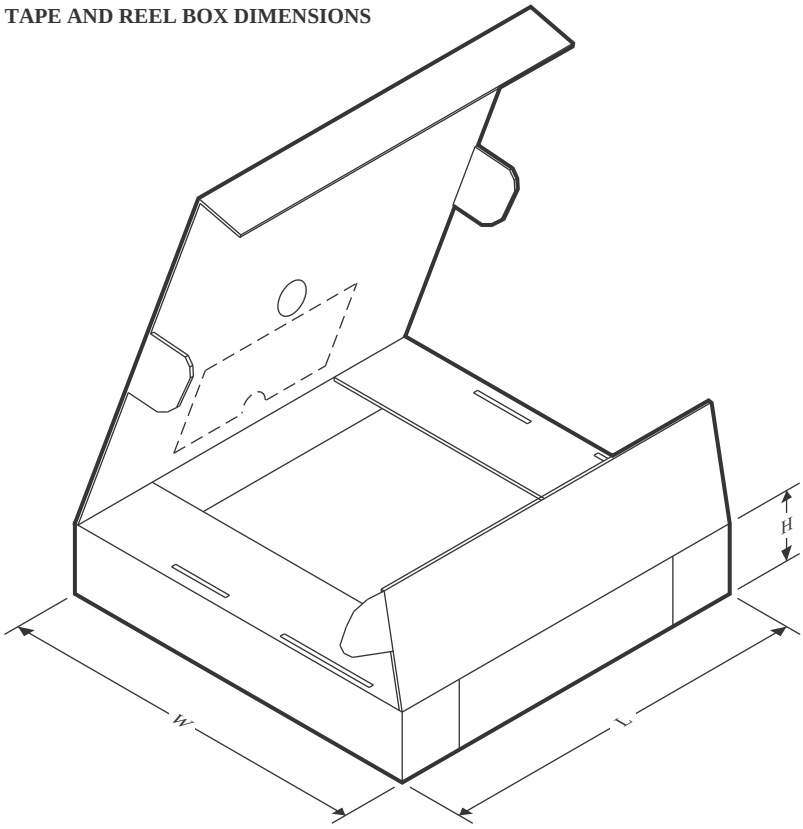
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS389006004RTERQ1	WQFN	RTE	16	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS38900603NRTERQ1	WQFN	RTE	16	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS389006ADJRTERQ1	WQFN	RTE	16	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS389006004RTERQ1	WQFN	RTE	16	3000	367.0	367.0	35.0
TPS38900603NRTERQ1	WQFN	RTE	16	3000	367.0	367.0	35.0
TPS389006ADJRTERQ1	WQFN	RTE	16	3000	367.0	367.0	35.0

GENERIC PACKAGE VIEW

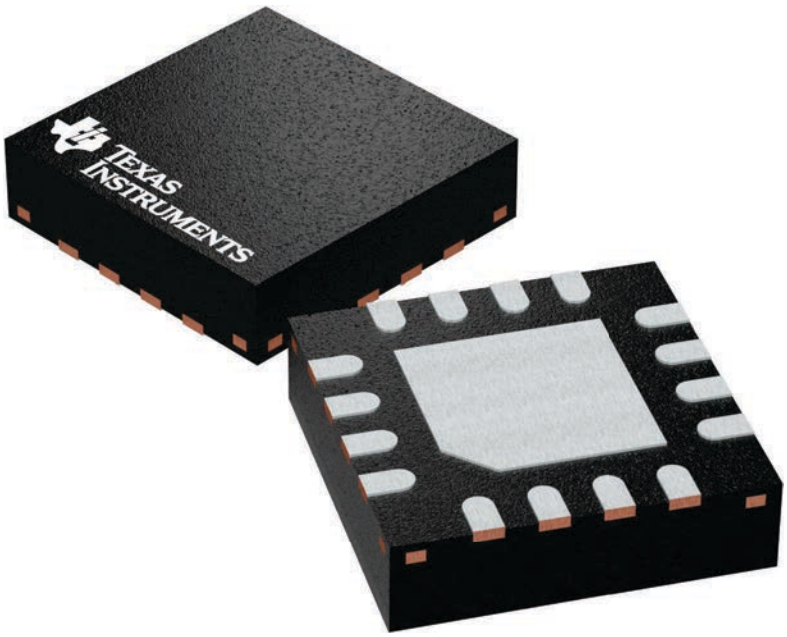
RTE 16

WQFN - 0.8 mm max height

3 x 3, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

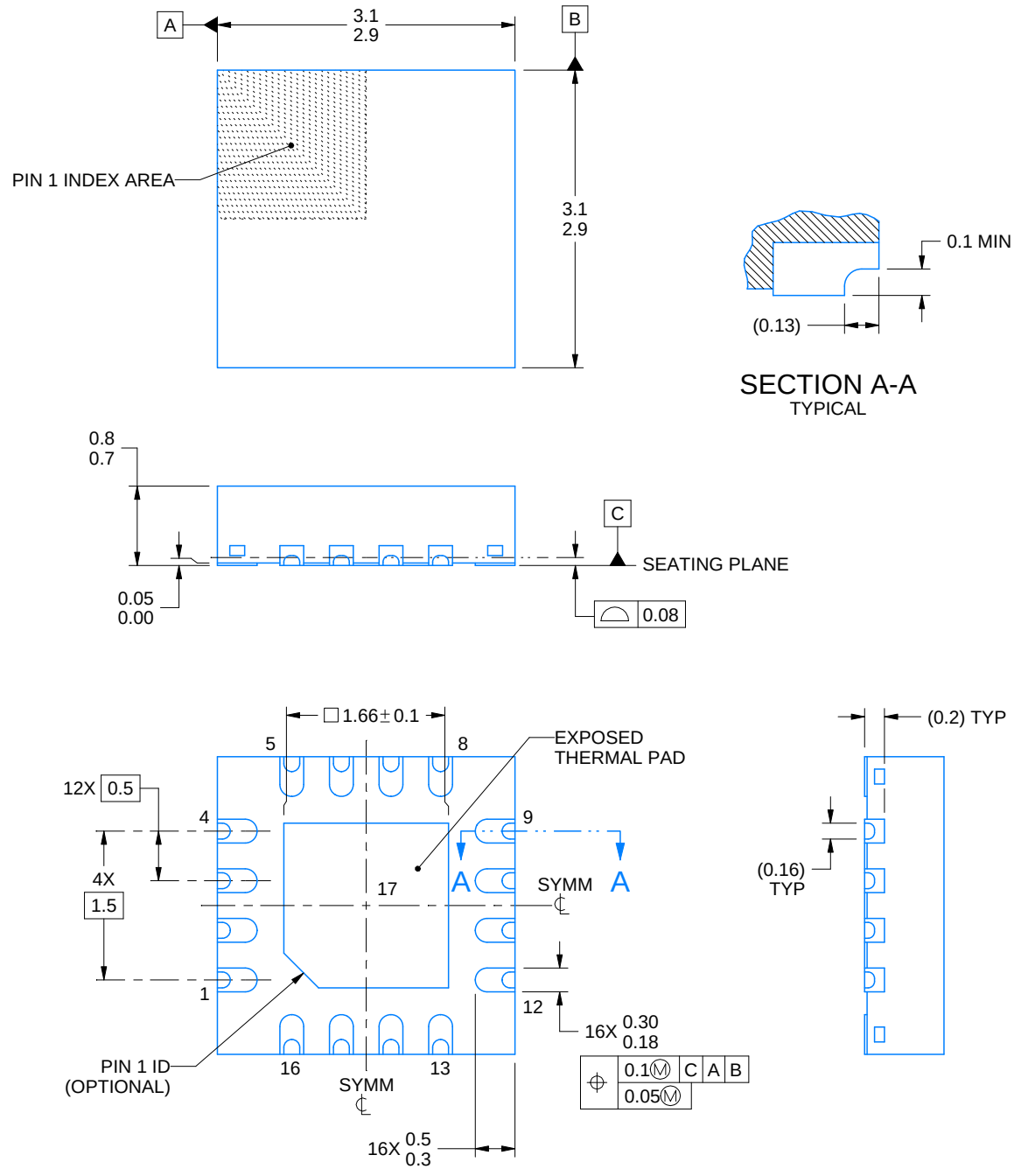


RTE0016K

PACKAGE OUTLINE

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

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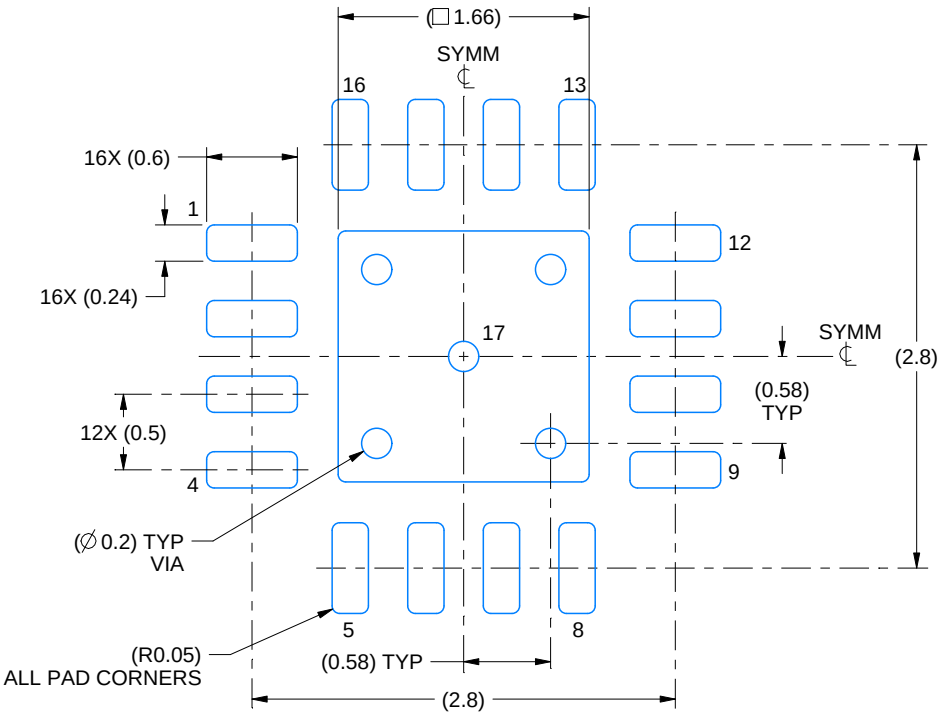
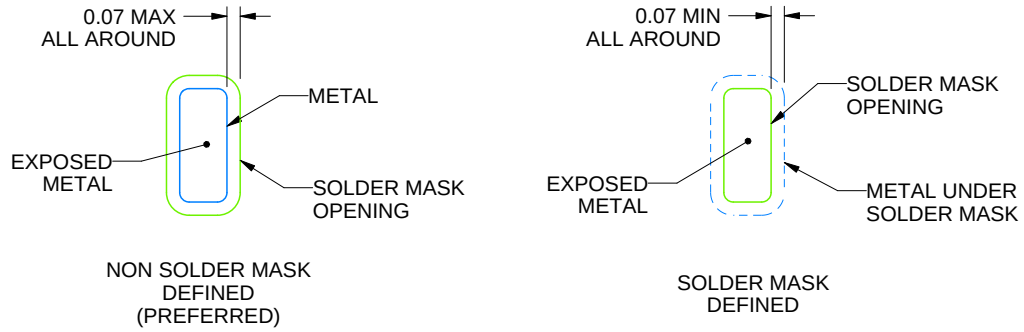


LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:20X



SOLDER MASK DETAILS

4224938/C 03/2022

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
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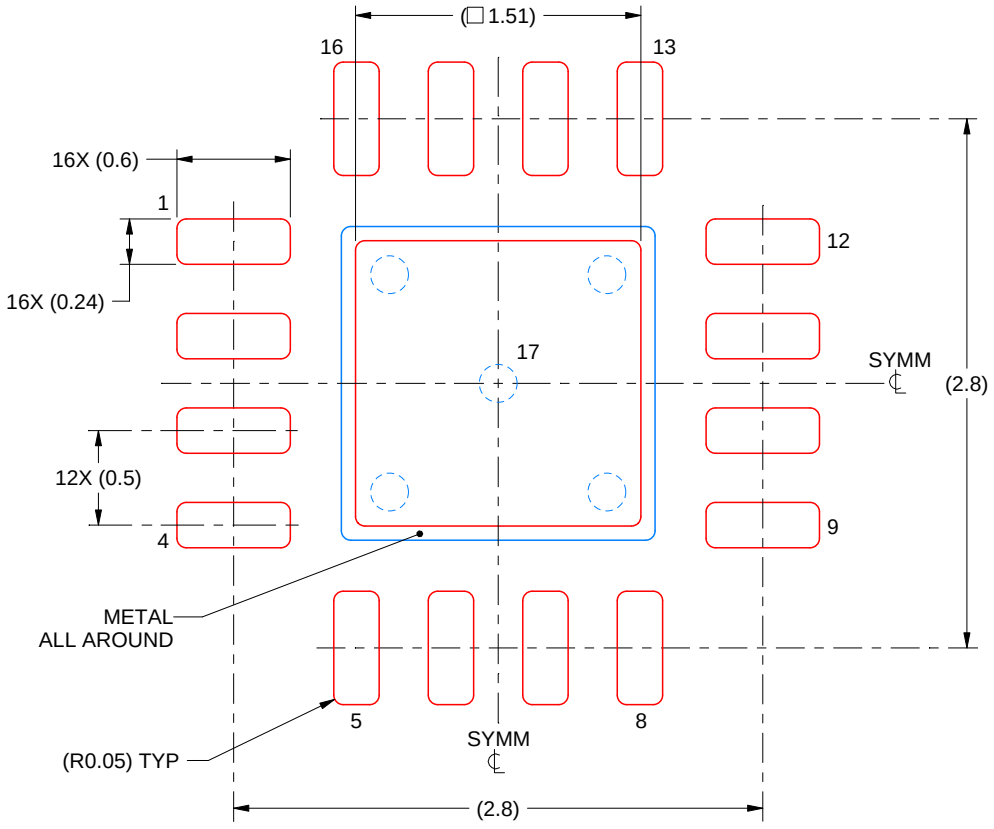

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17:
84% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:25X

4224938/C 03/2022

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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